

Please read this notice before using the TAIYO YUDEN products.

REMINDERS

- Product information in this catalog is as of October 2018. All of the contents specified herein are subject to change without notice due to technical improvements, etc. Therefore, please check for the latest information carefully before practical application or use of our products.

Please note that TAIYO YUDEN shall not be in any way responsible for any damages and defects in products or equipment incorporating our products, which are caused under the conditions other than those specified in this catalog or individual product specification sheets.

- Please contact TAIYO YUDEN for further details of product specifications as the individual product specification sheets are available.
- Please conduct validation and verification of our products in actual condition of mounting and operating environment before using our products.
- The products listed in this catalog are intended for use in general electronic equipment (e.g., AV equipment, OA equipment, home electric appliances, office equipment, information and communication equipment including, without limitation, mobile phone, and PC) and medical equipment classified as Class I or II by IMDRF. Please be sure to contact TAIYO YUDEN for further information before using the products for any equipment which may directly cause loss of human life or bodily injury (e.g., transportation equipment including, without limitation, automotive powertrain control system, train control system, and ship control system, traffic signal equipment, disaster prevention equipment, medical equipment classified as Class III by IMDRF, highly public information network equipment including, without limitation, telephone exchange, and base station).

Please do not incorporate our products into any equipment requiring high levels of safety and/or reliability (e.g., aerospace equipment, aviation equipment*, medical equipment classified as Class IV by IMDRF, nuclear control equipment, undersea equipment, military equipment).

*Note: There is a possibility that our products can be used only for aviation equipment that does not directly affect the safe operation of aircraft (e.g., in-flight entertainment, cabin light, electric seat, cooking equipment) if such use meets requirements specified separately by TAIYO YUDEN. Please be sure to contact TAIYO YUDEN for further information before using our products for such aviation equipment.

When our products are used even for high safety and/or reliability-required devices or circuits of general electronic equipment, it is strongly recommended to perform a thorough safety evaluation prior to use of our products and to install a protection circuit as necessary.

Please note that unless you obtain prior written consent of TAIYO YUDEN, TAIYO YUDEN shall not be in any way responsible for any damages incurred by you or third parties arising from use of the products listed in this catalog for any equipment requiring inquiry to TAIYO YUDEN or prohibited for use by TAIYO YUDEN as described above.

- Information contained in this catalog is intended to convey examples of typical performances and/or applications of our products and is not intended to make any warranty with respect to the intellectual property rights or any other related rights of TAIYO YUDEN or any third parties nor grant any license under such rights.
- Please note that the scope of warranty for our products is limited to the delivered our products themselves and TAIYO YUDEN shall not be in any way responsible for any damages resulting from a fault or defect in our products. Notwithstanding the foregoing, if there is a written agreement (e.g., supply and purchase agreement, quality assurance agreement) signed by TAIYO YUDEN and your company, TAIYO YUDEN will warrant our products in accordance with such agreement.
- The contents of this catalog are applicable to our products which are purchased from our sales offices or authorized distributors (hereinafter "TAIYO YUDEN's official sales channel"). Please note that the contents of this catalog are not applicable to our products purchased from any seller other than TAIYO YUDEN's official sales channel.
- Caution for Export
Some of our products listed in this catalog may require specific procedures for export according to "U.S. Export Administration Regulations", "Foreign Exchange and Foreign Trade Control Law" of Japan, and other applicable regulations. Should you have any questions on this matter, please contact our sales staff.

METAL WIRE-WOUND CHIP POWER INDUCTORS(MCOIL™ ME SERIES)



REFLOW

PARTS NUMBER

* Operating Temp.: -40~+125°C (Including self-generated heat)

| | | | | | | | | | | | | | | |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| M | E | K | K | 2 | 0 | 1 | 6 | T | 1 | R | 0 | M | △ | △ |
| ① | ② | ③ | ④ | ⑤ | ⑥ | ⑦ | ⑧ | | | | | | | |

△=Blank space

① Series name

| Code | Series name |
|------|--------------------------------------|
| ME | Metal Wire-wound Chip Power Inductor |

② Dimensions (T)

| Code | Dimensions (T) [mm] |
|------|---------------------|
| KK | 1.0 |

③ Dimensions (L × W)

| Code | Dimensions (L × W) [mm] |
|------|-------------------------|
| 2016 | 2.0 × 1.6 |
| 2520 | 2.5 × 2.0 |

④ Packaging

| Code | Packaging |
|------|-----------|
| T | Taping |

⑤ Nominal inductance

| Code (example) | Nominal inductance [μH] |
|----------------|-------------------------|
| R47 | 0.47 |
| 1R0 | 1.0 |
| 4R7 | 4.7 |

※R=Decimal point

⑥ Inductance tolerance

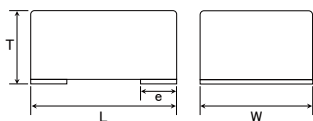
| Code | Inductance tolerance |
|------|----------------------|
| M | ±20% |

⑦ Special code

| Code | Special code |
|------|--------------|
| △ | Standard |

⑧ Internal code

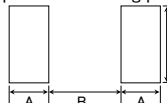
STANDARD EXTERNAL DIMENSIONS / STANDARD QUANTITY



Recommended Land Patterns

Surface Mounting

- Mounting and soldering conditions should be checked beforehand.
- Applicable soldering process to these products is reflow soldering only.



| Type | A | B | C |
|------|-----|-----|-----|
| 2016 | 0.7 | 0.8 | 1.8 |
| 2520 | 0.9 | 1.0 | 2.2 |

Unit: mm

| Type | L | W | T | e | Standard quantity [pcs] Taping |
|----------|--------------------------|--------------------------|------------------------|---------------------------|-----------------------------------|
| MEKK2016 | 2.0±0.2 (0.079±0.008) | 1.6±0.2 (0.063±0.008) | 1.0 max (0.039 max) | 0.5±0.3 (0.020±0.012) | 3000 |
| MEKK2520 | 2.5±0.2 (0.098±0.008) | 2.0±0.2 (0.079±0.008) | 1.0 max (0.039 max) | 0.65±0.3 (0.026±0.012) | 3000 |

Unit: mm (inch)

PARTS NUMBER

MEKK2016 type [Thickness: 1.0mm max.]

| Parts number | EHS | Nominal inductance [μH] | Inductance tolerance | Self-resonant frequency [MHz] (min.) | DC Resistance [Ω] (max.) | Rated current ※) [mA] (max.) | | Measuring frequency [MHz] |
|---------------|------|-------------------------|----------------------|--------------------------------------|--------------------------|------------------------------|-------------------------------|---------------------------|
| | | | | | | Saturation current Idc1 | Temperature rise current Idc2 | |
| MEKK2016TR47M | RoHS | 0.47 | ±20% | - | 0.030 | 4,500 | 4,300 | 1 |
| MEKK2016TR68M | RoHS | 0.68 | ±20% | - | 0.052 | 3,800 | 3,300 | 1 |
| MEKK2016T1R0M | RoHS | 1.0 | ±20% | - | 0.060 | 3,600 | 3,100 | 1 |
| MEKK2016T2R2M | RoHS | 2.2 | ±20% | - | 0.150 | 2,400 | 1,900 | 1 |

MEKK2520 type [Thickness: 1.0mm max.]

| Parts number | EHS | Nominal inductance [μH] | Inductance tolerance | Self-resonant frequency [MHz] (min.) | DC Resistance [Ω] (max.) | Rated current ※) [mA] (max.) | | Measuring frequency [MHz] |
|---------------|------|-------------------------|----------------------|--------------------------------------|--------------------------|------------------------------|-------------------------------|---------------------------|
| | | | | | | Saturation current Idc1 | Temperature rise current Idc2 | |
| MEKK2520TR33M | RoHS | 0.33 | ±20% | - | 0.022 | 6,400 | 5,100 | 1 |
| MEKK2520TR47M | RoHS | 0.47 | ±20% | - | 0.025 | 5,900 | 4,800 | 1 |
| MEKK2520T1R0M | RoHS | 1.0 | ±20% | - | 0.053 | 4,300 | 3,300 | 1 |
| MEKK2520T1R5M | RoHS | 1.5 | ±20% | - | 0.069 | 3,200 | 2,800 | 1 |
| MEKK2520T2R2M | RoHS | 2.2 | ±20% | - | 0.097 | 3,100 | 2,400 | 1 |
| MEKK2520T4R7M | RoHS | 4.7 | ±20% | - | 0.240 | 1,600 | 1,500 | 1 |

※) The saturation current value (Idc1) is the DC current value having inductance decrease down to 30%. (at 20°C)

※) The temperature rise current value (Idc2) is the DC current value having temperature increase up to 40°C. (at 20°C)

※) The rated current is the DC current value that satisfies both of current value saturation current value and temperature rise current value.

※) Idc2 Measurement board data
 Material:FR4
 Board dimensions: 100 × 50 × 1.6t mm
 Pattern dimensions: 45 × 45 mm (Double side board)
 Pattern thickness: 70 μm

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METAL WIRE-WOUND CHIP POWER INDUCTORS(MCOIL™ ME-H SERIES)



REFLOW

■ PARTS NUMBER

* Operating Temp.: -40~+125°C (Including self-generated heat)

| | | | | | | | | | | | | | | |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| M | E | K | K | 2 | 0 | 1 | 6 | H | 1 | R | 0 | M | △ | △ |
| ① | ② | ③ | ④ | ⑤ | ⑥ | ⑦ | ⑧ | | | | | | | |

△=Blank space

①Series name

| Code | Series name |
|------|--------------------------------------|
| ME | Metal Wire-wound Chip Power Inductor |

②Dimensions (T)

| Code | Dimensions (T) [mm] |
|------|---------------------|
| KK | 1.0 |

③Dimensions (L×W)

| Code | Dimensions (L×W) [mm] |
|------|-----------------------|
| 2012 | 2.0×1.2 |
| 2016 | 2.0×1.6 |

④Packaging

| Code | Packaging |
|------|--------------------------------|
| H | Taping (special specification) |

⑤Nominal inductance

| Code (example) | Nominal inductance [μH] |
|----------------|-------------------------|
| R47 | 0.47 |
| 1R0 | 1.0 |
| 2R2 | 2.2 |

※R=Decimal point

⑥Inductance tolerance

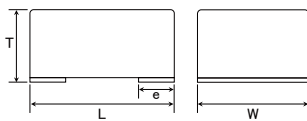
| Code | Inductance tolerance |
|------|----------------------|
| M | ±20% |

⑦Special code

| Code | Special code |
|------|--------------|
| △ | Standard |

⑧Internal code

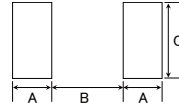
■ STANDARD EXTERNAL DIMENSIONS / STANDARD QUANTITY



Recommended Land Patterns

Surface Mounting

- Mounting and soldering conditions should be checked beforehand.
- Applicable soldering process to these products is reflow soldering only.



| Type | A | B | C |
|------|-----|-----|-----|
| 2012 | 0.7 | 0.8 | 1.4 |
| 2016 | 0.7 | 0.8 | 1.8 |

Unit: mm

| Type | L | W | T | e | Standard quantity [pcs] |
|-----------|--------------------------|--------------------------|------------------------|--------------------------|-------------------------|
| | | | | | Taping |
| MEKK2012H | 2.0±0.2 (0.079±0.008) | 1.2±0.2 (0.047±0.008) | 1.0 max (0.039 max) | 0.5±0.3 (0.020±0.012) | 3000 |
| MEKK2016H | 2.0±0.2 (0.079±0.008) | 1.6±0.2 (0.063±0.008) | 1.0 max (0.039 max) | 0.5±0.3 (0.020±0.012) | 3000 |

Unit: mm (inch)

■ PARTS NUMBER

● MEKK2012H type [Thickness: 1.0mm max.]

| Parts number | EHS | Nominal inductance [μH] | Inductance tolerance | Self-resonant frequency [MHz] (min.) | DC Resistance [Ω] (max.) | Rated current ※) [mA] (max.) | | Measuring frequency [MHz] |
|---------------|------|-------------------------|----------------------|--------------------------------------|--------------------------|------------------------------|-------------------------------|---------------------------|
| | | | | | | Saturation current Idc1 | Temperature rise current Idc2 | |
| MEKK2012HR47M | RoHS | 0.47 | ±20% | - | 0.030 | 4,500 | 4,200 | 1 |

● MEKK2016H type [Thickness: 1.0mm max.]

| Parts number | EHS | Nominal inductance [μH] | Inductance tolerance | Self-resonant frequency [MHz] (min.) | DC Resistance [Ω] (max.) | Rated current ※) [mA] (max.) | | Measuring frequency [MHz] |
|---------------|------|-------------------------|----------------------|--------------------------------------|--------------------------|------------------------------|-------------------------------|---------------------------|
| | | | | | | Saturation current Idc1 | Temperature rise current Idc2 | |
| MEKK2016HR47M | RoHS | 0.47 | ±20% | - | 0.026 | 5,300 | 4,700 | 1 |
| MEKK2016H1R0M | RoHS | 1.0 | ±20% | - | 0.048 | 4,000 | 3,500 | 1 |
| MEKK2016H2R2M | RoHS | 2.2 | ±20% | - | 0.100 | 2,300 | 2,300 | 1 |

※) The saturation current value (Idc1) is the DC current value having inductance decrease down to 30%. (at 20°C)

※) The temperature rise current value (Idc2) is the DC current value having temperature increase up to 40°C. (at 20°C)

※) The rated current is the DC current value that satisfies both of current value saturation current value and temperature rise current value.

※) Idc2 Measurement board data

Material:FR4

Board dimensions: 100×50×1.6t mm

Pattern dimensions: 45×45 mm (Double side board)

Pattern thickness: 70 μm

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METAL WIRE-WOUND CHIP POWER INDUCTORS (MCOIL™ ME SERIES/MCOIL™ ME-H SERIES)

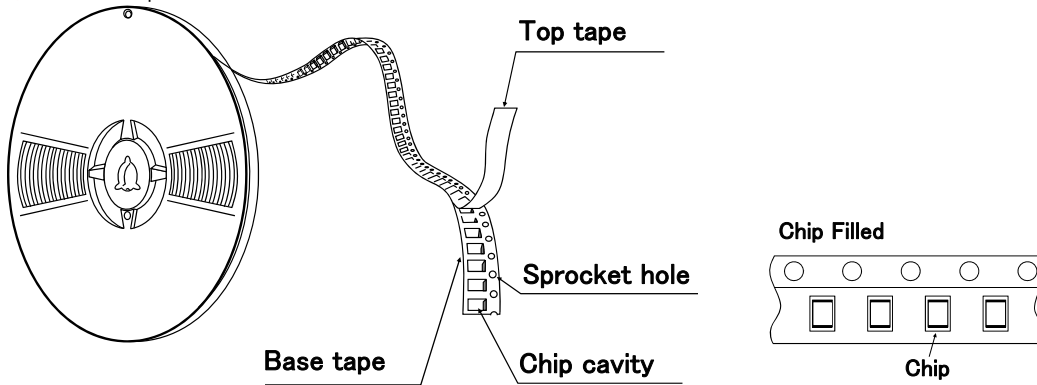
PACKAGING

① Minimum Quantity

| Type | Standard Quantity [pcs] |
|----------|-------------------------|
| | Tape & Reel |
| MEKK2012 | 3000 |
| MEKK2016 | 3000 |
| MEKK2520 | 3000 |

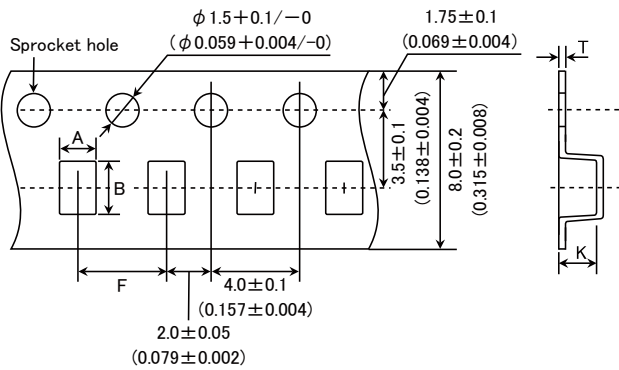
② Tape Material

● Embossed Tape



③ Taping dimensions

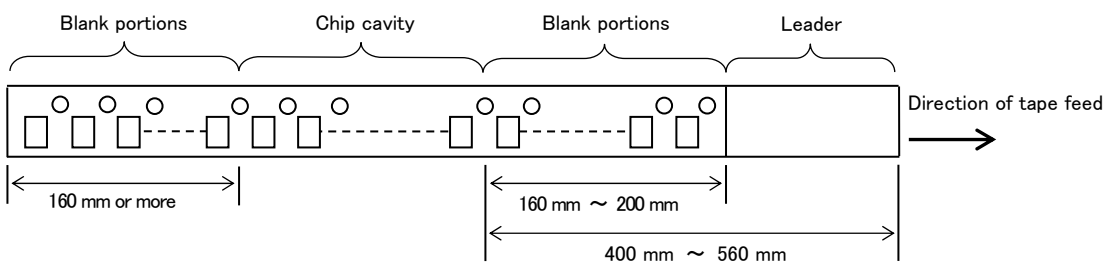
● Embossed tape 8mm wide (0.315 inches wide)



| Type | Chip cavity | | Insertion pitch | Tape thickness | |
|----------|---|---|--|--|--|
| | A | B | F | T | K |
| MEKK2012 | 1.45 ± 0.1 (0.057 ± 0.004) | 2.25 ± 0.1 (0.089 ± 0.004) | 4.0 ± 0.1 (0.157 ± 0.004) | 0.25 ± 0.05 (0.009 ± 0.002) | 1.1 ± 0.1 (0.043 ± 0.004) |
| MEKK2016 | 1.9 ± 0.1 (0.075 ± 0.004) | 2.45 ± 0.1 (0.097 ± 0.004) | 4.0 ± 0.1 (0.157 ± 0.004) | 0.25 ± 0.05 (0.009 ± 0.002) | 1.2 ± 0.1 (0.047 ± 0.004) |
| MEKK2520 | 2.4 ± 0.1 (0.094 ± 0.004) | 2.9 ± 0.1 (0.114 ± 0.004) | 4.0 ± 0.1 (0.157 ± 0.004) | 0.25 ± 0.05 (0.009 ± 0.002) | 1.1 ± 0.1 (0.043 ± 0.004) |

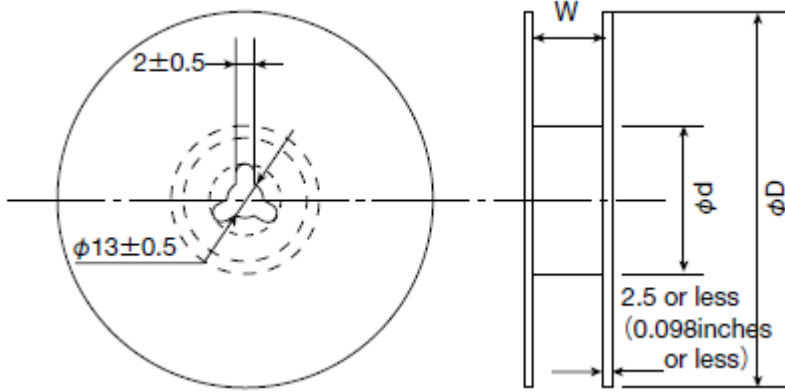
Unit: mm (inch)

④ Leader and Blank portion



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⑤ Reel size

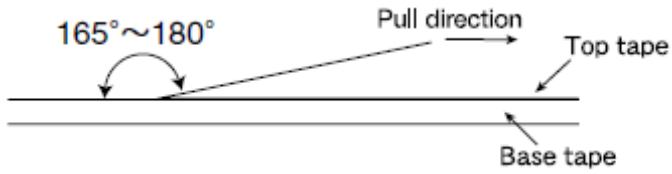


| Type | Reel size (Reference values) | | |
|----------|------------------------------|---------------------------|---------------------------|
| | ϕD | ϕd | W |
| MEKK2012 | 180+0/-3 (7.087+0/-0.118) | 60+1/-0 (2.36+0.039/0) | 10.0±1.5 (0.394±0.059) |
| MEKK2016 | | | |
| MEKK2520 | | | |

Unit : mm (inch)

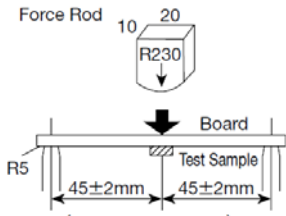
⑥ Top Tape Strength

The top tape requires a peel-off force of 0.1 to 1.0N in the direction of the arrow as illustrated below.



METAL WIRE-WOUND CHIP POWER INDUCTORS (MCOIL™ ME SERIES / MCOIL™ ME-H SERIES)

RELIABILITY DATA

| 1. Operating Temperature Range | | |
|---------------------------------------|---|---------------------------------------|
| Specified Value | ME series | -40 ~ +125°C |
| | ME-H series | |
| Test Methods and Remarks | Including self-generated heat | |
| 2. Storage Temperature Range | | |
| Specified Value | ME series | -40 ~ +85°C |
| | ME-H series | |
| Test Methods and Remarks | 0 to 40°C for the product with taping. | |
| 3. Rated current | | |
| Specified Value | ME series | Within the specified tolerance |
| | ME-H series | |
| 4. Inductance | | |
| Specified Value | ME series | Within the specified tolerance |
| | ME-H series | |
| Test Methods and Remarks | Measuring equipment : LCR Meter (HP 4294A or equivalent) Measuring frequency : 1MHz, 0.5V | |
| 5. DC Resistance | | |
| Specified Value | ME series | Within the specified tolerance |
| | ME-H series | |
| Test Methods and Remarks | Measuring equipment : DC ohmmeter (HIOKI 3227 or equivalent) | |
| 6. Self resonance frequency | | |
| Specified Value | ME series | - |
| | ME-H series | |
| 7. Temperature characteristic | | |
| Specified Value | ME series | Inductance change : Within $\pm 15\%$ |
| | ME-H series | |
| Test Methods and Remarks | Measurement of inductance shall be taken at temperature range within -40°C ~ +125°C. With reference to inductance value at +20°C., change rate shall be calculated. | |
| 8. Resistance to flexure of substrate | | |
| Specified Value | ME series | No damage |
| | ME-H series | |
| Test Methods and Remarks | <p>The test samples shall be soldered to the test board by the reflow. As illustrated below, apply force in the direction of the arrow indicating until deflection of the test board reaches to 2 mm.</p> <p>Test board size : 100 × 40 × 1.0 mm Test board material : Glass epoxy-resin Solder cream thickness : 0.12 mm</p>  | |

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| 9. Insulation resistance : between wires | | |
|--|-------------|---|
| Specified Value | ME series | — |
| | ME-H series | |

| 10. Insulation resistance : between wire and over-coating | | |
|---|-------------|-----------------|
| Specified Value | ME series | DC25V 100k Ωmin |
| | ME-H series | |

| 11. Withstanding voltage : between wire and over-coating | | |
|--|-------------|---|
| Specified Value | ME series | — |
| | ME-H series | |

| 12. Adhesion of terminal electrode | | |
|------------------------------------|---|-----------------|
| Specified Value | ME series | No abnormality. |
| | ME-H series | |
| Test Methods and Remarks | The test samples shall be soldered to the test board by the reflow. Applied force : 10N to X and Y directions. Duration : 5s. Solder cream thickness : 0.12mm. | |

| 13. Resistance to vibration | | | | | | | | | | | | | | | |
|---|--|--|-----------------|---------|--|-----------------|--|--|-----------------|--------------------------------|--|------|---|--------------------------------------|---|
| Specified Value | ME series | Inductance change : Within ±10% No significant abnormality in appearance. | | | | | | | | | | | | | |
| | ME-H series | | | | | | | | | | | | | | |
| Test Methods and Remarks | The test samples shall be soldered to the test board by the reflow. Then it shall be submitted to below test conditions. | | | | | | | | | | | | | | |
| | <table border="1"> <tr> <td>Frequency Range</td> <td colspan="2">10~55Hz</td> </tr> <tr> <td>Total Amplitude</td> <td colspan="2">1.5mm (May not exceed acceleration 196m/s²)</td> </tr> <tr> <td>Sweeping Method</td> <td colspan="2">10Hz to 55Hz to 10Hz for 1min.</td> </tr> <tr> <td rowspan="3">Time</td> <td>X</td> <td rowspan="3">For 2 hours on ach X, Y, and Z axis.</td> </tr> <tr> <td>Y</td> </tr> <tr> <td>Z</td> </tr> </table> | | Frequency Range | 10~55Hz | | Total Amplitude | 1.5mm (May not exceed acceleration 196m/s ²) | | Sweeping Method | 10Hz to 55Hz to 10Hz for 1min. | | Time | X | For 2 hours on ach X, Y, and Z axis. | Y |
| Frequency Range | 10~55Hz | | | | | | | | | | | | | | |
| Total Amplitude | 1.5mm (May not exceed acceleration 196m/s ²) | | | | | | | | | | | | | | |
| Sweeping Method | 10Hz to 55Hz to 10Hz for 1min. | | | | | | | | | | | | | | |
| Time | X | For 2 hours on ach X, Y, and Z axis. | | | | | | | | | | | | | |
| | Y | | | | | | | | | | | | | | |
| | Z | | | | | | | | | | | | | | |
| Recovery : At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48hrs. | | | | | | | | | | | | | | | |

| 14. Solderability | | | | | |
|--------------------------|---|---|--------------------|---------|------|
| Specified Value | ME series | At least 90% of surface of terminal electrode is covered by new solder. | | | |
| | ME-H series | | | | |
| Test Methods and Remarks | The test samples shall be dipped in flux, and then immersed in molten solder as shown in below table. Flux : Methanol solution containing rosin 25%. | | | | |
| | <table border="1"> <tr> <td>Solder Temperature</td> <td>245±5°C</td> </tr> <tr> <td>Time</td> <td>5±0.5 sec.</td> </tr> </table> ※Immersion depth : All sides of mounting terminal shall be immersed. | | Solder Temperature | 245±5°C | Time |
| Solder Temperature | 245±5°C | | | | |
| Time | 5±0.5 sec. | | | | |

| 15. Resistance to soldering heat | | |
|----------------------------------|--|--|
| Specified Value | ME series | Inductance change : Within ±10% No significant abnormality in appearance. |
| | ME-H series | |
| Test Methods and Remarks | The test sample shall be exposed to reflow oven at 230°C for 40 seconds, with peak temperature at 260+0/−5°C for 5 seconds, 2 times. | |
| | Test board material : Glass epoxy-resin Test board thickness : 1.0mm Recovery : At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48hrs. | |

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| 16. Thermal shock | | | |
|---|---|--|----------------|
| Specified Value | ME series | Inductance change : Within $\pm 10\%$ No significant abnormality in appearance. | |
| | ME-H series | | |
| Test Methods and Remarks | The test samples shall be soldered to the test board by the reflow. The test samples shall be placed at specified temperature for specified time by step 1 to step 4 as shown in below table in sequence. The temperature cycle shall be repeated 100 cycles. | | |
| | Conditions of 1 cycle | | |
| | Step | Temperature ($^{\circ}\text{C}$) | Duration (min) |
| | 1 | -40 ± 3 | 30 ± 3 |
| | 2 | Room temperature | Within 3 |
| | 3 | $+85 \pm 2$ | 30 ± 3 |
| 4 | Room temperature | Within 3 | |
| Recovery : At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48hrs. | | | |

| 17. Damp heat | | |
|---|--|--|
| Specified Value | ME series | Inductance change : Within $\pm 10\%$ No significant abnormality in appearance. |
| | ME-H series | |
| Test Methods and Remarks | The test samples shall be soldered to the test board by the reflow. | |
| | The test samples shall be placed in thermostatic oven set at specified temperature and humidity as shown in below table. | |
| | Temperature | $60 \pm 2^{\circ}\text{C}$ |
| | Humidity | $90 \sim 95\% \text{RH}$ |
| | Time | $500 + 24 / - 0$ hour |
| Recovery : At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48hrs. | | |

| 18. Loading under damp heat | | |
|---|---|--|
| Specified Value | ME series | Inductance change : Within $\pm 10\%$ No significant abnormality in appearance. |
| | ME-H series | |
| Test Methods and Remarks | The test samples shall be soldered to the test board by the reflow. | |
| | The test samples shall be placed in thermostatic oven set at specified temperature and humidity and applied the rated current continuously as shown in below table. | |
| | Temperature | $60 \pm 2^{\circ}\text{C}$ |
| | Humidity | $90 \sim 95\% \text{RH}$ |
| | Applied current | Rated current |
| | Time | $500 + 24 / - 0$ hour |
| Recovery : At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48hrs. | | |

| 19. Low temperature life test | | |
|-------------------------------|--|--|
| Specified Value | ME series | Inductance change : Within $\pm 10\%$ No significant abnormality in appearance. |
| | ME-H series | |
| Test Methods and Remarks | The test samples shall be soldered to the test board by the reflow. After that, the test samples shall be placed at test conditions as shown in below table. | |
| | Temperature | $-40 \pm 2^{\circ}\text{C}$ |
| | Time | $500 + 24 / - 0$ hour |
| | Recovery : At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48hrs. | |

| 20. High temperature life test | | |
|--------------------------------|--|--|
| Specified Value | ME series | Inductance change : Within $\pm 10\%$ No significant abnormality in appearance. |
| | ME-H series | |
| Test Methods and Remarks | The test samples shall be soldered to the test board by the reflow. After that, the test samples shall be placed at test conditions as shown in below table. | |
| | Temperature | $125 \pm 2^{\circ}\text{C}$ |
| | Time | $500 + 24 / - 0$ hour |
| | Recovery : At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48hrs. | |

| 21. Loading at high temperature life test | | |
|---|-------------|---|
| Specified Value | ME series | — |
| | ME-H series | |

22. Standard condition

| | | |
|-----------------|-------------|--|
| Specified Value | ME series | Standard test condition : Unless otherwise specified, temperature is $20 \pm 15^{\circ}\text{C}$ and $65 \pm 20\%$ of relative humidity. When there is any question concerning measurement result: In order to provide correlation data, the test shall be condition of $20 \pm 2^{\circ}\text{C}$ of temperature, $65 \pm 5\%$ relative humidity. Inductance is in accordance with our measured value. |
| | ME-H series | |

METAL WIRE-WOUND CHIP POWER INDUCTORS (MCOIL™ ME SERIES/MCOIL™ ME-H SERIES)

PRECAUTIONS

1. Circuit Design

| | |
|-------------|---|
| Precautions | <ul style="list-style-type: none"> ◆Operating environment 1. The products described in this specification are intended for use in general electronic equipment,(office supply equipment, telecommunications systems, measuring equipment, and household equipment). They are not intended for use in mission-critical equipment or systems requiring special quality and high reliability (traffic systems, safety equipment, aerospace systems, nuclear control systems and medical equipment including life-support systems,) where product failure might result in loss of life, injury or damage. For such uses, contact TAIYO YUDEN Sales Department in advance. |
|-------------|---|

2. PCB Design

| | |
|--------------------------|--|
| Precautions | <ul style="list-style-type: none"> ◆Land pattern design 1. Please refer to a recommended land pattern. |
| Technical considerations | <ul style="list-style-type: none"> ◆Land pattern design Surface Mounting ▪ Mounting and soldering conditions should be checked beforehand. ▪ Applicable soldering process to this products is reflow soldering only. |

3. Considerations for automatic placement

| | |
|--------------------------|---|
| Precautions | <ul style="list-style-type: none"> ◆Adjustment of mounting machine 1. Excessive impact load should not be imposed on the products when mounting onto the PC boards. 2. Mounting and soldering conditions should be checked beforehand. |
| Technical considerations | <ul style="list-style-type: none"> ◆Adjustment of mounting machine 1. When installing products, care should be taken not to apply distortion stress as it may deform the products. |

4. Soldering

| | |
|--------------------------|--|
| Precautions | <ul style="list-style-type: none"> ◆Reflow soldering 1. Please contact any of our offices for a reflow soldering, and refer to the recommended condition specified. 2. The product shall be used reflow soldering only. 3. Please do not add any stress to a product until it returns in normal temperature after reflow soldering. ◆Lead free soldering 1. When using products with lead free soldering, we request to use them after confirming adhesion, temperature of resistance to soldering heat, soldering etc sufficiently. |
| Technical considerations | <ul style="list-style-type: none"> ◆Reflow soldering 1. If products are used beyond the range of the recommended conditions, heat stresses may deform the products, and consequently degrade the reliability of the products. <p>Recommended reflow condition (Pb free solder)</p> <p>Temperature [°C]</p> <p>Heating Time [sec]</p> <p>150~180</p> <p>90±30sec</p> <p>30±10sec</p> <p>230°C min</p> <p>5sec max</p> <p>Peak: 250+5/-0°C</p> |

5. Cleaning

| | |
|--------------------------|---|
| Precautions | <ul style="list-style-type: none"> ◆Cleaning conditions 1. Washing by supersonic waves shall be avoided. |
| Technical considerations | <ul style="list-style-type: none"> ◆Cleaning conditions 1. If washed by supersonic waves, the products might be broken. |

| 6. Handling | |
|--------------------------|--|
| Precautions | <ul style="list-style-type: none"> ◆ Handling <ol style="list-style-type: none"> 1. Keep the product away from all magnets and magnetic objects. ◆ Breakaway PC boards (splitting along perforations) <ol style="list-style-type: none"> 1. When splitting the PC board after mounting product, care should be taken not to give any stresses of deflection or twisting to the board. 2. Board separation should not be done manually, but by using the appropriate devices. ◆ Mechanical considerations <ol style="list-style-type: none"> 1. Please do not give the product any excessive mechanical shocks. 2. Please do not add any shock and power to a product in transportation. ◆ Pick-up pressure <ol style="list-style-type: none"> 1. Please do not push to add any pressure to a winding part. Please do not give any shock and push into a ferrite core exposure part. ◆ Packing <ol style="list-style-type: none"> 1. Please avoid accumulation of a packing box as much as possible. |
| Technical considerations | <ul style="list-style-type: none"> ◆ Handling <ol style="list-style-type: none"> 1. There is a case that a characteristic varies with magnetic influence. ◆ Breakaway PC boards (splitting along perforations) <ol style="list-style-type: none"> 1. The position of the product on PCBs shall be carefully considered to minimize the stress caused from splitting of the PCBs. ◆ Mechanical considerations <ol style="list-style-type: none"> 1. There is a case to be damaged by a mechanical shock. 2. There is a case to be broken by the handling in transportation. ◆ Pick-up pressure <ol style="list-style-type: none"> 1. Damage and a characteristic can vary with an excessive shock or stress. ◆ Packing <ol style="list-style-type: none"> 1. If packing boxes are accumulated, that could cause a deformation on packing tapes or a damage on the products. |
| 7. Storage conditions | |
| Precautions | <ul style="list-style-type: none"> ◆ Storage <ol style="list-style-type: none"> 1. To maintain the solderability of terminal electrodes and to keep the packing material in good condition, temperature and humidity in the storage area should be controlled. <ul style="list-style-type: none"> ▪ Recommended conditions <ul style="list-style-type: none"> Ambient temperature : 0~40°C Humidity : Below 70% RH ▪ The ambient temperature must be kept below 30°C. Even under ideal storage conditions, solderability of products electrodes may decrease as time passes. <ul style="list-style-type: none"> For this reason, product should be used within 6 months from the time of delivery. In case of storage over 6 months, solderability shall be checked before actual usage. |
| Technical considerations | <ul style="list-style-type: none"> ◆ Storage <ol style="list-style-type: none"> 1. Under a high temperature and humidity environment, problems such as reduced solderability caused by oxidation of terminal electrodes and deterioration of taping/packaging materials may take place. |

METAL MULTILAYER CHIP POWER INDUCTORS(MCOIL™ MC SERIES)



REFLOW

■ PARTS NUMBER

* Operating Temp.: -40~+125°C(Including self-generated heat)

| | | | | | | | | | | | | | | |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| M | C | K | K | 2 | 0 | 1 | 2 | T | 1 | R | 0 | M | △ | △ |
| ① | ② | ③ | ④ | ⑤ | ⑥ | ⑦ | ⑧ | | | | | | | |

△=Blank space

①Series name

| Code | Series name |
|------|---|
| MC | Metal base multilayer chip power inductor |

②Thickness

| Code | Thickness [mm] |
|------|----------------|
| EE | 0.55 max |
| FK | 0.60 max |
| FE | 0.65 max |
| HK | 0.80 max |
| KK | 1.0 max |

③Dimensions (L × W)

| Code | Type (inch) | Dimensions (L × W) [mm] |
|------|-------------|-------------------------|
| 1005 | 1005(0402) | 1.0 × 0.5 |
| 1608 | 1608(0603) | 1.6 × 0.8 |
| 2012 | 2012(0805) | 2.0 × 1.25 |

④Packaging

| Code | Packaging |
|------|-----------|
| T | Taping |

⑤Nominal inductance

| Code (example) | Nominal inductance [μH] |
|----------------|-------------------------|
| R24 | 0.24 |
| R47 | 0.47 |
| 1R0 | 1.0 |

※R=Decimal point

⑥Inductance tolerance

| Code | Inductance tolerance |
|------|----------------------|
| M | ±20% |

⑦Special code1

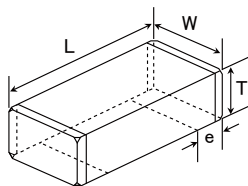
| Code | Special code1 |
|------|--------------------------|
| △ | Standard |
| G | 5 surface terminal |
| H | Standard (Internal Code) |

⑧Special code2

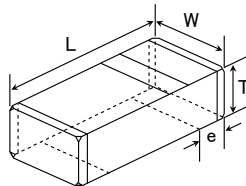
| Code | Special code2 |
|------|------------------|
| △ | Non Polarity |
| N | Polarity Marking |

■ STANDARD EXTERNAL DIMENSIONS / STANDARD QUANTITY

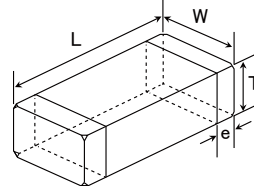
Standard



Polarity Marking



5 surface terminal



| Type | L | W | T | e | Standard quantity [pcs] | |
|--------------------|--------------------------|---------------------------|-------------------------|----------------------------|-------------------------|---------------|
| | | | | | Paper tape | Embossed tape |
| MCEE1005 (0402) | 1.0±0.2 (0.039±0.008) | 0.5±0.2 (0.020±0.008) | 0.55 max (0.022 max) | 0.25±0.15 (0.010±0.006) | 10000 | |
| MCFK1608 (0603) | 1.6±0.2 (0.063±0.008) | 0.8±0.2 (0.031±0.008) | 0.60 max (0.024 max) | 0.3±0.2 (0.012±0.008) | 4000 | — |
| MCFE1608 (0603) | 1.6±0.2 (0.063±0.008) | 0.8±0.2 (0.031±0.008) | 0.65 max (0.026 max) | 0.3±0.2 (0.012±0.008) | 4000 | — |
| MCKK1608 (0603) | 1.6±0.2 (0.063±0.008) | 0.8±0.2 (0.031±0.008) | 1.0 max (0.039 max) | 0.3±0.2 (0.012±0.008) | — | 3000 |
| MCHK2012 (0805) | 2.0±0.2 (0.079±0.008) | 1.25±0.2 (0.049±0.008) | 0.80 max (0.031 max) | 0.5±0.3 (0.02±0.012) | 4000 | — |
| MCKK2012 (0805) | 2.0±0.2 (0.079±0.008) | 1.25±0.2 (0.049±0.008) | 1.0 max (0.039 max) | 0.5±0.3 (0.02±0.012) | — | 3000 |

Unit: mm (inch)

► This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our product specification sheets. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our website (<http://www.ty-top.com/>).

■ PARTS NUMBER

● MC1005

| Parts number | EHS | Nominal inductance [μ H] | Inductance tolerance | DC Resistance [m Ω] | | Rated current(I _{dc1}) [A] (max.) | Rated current(I _{dc2}) [A] (max.) | Measuring frequency [MHz] | Thickness [mm] (max.) |
|-----------------|------|----------------------------------|----------------------|--------------------------------|--------|--|--|------------------------------|--------------------------|
| | | | | (max.) | (typ.) | | | | |
| MCEE1005TR10MHN | RoHS | 0.10 | ±20% | 50 | 41 | 2.00 | 2.00 | 1 | 0.55 |
| MCEE1005TR22MHN | RoHS | 0.22 | ±20% | 80 | 65 | 1.60 | 1.60 | 1 | 0.55 |
| MCEE1005TR47MHN | RoHS | 0.47 | ±20% | 140 | 114 | 1.20 | 1.20 | 1 | 0.55 |
| MCEE1005TR10MHN | RoHS | 1.0 | ±20% | 300 | 244 | 1.00 | 0.80 | 1 | 0.55 |

● MC1608

| Parts number | EHS | Nominal inductance [μ H] | Inductance tolerance | DC Resistance [m Ω] | | Rated current(I _{dc1}) [A] (max.) | Rated current(I _{dc2}) [A] (max.) | Measuring frequency [MHz] | Thickness [mm] (max.) |
|-----------------|------|----------------------------------|----------------------|--------------------------------|--------|--|--|------------------------------|--------------------------|
| | | | | (max.) | (typ.) | | | | |
| MCFK1608TR24M | RoHS | 0.24 | ±20% | 50 | 40 | 2.30 | 2.10 | 1 | 0.60 |
| MCFK1608TR47M | RoHS | 0.47 | ±20% | 85 | 69 | 1.90 | 1.60 | 1 | 0.60 |
| MCFK1608TR10M | RoHS | 1.0 | ±20% | 224 | 182 | 1.50 | 0.90 | 1 | 0.60 |
| MCFE1608TR24MG | RoHS | 0.24 | ±20% | 100 | 75 | 2.60 | 1.50 | 1 | 0.65 |
| MCFE1608TR47MG | RoHS | 0.47 | ±20% | 150 | 114 | 2.00 | 1.20 | 1 | 0.65 |
| MCFE1608TR10MG | RoHS | 1.0 | ±20% | 340 | 270 | 1.40 | 0.80 | 1 | 0.65 |
| MCKK1608TR24M N | RoHS | 0.24 | ±20% | 38 | 35 | 2.80 | 2.60 | 1 | 1.00 |
| MCKK1608TR47M N | RoHS | 0.47 | ±20% | 55 | 44 | 2.40 | 2.00 | 1 | 1.00 |
| MCKK1608TR10M N | RoHS | 1.0 | ±20% | 123 | 100 | 2.00 | 1.30 | 1 | 1.00 |

● MC2012

| Parts number | EHS | Nominal inductance [μ H] | Inductance tolerance | DC Resistance [m Ω] | | Rated current(I _{dc1}) [A] (max.) | Rated current(I _{dc2}) [A] (max.) | Measuring frequency [MHz] | Thickness [mm] (max.) |
|---------------|------|----------------------------------|----------------------|--------------------------------|--------|--|--|------------------------------|--------------------------|
| | | | | (max.) | (typ.) | | | | |
| MCHK2012TR24M | RoHS | 0.24 | ±20% | 24 | 19 | 4.32 | 3.60 | 1 | 0.80 |
| MCHK2012TR47M | RoHS | 0.47 | ±20% | 36 | 30 | 3.21 | 3.15 | 1 | 0.80 |
| MCHK2012TR10M | RoHS | 1.0 | ±20% | 111 | 90 | 2.26 | 1.47 | 1 | 0.80 |
| MCKK2012TR24M | RoHS | 0.24 | ±20% | 25 | 20 | 6.20 | 4.00 | 1 | 1.00 |
| MCKK2012TR47M | RoHS | 0.47 | ±20% | 39 | 32 | 4.50 | 3.10 | 1 | 1.00 |
| MCKK2012TR10M | RoHS | 1.0 | ±20% | 90 | 73 | 3.60 | 2.10 | 1 | 1.00 |

※I_{dc1} is the DC value at which the initial L value is decreased within 30% by the application of DC bias. (at 20°C)

※I_{dc2} is the DC value at which the temperature of element is increased within 40°C by the application of DC bias. (at 20°C)

Multilayer chip inductors

Multilayer chip inductors for high frequency, Multilayer chip bead inductors

Multilayer common mode choke coils (MC series F type)

Metal Multilayer Chip Power Inductors (MCOIL™ MC series)

PACKAGING

① Minimum Quantity

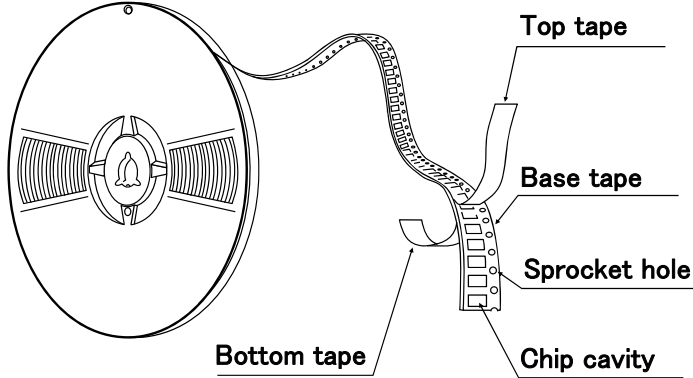
● Tape & Reel Packaging

| Type | Thickness mm (inch) | Standard Quantity [pcs] | |
|-----------------|------------------------|-------------------------|---------------|
| | | Paper Tape | Embossed Tape |
| CK1608 (0603) | 0.8 (0.031) | 4000 | — |
| CK2125 (0805) | 0.85 (0.033) | 4000 | — |
| | 1.25 (0.049) | — | 2000 |
| CKS2125 (0805) | 0.85 (0.033) | 4000 | — |
| | 1.25 (0.049) | — | 2000 |
| CKP1608 (0603) | 0.8 (0.031) | 4000 | — |
| CKP2012 (0805) | 0.9 (0.035) | — | 3000 |
| CKP2016 (0806) | 0.9 (0.035) | — | 3000 |
| CKP2520 (1008) | 0.7 (0.028) | — | 3000 |
| | 0.9 (0.035) | — | 3000 |
| | 1.1 (0.043) | — | 2000 |
| LK1005 (0402) | 0.5 (0.020) | 10000 | — |
| LK1608 (0603) | 0.8 (0.031) | 4000 | — |
| LK2125 (0805) | 0.85 (0.033) | 4000 | — |
| | 1.25 (0.049) | — | 2000 |
| HK0603 (0201) | 0.3 (0.012) | 15000 | — |
| HK1005 (0402) | 0.5 (0.020) | 10000 | — |
| HK1608 (0603) | 0.8 (0.031) | 4000 | — |
| HK2125 (0805) | 0.85 (0.033) | — | 4000 |
| | 1.0 (0.039) | — | 3000 |
| HKQ0603W (0201) | 0.3 (0.012) | 15000 | — |
| HKQ0603S (0201) | 0.3 (0.012) | 15000 | — |
| HKQ0603U (0201) | 0.3 (0.012) | 15000 | — |
| AQ105 (0402) | 0.5 (0.020) | 10000 | — |
| BK0603 (0201) | 0.3 (0.012) | 15000 | — |
| BK1005 (0402) | 0.5 (0.020) | 10000 | — |
| BKH0603 (0201) | 0.3 (0.012) | 15000 | — |
| BKH1005 (0402) | 0.5 (0.020) | 10000 | — |
| BK1608 (0603) | 0.8 (0.031) | 4000 | — |
| BK2125 (0805) | 0.85 (0.033) | 4000 | — |
| | 1.25 (0.049) | — | 2000 |
| BK2010 (0804) | 0.45 (0.018) | 4000 | — |
| BK3216 (1206) | 0.8 (0.031) | — | 4000 |
| BKP0603 (0201) | 0.3 (0.012) | 15000 | — |
| BKP1005 (0402) | 0.5 (0.020) | 10000 | — |
| BKP1608 (0603) | 0.8 (0.031) | 4000 | — |
| BKP2125 (0805) | 0.85 (0.033) | 4000 | — |
| MCF0605 (0202) | 0.3 (0.012) | 15000 | — |
| MCF0806 (0302) | 0.4 (0.016) | — | 10000 |
| MCF1210 (0504) | 0.55 (0.022) | — | 5000 |
| MCF2010 (0804) | 0.45 (0.018) | — | 4000 |
| MCEE1005 (0402) | 0.55 (0.022) | 10000 | — |
| MCFK1608 (0603) | 0.6 (0.024) | 4000 | — |
| MCFE1608 (0603) | 0.65 (0.026) | 4000 | — |
| MCKK1608 (0603) | 1.0 (0.039) | — | 3000 |
| MCHK2012 (0806) | 0.8 (0.031) | 4000 | — |
| MCKK2012 (0805) | 1.0 (0.039) | — | 3000 |

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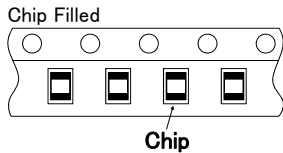
② Taping material

● Card board carrier tape

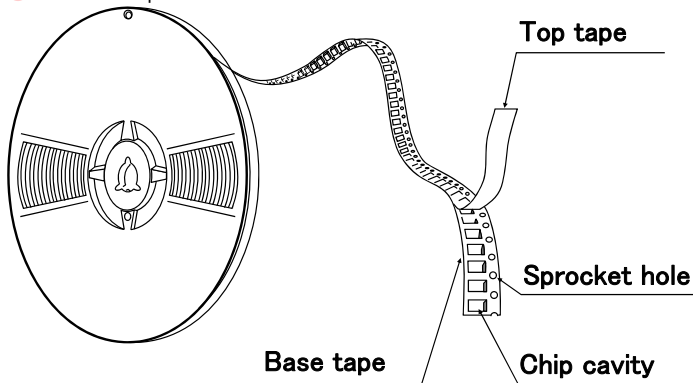


| | |
|-----|------|
| CK | 1608 |
| CKP | 1608 |
| CK | 2125 |
| CKS | 2125 |
| LK | 1005 |
| LK | 1608 |
| LK | 2125 |
| HK | 0603 |
| HK | 1005 |
| HK | 1608 |
| HKQ | 0603 |
| AQ | 105 |

| | |
|-----|------|
| BK | 0603 |
| BK | 1005 |
| BK | 1608 |
| BK | 2125 |
| BK | 2010 |
| BKP | 0603 |
| BKP | 1005 |
| BKP | 1608 |
| BKP | 2125 |
| BKH | 0603 |
| BKH | 1005 |
| MCF | 0605 |
| MC | 1005 |
| MC | 1608 |
| MC | 2012 |

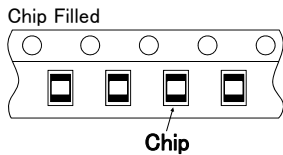


● Embossed Tape



| | |
|-----|------|
| CK | 2125 |
| CKS | 2125 |
| CKP | 2012 |
| CKP | 2016 |
| CKP | 2520 |
| LK | 2125 |
| HK | 2125 |

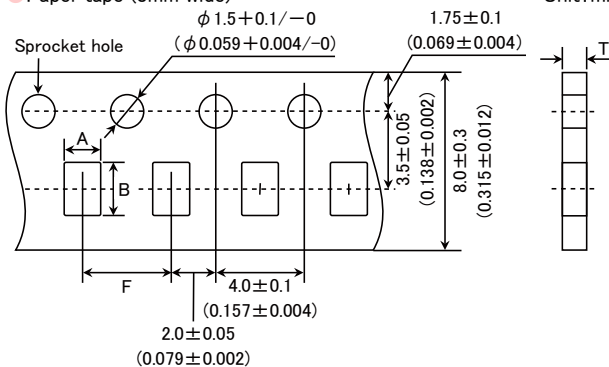
| | |
|-----|------|
| BK | 2125 |
| BK | 3216 |
| MCF | 0806 |
| MCF | 1210 |
| MCF | 2010 |
| MC | 1608 |
| MC | 2012 |



③ Taping Dimensions

● Paper tape (8mm wide)

Unit: mm (inch)

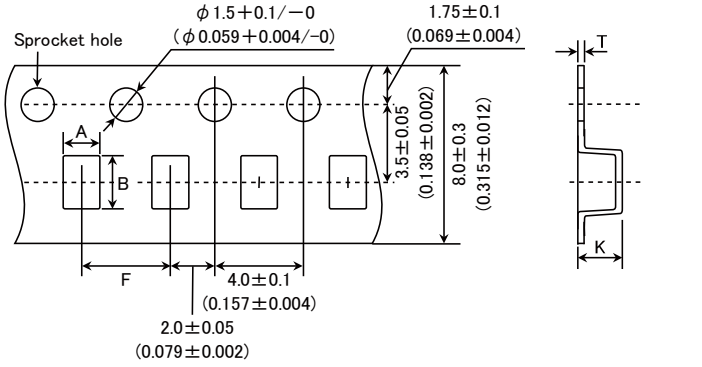


▶ This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (<http://www.ty-top.com/>).

| Type | Thickness mm (inch) | Chip cavity | | Insertion Pitch | Tape Thickness |
|----------------|------------------------|----------------------------|----------------------------|---------------------------|-----------------------|
| | | A | B | F | T |
| CK1608(0603) | 0.8 (0.031) | 1.0±0.2 (0.039±0.008) | 1.8±0.2 (0.071±0.008) | 4.0±0.1 (0.157±0.004) | 1.1max (0.043max) |
| CK2125(0805) | 0.85(0.033) | 1.5±0.2 (0.059±0.008) | 2.3±0.2 (0.091±0.008) | 4.0±0.1 (0.157±0.004) | 1.1max (0.043max) |
| CKS2125(0805) | 0.85(0.033) | 1.5±0.2 (0.059±0.008) | 2.3±0.2 (0.091±0.008) | 4.0±0.1 (0.157±0.004) | 1.1max (0.043max) |
| CKP1608(0603) | 0.8 (0.031) | 1.0±0.2 (0.039±0.008) | 1.8±0.2 (0.071±0.008) | 4.0±0.1 (0.157±0.004) | 1.1max (0.043max) |
| LK1005(0402) | 0.5 (0.020) | 0.65±0.1 (0.026±0.004) | 1.15±0.1 (0.045±0.004) | 2.0±0.05 (0.079±0.002) | 0.8max (0.031max) |
| LK1608(0603) | 0.8 (0.031) | 1.0±0.2 (0.039±0.008) | 1.8±0.2 (0.071±0.008) | 4.0±0.1 (0.157±0.004) | 1.1max (0.043max) |
| LK2125(0805) | 0.85(0.033) | 1.5±0.2 (0.059±0.008) | 2.3±0.2 (0.091±0.008) | 4.0±0.1 (0.157±0.004) | 1.1max (0.043max) |
| HK0603(0201) | 0.3 (0.012) | 0.40±0.06 (0.016±0.002) | 0.70±0.06 (0.028±0.002) | 2.0±0.05 (0.079±0.002) | 0.45max (0.018max) |
| HK1005(0402) | 0.5 (0.020) | 0.65±0.1 (0.026±0.004) | 1.15±0.1 (0.045±0.004) | 2.0±0.05 (0.079±0.002) | 0.8max (0.031max) |
| HK1608(0603) | 0.8 (0.031) | 1.0±0.2 (0.039±0.008) | 1.8±0.2 (0.071±0.008) | 4.0±0.1 (0.157±0.004) | 1.1max (0.043max) |
| HKQ0603W(0201) | 0.3 (0.012) | 0.40±0.06 (0.016±0.002) | 0.70±0.06 (0.028±0.002) | 2.0±0.05 (0.079±0.002) | 0.45max (0.018max) |
| HKQ0603S(0201) | 0.3 (0.012) | 0.40±0.06 (0.016±0.002) | 0.70±0.06 (0.028±0.002) | 2.0±0.05 (0.079±0.002) | 0.45max (0.018max) |
| HKQ0603U(0201) | 0.3 (0.012) | 0.40±0.06 (0.016±0.002) | 0.70±0.06 (0.028±0.002) | 2.0±0.05 (0.079±0.002) | 0.45max (0.018max) |
| AQ105(0402) | 0.5 (0.020) | 0.75±0.1 (0.030±0.004) | 1.15±0.1 (0.045±0.004) | 2.0±0.05 (0.079±0.002) | 0.8max (0.031max) |
| BK0603(0201) | 0.3 (0.012) | 0.40±0.06 (0.016±0.002) | 0.70±0.06 (0.028±0.002) | 2.0±0.05 (0.079±0.002) | 0.45max (0.018max) |
| BK1005(0402) | 0.5 (0.020) | 0.65±0.1 (0.026±0.004) | 1.15±0.1 (0.045±0.004) | 2.0±0.05 (0.079±0.002) | 0.8max (0.031max) |
| BK1608(0603) | 0.8 (0.031) | 1.0±0.2 (0.039±0.008) | 1.8±0.2 (0.071±0.008) | 4.0±0.1 (0.157±0.004) | 1.1max (0.043max) |
| BK2125(0805) | 0.85(0.033) | 1.5±0.2 (0.059±0.008) | 2.3±0.2 (0.091±0.008) | 4.0±0.1 (0.157±0.004) | 1.1max (0.043max) |
| BK2010(0804) | 0.45(0.018) | 1.2±0.1 (0.047±0.004) | 2.17±0.1 (0.085±0.004) | 4.0±0.1 (0.157±0.004) | 0.8max (0.031max) |
| BKP0603(0201) | 0.3 (0.012) | 0.40±0.06 (0.016±0.002) | 0.70±0.06 (0.028±0.002) | 2.0±0.05 (0.079±0.002) | 0.45max (0.018max) |
| BKP1005(0402) | 0.5 (0.020) | 0.65±0.1 (0.026±0.004) | 1.15±0.1 (0.045±0.004) | 2.0±0.05 (0.079±0.002) | 0.8max (0.031max) |
| BKP1608(0603) | 0.8 (0.031) | 1.0±0.2 (0.039±0.008) | 1.8±0.2 (0.071±0.008) | 4.0±0.1 (0.157±0.004) | 1.1max (0.043max) |
| BKP2125(0805) | 0.85(0.033) | 1.5±0.2 (0.059±0.008) | 2.3±0.2 (0.091±0.008) | 4.0±0.1 (0.157±0.004) | 1.1max (0.043max) |
| BKH0603(0201) | 0.3 (0.012) | 0.40±0.06 (0.016±0.002) | 0.70±0.06 (0.028±0.002) | 2.0±0.05 (0.079±0.002) | 0.45max (0.018max) |
| BKH1005(0402) | 0.5 (0.020) | 0.65±0.1 (0.026±0.004) | 1.15±0.1 (0.045±0.004) | 2.0±0.05 (0.079±0.002) | 0.8max (0.031max) |
| MCF0605(0202) | 0.3 (0.012) | 0.62±0.03 (0.024±0.001) | 0.77±0.03 (0.030±0.001) | 2.0±0.05 (0.079±0.002) | 0.45max (0.018max) |
| MCFK1608(0603) | 0.6 (0.024) | 1.1±0.05 (0.043±0.002) | 1.9±0.05 (0.075±0.002) | 4.0±0.1 (0.157±0.004) | 0.72max (0.028max) |
| MCEE1005(0402) | 0.55(0.021) | 0.8±0.05 (0.031±0.002) | 1.3±0.05 (0.051±0.002) | 2.0±0.05 (0.079±0.002) | 0.6max (0.016max) |
| MCFE1608(0603) | 0.65(0.026) | 1.1±0.05 (0.043±0.002) | 1.9±0.05 (0.075±0.002) | 4.0±0.1 (0.157±0.004) | 0.9max (0.035max) |
| MCHK2012(0805) | 0.8 (0.031) | 1.55±0.2 (0.061±0.008) | 2.3±0.2 (0.091±0.008) | 4.0±0.1 (0.157±0.004) | 0.9max (0.035max) |

Unit : mm (inch)

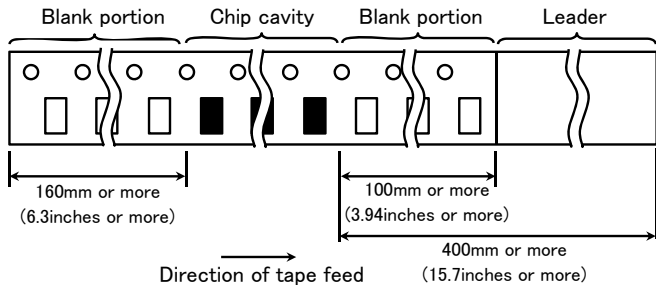
● Embossed Tape (8mm wide)



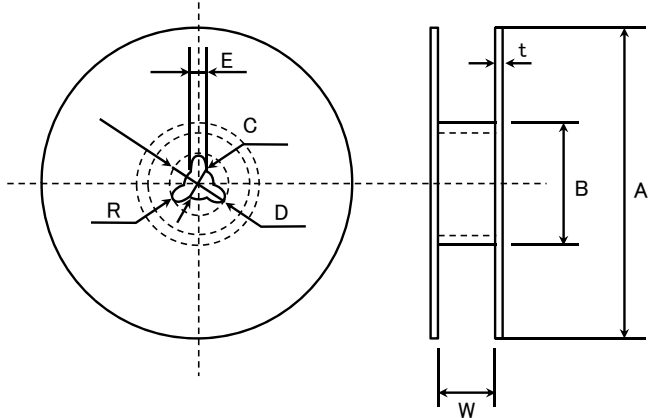
| Type | Thickness mm (inch) | Chip cavity | | Insertion Pitch | Tape Thickness | |
|----------------|------------------------|--------------------------------|--------------------------------|-------------------------------|-----------------|-----------------|
| | | A | B | F | K | T |
| CK2125(0805) | 1.25 (0.049) | 1.5 ± 0.2 (0.059 ± 0.008) | 2.3 ± 0.2 (0.091 ± 0.008) | 4.0 ± 0.1 (0.157 ± 0.004) | 2.0 (0.079) | 0.3 (0.012) |
| CKS2125(0805) | 1.25 (0.049) | 1.5 ± 0.2 (0.059 ± 0.008) | 2.3 ± 0.2 (0.091 ± 0.008) | 4.0 ± 0.1 (0.157 ± 0.004) | 2.0 (0.079) | 0.3 (0.012) |
| CKP2012(0805) | 0.9 (0.035) | 1.55 ± 0.2 (0.061 ± 0.008) | 2.3 ± 0.2 (0.091 ± 0.008) | 4.0 ± 0.1 (0.157 ± 0.004) | 1.3 (0.051) | 0.3 (0.012) |
| CKP2016(0806) | 0.9 (0.035) | 1.8 ± 0.1 (0.071 ± 0.004) | 2.2 ± 0.1 (0.087 ± 0.004) | 4.0 ± 0.1 (0.157 ± 0.004) | 1.3 (0.051) | 0.25 (0.01) |
| CKP2520(1008) | 0.7 (0.028) | 2.3 ± 0.1 (0.091 ± 0.004) | 2.8 ± 0.1 (0.110 ± 0.004) | 4.0 ± 0.1 (0.157 ± 0.004) | 1.4 (0.055) | 0.3 (0.012) |
| | 0.9 (0.035) | | | | 1.4 (0.055) | |
| | 1.1 (0.043) | | | | 1.7 (0.067) | |
| | 1.1 (0.043) | | | | 1.7 (0.067) | |
| LK2125(0805) | 1.25 (0.049) | 1.5 ± 0.2 (0.059 ± 0.008) | 2.3 ± 0.2 (0.091 ± 0.008) | 4.0 ± 0.1 (0.157 ± 0.004) | 2.0 (0.079) | 0.3 (0.012) |
| HK2125(0805) | 0.85 (0.033) | 1.5 ± 0.2 (0.059 ± 0.008) | 2.3 ± 0.2 (0.091 ± 0.008) | 4.0 ± 0.1 (0.157 ± 0.004) | 1.5 (0.059) | 0.3 (0.012) |
| | 1.0 (0.039) | | | | 2.0 (0.079) | |
| BK2125(0805) | 1.25 (0.049) | 1.5 ± 0.2 (0.059 ± 0.008) | 2.3 ± 0.2 (0.091 ± 0.008) | 4.0 ± 0.1 (0.157 ± 0.004) | 2.0 (0.079) | 0.3 (0.012) |
| BK3216(1206) | 0.8 (0.031) | 1.9 ± 0.1 (0.075 ± 0.004) | 3.5 ± 0.1 (0.138 ± 0.004) | 4.0 ± 0.1 (0.157 ± 0.004) | 1.4 (0.055) | 0.3 (0.012) |
| MCF0806(0302) | 0.4 (0.016) | 0.75 ± 0.05 (0.030 ± 0.002) | 0.95 ± 0.05 (0.037 ± 0.002) | 2.0 ± 0.05 (0.079 ± 0.002) | 0.55 (0.022) | 0.3 (0.012) |
| MCF1210(0504) | 0.55 (0.022) | 1.15 ± 0.05 (0.045 ± 0.002) | 1.40 ± 0.05 (0.055 ± 0.002) | 4.0 ± 0.1 (0.157 ± 0.004) | 0.65 (0.026) | 0.3 (0.012) |
| MCF2010(0804) | 0.45 (0.018) | 1.1 ± 0.1 (0.043 ± 0.004) | 2.3 ± 0.1 (0.091 ± 0.004) | 4.0 ± 0.1 (0.157 ± 0.004) | 0.85 (0.033) | 0.3 (0.012) |
| MCKK1608(0603) | 1.0 (0.039) | 1.1 ± 0.1 (0.043 ± 0.004) | 1.95 ± 0.1 (± 0.004) | 4.0 ± 0.1 (0.157 ± 0.004) | 1.4 (0.055) | 0.25 (0.01) |
| MCKK2012(0805) | 1.0 (0.039) | 1.55 ± 0.2 (0.061 ± 0.008) | 2.3 ± 0.2 (0.091 ± 0.008) | 4.0 ± 0.1 (0.157 ± 0.004) | 1.35 (0.053) | 0.25 (0.010) |

Unit : mm (inch)

④ LEADER AND BLANK PORTION



⑤ Reel Size



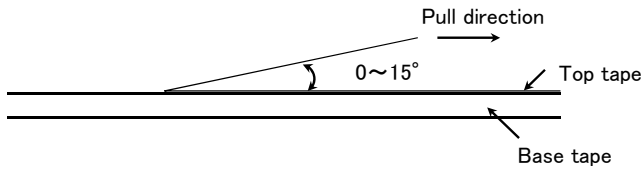
| A | B | C | D | E | R |
|--------------------|-------------------|---------------------|---------------------|---------------|-----|
| $\phi 178 \pm 2.0$ | $\phi 60$ or more | $\phi 13.0 \pm 0.2$ | $\phi 21.0 \pm 0.8$ | 2.0 ± 0.5 | 1.0 |

| | t | W |
|----------------|---------|--------------|
| 4mm width tape | 1.5max. | 5 ± 1.0 |
| 8mm width tape | 2.5max. | 10 ± 1.5 |

(Unit : mm)

⑥ Top tape strength

The top tape requires a peel-off force of 0.1~0.7N in the direction of the arrow as illustrated below.



Multilayer chip inductors

Multilayer chip inductors for high frequency, Multilayer chip bead inductors

Multilayer common mode choke coils (MC series F type)

Metal Multilayer Chip Power Inductors (MCOIL™ MC series)

RELIABILITY DATA

| 1. Operating Temperature Range | | |
|--------------------------------|--|------------|
| Specified Value | BK series | -55~+125°C |
| | BKH series | |
| | BKP series | -55~+85°C |
| | MCF series | -40~+85°C |
| | CK series | -40~+85°C |
| | CKS series | |
| | CKP series | |
| | LK series | |
| | MCOIL™ MC series | |
| | HK0603, HK1005 | -55~+125°C |
| | HK1608, HK2125 | -40~+85°C |
| | HKQ0603 | -55~+125°C |
| AQ105 | | |
| MCOIL™ MC series | -40~+125°C (Including self-generated heat) | |

| 2. Storage Temperature Range | | |
|------------------------------|------------------|------------|
| Specified Value | BK series | -55~+125°C |
| | BKH series | |
| | BKP series | -55~+85°C |
| | MCF series | -40~+85°C |
| | CK series | -40~+85°C |
| | CKS series | |
| | CKP series | |
| | LK series | |
| | MCOIL™ MC series | |
| | HK0603, HK1005 | -55~+125°C |
| | HK1608, HK2125 | -40~+85°C |
| | HKQ0603 | -55~+125°C |
| AQ105 | | |
| MCOIL™ MC series | -40~+85°C | |

| 3. Rated Current | | |
|------------------|---|---|
| Specified Value | BK series | The temperature of the element is increased within 20°C. |
| | BKH series | |
| | BKP series | The temperature of the element is increased within 40°C |
| | MCF series | Refer to each specification. |
| | CK series | The temperature of the element is increased within 20°C. |
| | CKS series | |
| | CKP series | |
| | LK series | The decreasing-rate of inductance value is within 5 % |
| | HK0603, HK1005 | The decreasing-rate of inductance value is within 5 %, or the temperature of the element is increased within 20°C |
| | HK1608, HK2125 | |
| | HKQ0603 | |
| | AQ105 | |
| MCOIL™ MC series | | |
| | Idc1: The decreasing-rate of inductance value is within 30 % Idc2: The temperature of the element is increased within 40°C | |

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For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (<http://www.ty-top.com/>).

| 4. Impedance | | |
|--------------------------|--|---|
| Specified Value | BK series | Refer to each specification. |
| | BKH series | |
| | BKP series | |
| | MCF series | |
| Test Methods and Remarks | BK0603Series, BKP0603Series, BKH Series | Measuring frequency : 100±1MHz Measuring equipment : 4991A (or its equivalent) Measuring jig : 16193A (or its equivalent) |
| | BK1005Series, BKP1005Series, BKH1005Series | Measuring frequency : 100±1MHz Measuring equipment : 4291A (or its equivalent) Measuring jig : 16192A (or its equivalent), HW:16193A (or its equivalent) |
| | BK1608・2125Series, BKP1608・2125Series | Measuring frequency : 100±1MHz Measuring equipment : 4291A (or its equivalent), 4195A (or its equivalent) Measuring jig : 16092A (or its equivalent), HW:16192A (or its equivalent) |
| | BK2010・3216Series | Measuring frequency : 100±1MHz Measuring equipment : 4291A (or its equivalent), 4195A (or its equivalent) Measuring jig : 16192A (or its equivalent) |
| | MCF Series | Measuring frequency : 100±1MHz Measuring equipment : 4291A (or its equivalent) |

| 5. Inductance | | |
|--------------------------|---------------------------|---|
| Specified Value | CK series | Refer to each specification. |
| | CKS series | |
| | CKP series | |
| | LK series | |
| | HK0603, HK1005 | |
| | HK1608, HK2125 | |
| | HKQ0603 | |
| | AQ105 | |
| Test Methods and Remarks | MCOIL™ MC series | |
| | CK, CKS, LK Series | Measuring frequency : Refer to each specification. Measuring equipment /jig : 1608,2125⇒4194A+16085B+16092A (or its equivalent), 4195A+41951+16092A (or its equivalent) 1005⇒4291A+16193A (or its equivalent) Measuring current : 047~4.7 μH ⇒1mArms、5.6~33 μH ⇒0.1mArms |
| | CKP, MCOIL™ MC Series | Measuring frequency : 1MHz Measuring equipment : 4285A (or its equivalent) |
| | HK0603, HK1005, AQ Series | Measuring frequency : 100MHz Measuring equipment /jig : HK0603・AQ105⇒4291A+16197A (or its equivalent) HK1005⇒4291A+16193A (or its equivalent) |
| | HK1608, HK2125 Series | Measuring frequency : ~100nH⇒100MHz、120nH~⇒50MHz Measuring equipment /jig : 4195A+16092A (or its equivalent) |
| | HKQ Series | Measuring frequency : HKQ0603S・HKQ0603U⇒500MHz Measuring frequency : HKQ0603W⇒300/500MHz Measuring equipment /jig : E4991A+16197A (or its equivalent) |

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6. Q

| | | |
|--------------------------|-------------------------------------|---|
| Specified Value | CK series | — |
| | CKS series | |
| | CKP series | |
| | LK series | |
| | HK0603, HK1005 | |
| | HK1608, HK2125 | |
| | HKQ0603 | |
| | AQ105 | |
| MCOIL™ MC series | — | |
| Test Methods and Remarks | LK Series | |
| | Measuring frequency | : Refer to each specification. |
| | Measuring equipment /jig | : 1608,2125⇒4194A+16085B+16092A (or its equivalent) 、 4195A+41951+16092A (or its equivalent) 1005⇒4291A+16193A (or its equivalent) |
| | Measuring current | : 047~4.7 μH ⇒1mArms 、 5.6~33 μH ⇒0.1mArms |
| | HK0603, HK1005, AQ Series | |
| | Measuring frequency | : 100MHz |
| | Measuring equipment /jig | : HK0603・AQ105⇒4291A+16197A (or its equivalent) HK1005⇒4291A+16193A (or its equivalent) |
| | HK1608, HK2125 Series | |
| | Measuring frequency | : ~100nH⇒100MHz 、 120nH~⇒50MHz |
| | Measuring equipment /jig | : 4195A+16092A (or its equivalent) |
| HKQ Series | | |
| Measuring frequency | : HKQ0603S・HKQ0603U⇒ 500MHz | |
| Measuring frequency | : HKQ0603W⇒ 300/500MHz | |
| Measuring equipment /jig | : E4991A+16197A (or its equivalent) | |

7. DC Resistance

| | | |
|--------------------------|---|------------------------------|
| Specified Value | BK series | Refer to each specification. |
| | BKH series | |
| | BKP series | |
| | MCF series | |
| | CK series | |
| | CKS series | |
| | CKP series | |
| | LK series | |
| | HK0603, HK1005 | |
| | HK1608, HK2125 | |
| | HKQ0603 | |
| | AQ105 | |
| MCOIL™ MC series | — | |
| Test Methods and Remarks | Measuring equipment: VOAC-7412, VOAC-7512, VOAC-7521 (made by Iwasaki Tsushinki), HIOKI3227 (or its equivalent) | |

8. Self Resonance Frequency (SRF)

| | | |
|--------------------------|--|--------------------------------------|
| Specified Value | BK series | — |
| | BKH series | |
| | BKP series | |
| | MCF series | |
| | CK series | |
| | CKS series | |
| | CKP series | |
| | LK series | |
| | HK0603, HK1005 | |
| | HK1608, HK2125 | |
| | HKQ0603 | |
| | AQ105 | |
| MCOIL™ MC series | — | |
| Test Methods and Remarks | LK, CK Series : | |
| | Measuring equipment | : 4195A (or its equivalent) |
| | Measuring jig | : 41951 + 16092A (or its equivalent) |
| | HK, HKQ, AQ Series : | |
| Measuring equipment | : 8719C (or its equivalent) ・8753D (or its equivalent) /HK2125 | |

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| 9. Temperature Characteristic | | |
|-------------------------------|--|---|
| Specified Value | BK series | — |
| | BKH series | |
| | BKP series | |
| | MCF series | |
| | CK series | |
| | CKS series | |
| | CKP series | |
| | LK series | |
| | HK0603, HK1005 | |
| | HK1608, HK2125 | |
| | HKQ0603 | |
| | AQ105 | |
| | MCOIL™ MC series | |
| | HK0603, HK1005 | |
| HK1608, HK2125 | | |
| HKQ0603 | | |
| AQ105 | Inductance change: Within ±15% | |
| MCOIL™ MC series | | |
| Test Methods and Remarks | HK, HKQ, AQ Series: Temperature range : -30~+85°C Reference temperature : +20°C MCOIL™ MC series: Temperature range : -40~+85°C Reference temperature : +20°C | |

| 10. Resistance to Flexure of Substrate | | |
|--|--------------------------|-----------------------|
| Specified Value | BK series | No mechanical damage. |
| | BKH series | |
| | BKP series | |
| | MCF series | |
| | CK series | |
| | CKS series | |
| | CKP series | |
| | LK series | |
| | HK0603, HK1005 | |
| | HK1608, HK2125 | |
| | HKQ0603 | |
| | AQ105 | |
| | MCOIL™ MC series | |
| | Test Methods and Remarks | |

| 11. Solderability | | |
|-------------------|--------------------------|--|
| Specified Value | BK series | At least 90% of terminal electrode is covered by new solder. |
| | BKH series | |
| | BKP series | |
| | MCF series | |
| | CK series | |
| | CKS series | |
| | CKP series | |
| | LK series | |
| | HK0603, HK1005 | |
| | HK1608, HK2125 | |
| | HKQ0603 | |
| | AQ105 | |
| | MCOIL™ MC series | |
| | Test Methods and Remarks | |

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| 12. Resistance to Soldering | | |
|-----------------------------|--|--|
| Specified Value | BK series | Appearance: No significant abnormality Impedance change: Within $\pm 30\%$ |
| | BKH series | |
| | BKP series | |
| | MCF series | Appearance: No significant abnormality Impedance change: Within $\pm 20\%$ |
| | CK series | Appearance: No significant abnormality Inductance change: R10~4R7 \Rightarrow Within $\pm 10\%$, 6R8~100 \Rightarrow Within $\pm 15\%$ |
| | CKS series | Appearance: No significant abnormality Inductance change: Within $\pm 20\%$ |
| | CKP series | Appearance: No significant abnormality Inductance change: Within $\pm 30\%$ |
| | LK series | Appearance: No significant abnormality Inductance change: 1005 \Rightarrow Within $\pm 15\%$ 1608,2125 \Rightarrow 47N~4R7: Within $\pm 10\%$ 5R6~330: Within $\pm 15\%$ |
| | HK0603, HK1005 | Appearance: No significant abnormality Inductance change: Within $\pm 5\%$ |
| | HK1608, HK2125 | |
| | HKQ0603 | |
| AQ105 | | |
| MCOIL™ MC series | Appearance: No significant abnormality Inductance change: Within $\pm 10\%$ | |
| Test Methods and Remarks | Solder temperature | : $260 \pm 5^\circ\text{C}$ |
| | Duration | : 10 ± 0.5 sec. |
| | Preheating temperature | : 150 to 180°C |
| | Preheating time | : 3 min. |
| | Flux | : Immersion into methanol solution with colophony for 3 to 5 sec. |
| | Recovery | : 2 to 3 hrs of recovery under the standard condition after the test. (See Note 1) |

(Note 1) When there are questions concerning measurement result; measurement shall be made after 48 ± 2 hrs of recovery under the standard condition.

| 13. Thermal Shock | | | |
|--|--|--|-------------|
| Specified Value | BK series | Appearance: No significant abnormality Impedance change: Within $\pm 30\%$ | |
| | BKH series | | |
| | BKP series | | |
| | MCF series | Appearance: No significant abnormality Impedance change: Within $\pm 20\%$ | |
| | CK series | Appearance: No significant abnormality Inductance change: Within $\pm 20\%$ | |
| | CKS series | Appearance: No significant abnormality Inductance change: Within $\pm 20\%$ | |
| | CKP series | Appearance: No significant abnormality Inductance change: Within $\pm 30\%$ | |
| | LK series | Appearance: No significant abnormality Inductance change: Within $\pm 10\%$ Q change: Within $\pm 30\%$ | |
| | HK0603, HK1005 | Appearance: No significant abnormality Inductance change: Within $\pm 10\%$ Q change: Within $\pm 20\%$ | |
| | HK1608, HK2125 | | |
| | HKQ0603 | | |
| AQ105 | | | |
| MCOIL™ MC series | Appearance: No significant abnormality Inductance change: Within $\pm 10\%$ | | |
| Test Methods and Remarks | Conditions for 1 cycle | | |
| | Step | temperature ($^\circ\text{C}$) | time (min.) |
| | 1 | Minimum operating temperature $+0/-3$ | 30 ± 3 |
| | 2 | Room temperature | 2~3 |
| | 3 | Maximum operating temperature $+3/-0$ | 30 ± 3 |
| | 4 | Room temperature | 2~3 |
| Number of cycles: 5 | | | |
| Recovery: 2 to 3 hrs of recovery under the standard condition after the test. (See Note 1) | | | |

(Note 1) When there are questions concerning measurement result; measurement shall be made after 48 ± 2 hrs of recovery under the standard condition.

| 14. Damp Heat (Steady state) | | |
|-------------------------------|---|--|
| Specified Value | BK series | Appearance: No significant abnormality Impedance change: Within $\pm 30\%$ |
| | BKH series | |
| | BKP series | |
| | MCF series | Appearance: No significant abnormality Impedance change: Within $\pm 20\%$ |
| | CK series | Appearance: No significant abnormality Inductance change: Within $\pm 20\%$ |
| | CKS series | |
| | CKP series | Appearance: No significant abnormality Inductance change: Within $\pm 30\%$ |
| | LK series | Appearance: No significant abnormality Inductance change: 1005,1608 \Rightarrow Within $\pm 10\%$ 2125 \Rightarrow Within $\pm 20\%$ Q change: Within $\pm 30\%$ |
| | HK0603, HK1005 | Appearance: No significant abnormality Inductance change: Within $\pm 10\%$ Q change: Within $\pm 20\%$ |
| | HK1608, HK2125 | |
| | HKQ0603 | |
| | AQ105 | |
| MCOIL™ MC series | Appearance: No significant abnormality Inductance change: Within $\pm 10\%$ | |
| Test Methods and Remarks | BK, BKP, BKH, LK, CK, CKS, CKP, MCF Series: Temperature : $40 \pm 2^\circ\text{C}$ Humidity : 90 to 95%RH Duration : 500 +24/-0 hrs Recovery : 2 to 3 hrs of recovery under the standard condition after the removal from test chamber. (See Note 1) HK, HKQ, AQ, MCOIL™ MC series: Temperature : $60 \pm 2^\circ\text{C}$ Humidity : 90 to 95%RH Duration : 500 +24/-0 hrs Recovery : 2 to 3 hrs of recovery under the standard condition after the removal from test chamber. (See Note 1) | |

(Note 1) When there are questions concerning measurement result; measurement shall be made after 48 ± 2 hrs of recovery under the standard condition.

| 15. Loading under Damp Heat | | |
|-----------------------------|---|---|
| Specified Value | BK series | Appearance: No significant abnormality Impedance change: Within $\pm 30\%$ |
| | BKH series | |
| | BKP series | |
| | MCF series | — |
| | CK series | Appearance: No significant abnormality Inductance change: Within $\pm 20\%$ |
| | CKS series | |
| | CKP series | Appearance: No significant abnormality Inductance change: Within $\pm 30\%$ |
| | LK series | Appearance: No significant abnormality Inductance change: 1005 \Rightarrow Within $\pm 10\%$ 1608 \Rightarrow 0.047~12.0 μH : Within $\pm 10\%$ 15.0~33.0 μH : Within $\pm 15\%$ 2125 \Rightarrow Within $\pm 20\%$ Q change: Within $\pm 30\%$ |
| | HK0603, HK1005 | Appearance: No significant abnormality Inductance change: Within $\pm 10\%$ Q change: Within $\pm 20\%$ |
| | HK1608, HK2125 | |
| | HKQ0603 | |
| | AQ105 | |
| MCOIL™ MC series※ | Appearance: No significant abnormality Inductance change: Within $\pm 10\%$ | |
| Test Methods and Remarks | BK, BKP, BKH, LK, CK, CKS, CKP Series: Temperature : $40 \pm 2^\circ\text{C}$ Humidity : 90 to 95%RH Applied current : Rated current Duration : 500 +24/-0 hrs Recovery : 2 to 3 hrs of recovery under the standard condition after the removal from test chamber. (See Note 1) HK, HKQ, AQ, MCOIL™ MC Series: Temperature : $60 \pm 2^\circ\text{C}$ Humidity : 90 to 95%RH Applied current : Rated current ※MC series ; Idc2max Duration : 500 +24/-0 hrs Recovery : 2 to 3 hrs of recovery under the standard condition after the removal from test chamber. (See Note 1) | |

Note on standard condition: "standard condition" referred to herein is defined as follows:

5 to 35°C of temperature, 45 to 85% relative humidity, and 86 to 106kPa of air pressure.

When there are questions concerning measurement results:

In order to provide correlation data, the test shall be conducted under condition of $20 \pm 2^\circ\text{C}$ of temperature, 60 to 70% relative humidity, and 86 to 106kPa of air pressure.

Unless otherwise specified, all the tests are conducted under the "standard condition."

(Note 1) Measurement shall be made after 48 ± 2 hrs of recovery under the standard condition.

| 16. Loading at High Temperature | | |
|---------------------------------|--|---|
| Specified Value | BK series | Appearance: No significant abnormality Impedance change: Within $\pm 30\%$ |
| | BKH series | |
| | BKP series | |
| | MCF series | Appearance: No significant abnormality Impedance change: Within $\pm 20\%$ |
| | CK series | Appearance: No significant abnormality |
| | CKS series | Inductance change: Within $\pm 20\%$ |
| | CKP series | Appearance: No significant abnormality Inductance change: Within $\pm 30\%$ |
| | LK series | Appearance: No significant abnormality Inductance change: 1005 \Rightarrow Within $\pm 10\%$ 1608 \Rightarrow 0.047~12.0 μH : Within $\pm 10\%$ 15.0~33.0 μH : Within $\pm 15\%$ 2125 \Rightarrow Within $\pm 20\%$ Q change: Within $\pm 30\%$ |
| | HK0603, HK1005 | Appearance: No significant abnormality Inductance change: Within $\pm 10\%$ Q change: Within $\pm 20\%$ |
| | HK1608, HK2125 | |
| | HKQ0603 | |
| | AQ105 | |
| MCOIL™ MC series※ | Appearance: No significant abnormality Inductance change: Within $\pm 10\%$ | |
| Test Methods and Remarks | Temperature : Maximum operating temperature Applied current : Rated current ※MC series ; Idc2max Duration : 500 +24/-0 hrs Recovery : 2 to 3 hrs of recovery under the standard condition after the removal from test chamber. (See Note 1) | |

Note on standard condition: "standard condition" referred to herein is defined as follows:
5 to 35°C of temperature, 45 to 85% relative humidity, and 86 to 106kPa of air pressure.

When there are questions concerning measurement results:

In order to provide correlation data, the test shall be conducted under condition of 20 \pm 2°C of temperature, 60 to 70% relative humidity, and 86 to 106kPa of air pressure. Unless otherwise specified, all the tests are conducted under the "standard condition."

(Note 1) Measurement shall be made after 48 \pm 2 hrs of recovery under the standard condition.

Metal Multilayer Chip Power Inductors (MCOIL™ MC series)

■ PRECAUTIONS

| 1. Circuit Design | |
|---|--|
| Precautions | <ul style="list-style-type: none"> ◆ Operating environment <p>The products described in this specification are intended for use in general electronic equipment.(office supply equipment, telecommunications systems, measuring equipment, and household equipment). They are not intended for use in mission-critical equipment or systems requiring special quality and high reliability (traffic systems, safety equipment, aerospace systems, nuclear control systems and medical equipment including life-support systems,) where product failure might result in loss of life, injury or damage. For such uses, contact TAIYO YUDEN Sales Department in advance.</p> |
| 2. PCB Design | |
| Precautions | <ul style="list-style-type: none"> ◆ Land pattern design <ul style="list-style-type: none"> • Please refer to a recommended land pattern specified. |
| Technical considerations | <ul style="list-style-type: none"> ◆ Land pattern design <ul style="list-style-type: none"> • Surface Mounting • Mounting and soldering conditions should be checked beforehand. • Applicable soldering process to this products is reflow soldering only. |
| 3. Considerations for automatic placement | |
| Precautions | <ul style="list-style-type: none"> ◆ Adjustment of mounting machine <ul style="list-style-type: none"> • Excessive impact load should not be imposed on the products when mounting onto the PC boards. • Mounting and soldering conditions should be checked beforehand. |
| Technical considerations | <ul style="list-style-type: none"> ◆ Adjustment of mounting machine <ul style="list-style-type: none"> • When installing products, care should be taken not to apply distortion stress as it may deform the products. |
| 4. Soldering | |
| Precautions | <ul style="list-style-type: none"> ◆ Reflow soldering <ul style="list-style-type: none"> • Please contact any of our offices for a reflow soldering, and refer to the recommended condition specified. • The product shall be used reflow soldering only. • Please do not add any stress to a product until it returns in normal temperature after reflow soldering. ◆ Lead free soldering <ul style="list-style-type: none"> • When using products with lead free soldering, we request to use them after confirming adhesion, temperature of resistance to soldering heat, soldering etc sufficiently. |
| Technical considerations | <ul style="list-style-type: none"> ◆ Reflow soldering <ul style="list-style-type: none"> • If products are used beyond the range of the recommended conditions, heat stresses may deform the products, and consequently degrade the reliability of the products. <p>Recommended reflow condition (Pb free solder)</p> <p>Temperature [°C]</p> <p>Heating Time [sec]</p> <p>150~180</p> <p>90±30sec</p> <p>40sec max</p> <p>230°C min</p> <p>5sec max</p> <p>Peak: 260+0/-5°C</p> |
| 5. Cleaning | |
| Precautions | <ul style="list-style-type: none"> ◆ Cleaning conditions <ul style="list-style-type: none"> • Washing by supersonic waves shall be avoided. |
| Technical considerations | <ul style="list-style-type: none"> ◆ Cleaning conditions <ul style="list-style-type: none"> • If washed by supersonic waves, the products might be broken. |

| 6. Handling | |
|--------------------------|---|
| Precautions | <ul style="list-style-type: none"> ◆ Handling <ul style="list-style-type: none"> • Keep the product away from all magnets and magnetic objects. ◆ Breakaway PC boards (splitting along perforations) <ul style="list-style-type: none"> • When splitting the PC board after mounting product, care should be taken not to give any stresses of deflection or twisting to the board. • Board separation should not be done manually, but by using the appropriate devices. ◆ Mechanical considerations <ul style="list-style-type: none"> • Please do not give the product any excessive mechanical shocks. • Please do not add any shock and power to a product in transportation. ◆ Application of resin coatings, moldings, etc. to the PCB and components. <ul style="list-style-type: none"> • Please avoid operation, which apply excessive stress and/or temperature to the products such as resin molding. |
| Technical considerations | <ul style="list-style-type: none"> ◆ Handling <ul style="list-style-type: none"> • There is a case that a characteristic varies with magnetic influence. ◆ Breakaway PC boards (splitting along perforations) <ul style="list-style-type: none"> • The position of the product on PCBs shall be carefully considered to minimize the stress caused from splitting of the PCBs. ◆ Mechanical considerations <ul style="list-style-type: none"> • There is a case to be damaged by a mechanical shock. • There is a case to be broken by the handling in transportation. ◆ Application of resin coatings, moldings, etc. to the PCB and components. <ul style="list-style-type: none"> • Damage and a characteristic can vary with an excessive stress and/or temperature |
| 7. Storage conditions | |
| Precautions | <ul style="list-style-type: none"> ◆ Storage <ul style="list-style-type: none"> • To maintain the solderability of terminal electrodes and to keep the packing material in good condition, temperature and humidity in the storage area should be controlled. <li style="padding-left: 40px;">Recommended conditions <li style="padding-left: 60px;">Ambient temperature : 0~40°C <li style="padding-left: 60px;">Humidity : Below 70% RH • The ambient temperature must be kept below 30°C. Even under ideal storage conditions, solderability of products electrodes may decrease as time passes. • For this reason, product should be used within 6 months from the time of delivery. • In case of storage over 6 months, solderability shall be checked before actual usage. |
| Technical considerations | <ul style="list-style-type: none"> ◆ Storage <ul style="list-style-type: none"> • Under a high temperature and humidity environment, problems such as reduced solderability caused by oxidation of terminal electrodes and deterioration of taping/packaging materials may take place. |

METAL CORE SMD POWER INDUCTORS(MCOIL™ MD SERIES)



REFLOW

■ PARTS NUMBER

*Operating Temp.: -40~+125°C (Including self-generated heat)

| | | | | | | | | | | | | | | |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| M | D | K | K | 1 | 6 | 1 | 6 | T | 1 | R | 0 | M | M | △ |
| ① | ② | ③ | ④ | ⑤ | ⑥ | ⑦ | ⑧ | | | | | | | |

△=Blank space

① Series name

| Code | Series name |
|------|-------------------------------|
| MD | Metal base coil specification |

② Dimensions (H)

| Code | Dimensions (H) [mm] |
|------|---------------------|
| JE | 0.95 |
| KK | 1.0 |
| MK | 1.2 |
| PK | 1.4 |
| WK | 2.0 |

③ Dimensions (L × W)

| Code | Dimensions (L × W) [mm] |
|------|-------------------------|
| 1616 | 1.6 × 1.6 |
| 2020 | 2.0 × 2.0 |
| 3030 | 3.0 × 3.0 |
| 4040 | 4.0 × 4.0 |
| 5050 | 4.9 × 4.9 |

④ Packaging

| Code | Packaging |
|------|-----------|
| T | Taping |

⑤ Nominal inductance

| Code (example) | Nominal inductance [μH] |
|----------------|-------------------------|
| R47 | 0.47 |
| 1R0 | 1.0 |
| 4R7 | 4.7 |

※R=Decimal point

⑥ Inductance tolerance

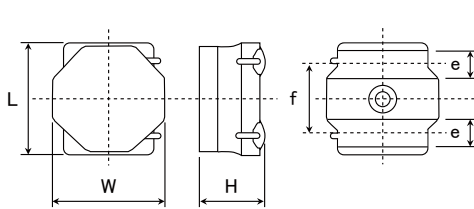
| Code | Inductance tolerance |
|------|----------------------|
| M | ±20% |
| N | ±30% |

⑦ Special code

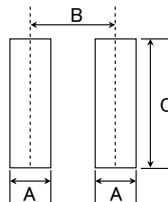
| Code | Special code |
|------|-----------------|
| F | Ferrite coating |
| M | Metal coating |

⑧ Internal code

■ STANDARD EXTERNAL DIMENSIONS / STANDARD QUANTITY



Recommended Land Patterns



| Type | A | B | C |
|------|------|------|------|
| 1616 | 0.5 | 1.10 | 1.65 |
| 2020 | 0.65 | 1.35 | 2.0 |
| 3030 | 0.8 | 2.2 | 2.7 |
| 4040 | 1.2 | 2.8 | 3.7 |
| 5050 | 1.5 | 3.6 | 4.2 |

Unit: mm

| Type | L | W | H | e | f | Standard quantity [pcs] Taping |
|----------|---------------------------|---------------------------|-------------------------|---|---------------------------|--------------------------------|
| MDKK1616 | 1.64±0.1 (0.065±0.004) | 1.64±0.1 (0.065±0.004) | 1.0 max (0.039 max) | 0.40 +0.2/-0.1 (0.016 +0.008/-0.004) | 1.0±0.2 (0.039±0.008) | 2500 |
| MDJE2020 | 2.0±0.15 (0.079±0.006) | 2.0±0.15 (0.079±0.006) | 0.95 max (0.037 max) | 0.50±0.2 (0.02±0.008) | 1.25±0.2 (0.049±0.008) | 2500 |
| MDKK2020 | 2.0±0.15 (0.079±0.006) | 2.0±0.15 (0.079±0.006) | 1.0 max (0.039 max) | 0.50±0.2 (0.02±0.008) | 1.25±0.2 (0.049±0.008) | 2500 |
| MDMK2020 | 2.0±0.15 (0.079±0.006) | 2.0±0.15 (0.079±0.006) | 1.2 max (0.047 max) | 0.50±0.2 (0.02±0.008) | 1.25±0.2 (0.049±0.008) | 2500 |
| MDKK3030 | 3.0±0.1 (0.118±0.004) | 3.0±0.1 (0.118±0.004) | 1.0 max (0.039 max) | 0.90±0.2 (0.035±0.008) | 1.9±0.2 (0.075±0.008) | 2000 |
| MDMK3030 | 3.0±0.1 (0.118±0.004) | 3.0±0.1 (0.118±0.004) | 1.2 max (0.047 max) | 0.90±0.2 (0.035±0.008) | 1.9±0.2 (0.075±0.008) | 2000 |
| MDJE4040 | 4.0±0.2 (0.157±0.008) | 4.0±0.2 (0.157±0.008) | 0.95 max (0.037 max) | 1.1±0.2 (0.043±0.008) | 2.5±0.2 (0.098±0.008) | 1000 |
| MDMK4040 | 4.0±0.2 (0.157±0.008) | 4.0±0.2 (0.157±0.008) | 1.2 max (0.047 max) | 1.1±0.2 (0.043±0.008) | 2.5±0.2 (0.098±0.008) | 1000 |
| MDWK4040 | 4.0±0.2 (0.157±0.008) | 4.0±0.2 (0.157±0.008) | 2.0 max (0.079 max) | 1.1±0.2 (0.043±0.008) | 2.5±0.2 (0.098±0.008) | 700 |
| MDPK5050 | 4.9±0.2 (0.193±0.008) | 4.9±0.2 (0.193±0.008) | 1.4 max (0.055 max) | 1.20±0.2 (0.047±0.008) | 3.3±0.2 (0.130±0.008) | 1000 |

Unit: mm (inch)

▶ This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our product specification sheets. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our website (<http://www.ty-top.com/>).

● MDKK1616 type 【Thickness: 1.0mm max.】

| Parts number | EHS | Nominal inductance [μ H] | Inductance tolerance | DC Resistance[Ω] | | Rated current ※) [mA] | | | | Measuring frequency[MHz] |
|----------------|------|----------------------------------|----------------------|---------------------------|-------|--------------------------|-------|--------------------------------|-------|-----------------------------|
| | | | | | | Saturation current: Idc1 | | Temperature rise current: Idc2 | | |
| | | | | | | Max. | Typ. | Max. | Typ. | |
| MDKK1616TR47MM | RoHS | 0.47 | $\pm 20\%$ | 0.095 | 0.080 | 3,300 | 4,100 | 1,500 | 1,780 | 1 |
| MDKK1616T1R0MM | RoHS | 1.0 | $\pm 20\%$ | 0.140 | 0.120 | 2,200 | 2,750 | 1,200 | 1,490 | 1 |
| MDKK1616T1R5MM | RoHS | 1.5 | $\pm 20\%$ | 0.185 | 0.160 | 1,750 | 2,200 | 1,100 | 1,330 | 1 |
| MDKK1616T2R2MM | RoHS | 2.2 | $\pm 20\%$ | 0.250 | 0.215 | 1,500 | 1,800 | 950 | 1,110 | 1 |
| MDKK1616T3R3MM | RoHS | 3.3 | $\pm 20\%$ | 0.515 | 0.450 | 1,150 | 1,450 | 650 | 730 | 1 |
| MDKK1616T4R7MM | RoHS | 4.7 | $\pm 20\%$ | 0.640 | 0.550 | 950 | 1,200 | 550 | 630 | 1 |
| MDKK1616T6R8MM | RoHS | 6.8 | $\pm 20\%$ | 0.820 | 0.710 | 630 | 880 | 520 | 600 | 1 |
| MDKK1616T100MM | RoHS | 10 | $\pm 20\%$ | 1.120 | 0.970 | 550 | 800 | 450 | 500 | 1 |
| MDKK1616T150MM | RoHS | 15 | $\pm 20\%$ | 1.800 | 1.600 | 460 | 640 | 400 | 440 | 1 |

● MDJE2020 type 【Thickness: 0.95mm max.】

| Parts number | EHS | Nominal inductance [μ H] | Inductance tolerance | DC Resistance[Ω] | | Rated current ※) [mA] | | | | Measuring frequency[MHz] |
|----------------|------|----------------------------------|----------------------|---------------------------|-------|--------------------------|-------|--------------------------------|-------|-----------------------------|
| | | | | | | Saturation current: Idc1 | | Temperature rise current: Idc2 | | |
| | | | | | | Max. | Typ. | Max. | Typ. | |
| MDJE2020T1R0MM | RoHS | 1.0 | $\pm 20\%$ | 0.121 | 0.106 | 3,100 | 3,800 | 1,550 | 1,800 | 1 |
| MDJE2020T2R2MM | RoHS | 2.2 | $\pm 20\%$ | 0.266 | 0.230 | 1,550 | 1,900 | 1,050 | 1,200 | 1 |
| MDJE2020T3R3MM | RoHS | 3.3 | $\pm 20\%$ | 0.340 | 0.290 | 1,350 | 1,600 | 950 | 1,100 | 1 |
| MDJE2020T4R7MM | RoHS | 4.7 | $\pm 20\%$ | 0.475 | 0.410 | 1,200 | 1,550 | 850 | 950 | 1 |
| MDJE2020T6R8MM | RoHS | 6.8 | $\pm 20\%$ | 0.630 | 0.550 | 800 | 1,100 | 750 | 850 | 1 |
| MDJE2020T100MM | RoHS | 10 | $\pm 20\%$ | 1.040 | 0.910 | 700 | 900 | 550 | 600 | 1 |

● MDKK2020 type 【Thickness: 1.0mm max.】

| Parts number | EHS | Nominal inductance [μ H] | Inductance tolerance | DC Resistance[Ω] | | Rated current ※) [mA] | | | | Measuring frequency[MHz] |
|----------------|------|----------------------------------|----------------------|---------------------------|-------|--------------------------|-------|--------------------------------|-------|-----------------------------|
| | | | | | | Saturation current: Idc1 | | Temperature rise current: Idc2 | | |
| | | | | | | Max. | Typ. | Max. | Typ. | |
| MDKK2020TR47MM | RoHS | 0.47 | $\pm 20\%$ | 0.046 | 0.040 | 3,500 | 4,150 | 2,200 | 2,500 | 1 |
| MDKK2020TR68MM | RoHS | 0.68 | $\pm 20\%$ | 0.060 | 0.052 | 3,200 | 3,650 | 2,000 | 2,100 | 1 |
| MDKK2020T1R0MM | RoHS | 1.0 | $\pm 20\%$ | 0.085 | 0.074 | 2,900 | 3,400 | 1,700 | 1,900 | 1 |
| MDKK2020T1R5MM | RoHS | 1.5 | $\pm 20\%$ | 0.133 | 0.115 | 1,900 | 2,250 | 1,350 | 1,500 | 1 |
| MDKK2020T2R2MM | RoHS | 2.2 | $\pm 20\%$ | 0.165 | 0.139 | 1,650 | 1,950 | 1,200 | 1,350 | 1 |
| MDKK2020T3R3MM | RoHS | 3.3 | $\pm 20\%$ | 0.275 | 0.240 | 1,300 | 1,550 | 940 | 1,050 | 1 |
| MDKK2020T4R7MM | RoHS | 4.7 | $\pm 20\%$ | 0.435 | 0.375 | 1,050 | 1,250 | 750 | 850 | 1 |
| MDKK2020T100MM | RoHS | 10 | $\pm 20\%$ | 0.690 | 0.600 | 750 | 900 | 630 | 680 | 1 |
| MDKK2020T150MM | RoHS | 15 | $\pm 20\%$ | 1.180 | 1.020 | 550 | 750 | 480 | 550 | 1 |

● MDMK2020 type 【Thickness: 1.2mm max.】

| Parts number | EHS | Nominal inductance [μ H] | Inductance tolerance | DC Resistance[Ω] | | Rated current ※) [mA] | | | | Measuring frequency[MHz] |
|----------------|------|----------------------------------|----------------------|---------------------------|-------|--------------------------|-------|--------------------------------|-------|-----------------------------|
| | | | | | | Saturation current: Idc1 | | Temperature rise current: Idc2 | | |
| | | | | | | Max. | Typ. | Max. | Typ. | |
| MDMK2020TR47MM | RoHS | 0.47 | $\pm 20\%$ | 0.046 | 0.040 | 4,200 | 4,800 | 2,300 | 2,450 | 1 |
| MDMK2020TR68MM | RoHS | 0.68 | $\pm 20\%$ | 0.058 | 0.050 | 3,500 | 4,100 | 2,000 | 2,200 | 1 |
| MDMK2020T1R0MM | RoHS | 1.0 | $\pm 20\%$ | 0.064 | 0.056 | 2,550 | 2,900 | 1,900 | 2,050 | 1 |
| MDMK2020T1R5MM | RoHS | 1.5 | $\pm 20\%$ | 0.086 | 0.075 | 2,000 | 2,300 | 1,650 | 1,750 | 1 |
| MDMK2020T2R2MM | RoHS | 2.2 | $\pm 20\%$ | 0.109 | 0.095 | 1,750 | 2,000 | 1,450 | 1,550 | 1 |
| MDMK2020T3R3MM | RoHS | 3.3 | $\pm 20\%$ | 0.178 | 0.155 | 1,350 | 1,550 | 1,150 | 1,200 | 1 |
| MDMK2020T4R7MM | RoHS | 4.7 | $\pm 20\%$ | 0.242 | 0.210 | 1,150 | 1,300 | 950 | 1,050 | 1 |

● MDKK3030 type 【Thickness: 1.0mm max.】

| Parts number | EHS | Nominal inductance [μ H] | Inductance tolerance | DC Resistance[Ω] | | Rated current ※) [mA] | | | | Measuring frequency[MHz] |
|----------------|------|----------------------------------|----------------------|---------------------------|-------|--------------------------|-------|--------------------------------|-------|-----------------------------|
| | | | | | | Saturation current: Idc1 | | Temperature rise current: Idc2 | | |
| | | | | | | Max. | Typ. | Max. | Typ. | |
| MDKK3030TR47MM | RoHS | 0.47 | $\pm 20\%$ | 0.039 | 0.033 | 5,400 | 6,500 | 3,900 | 4,500 | 1 |
| MDKK3030T1R0MM | RoHS | 1.0 | $\pm 20\%$ | 0.086 | 0.074 | 4,400 | 5,200 | 2,400 | 2,800 | 1 |
| MDKK3030T1R5MM | RoHS | 1.5 | $\pm 20\%$ | 0.100 | 0.087 | 3,000 | 3,500 | 2,100 | 2,400 | 1 |
| MDKK3030T2R2MM | RoHS | 2.2 | $\pm 20\%$ | 0.144 | 0.125 | 2,500 | 3,000 | 1,900 | 2,200 | 1 |
| MDKK3030T3R3MM | RoHS | 3.3 | $\pm 20\%$ | 0.248 | 0.215 | 2,000 | 2,400 | 1,350 | 1,500 | 1 |
| MDKK3030T4R7MM | RoHS | 4.7 | $\pm 20\%$ | 0.345 | 0.300 | 1,700 | 2,000 | 1,150 | 1,300 | 1 |
| MDKK3030T6R8MM | RoHS | 6.8 | $\pm 20\%$ | 0.437 | 0.380 | 1,400 | 1,700 | 1,000 | 1,150 | 1 |
| MDKK3030T100MM | RoHS | 10 | $\pm 20\%$ | 0.575 | 0.500 | 1,100 | 1,300 | 850 | 1,000 | 1 |

● MDMK3030 type 【Thickness: 1.2mm max.】

| Parts number | EHS | Nominal inductance [μ H] | Inductance tolerance | DC Resistance[Ω] | | Rated current ※) [mA] | | | | Measuring frequency[MHz] |
|----------------|------|----------------------------------|----------------------|---------------------------|-------|--------------------------|-------|--------------------------------|-------|-----------------------------|
| | | | | | | Saturation current: Idc1 | | Temperature rise current: Idc2 | | |
| | | | | | | Max. | Typ. | Max. | Typ. | |
| MDMK3030TR30MM | RoHS | 0.30 | $\pm 20\%$ | 0.020 | 0.017 | 7,600 | 9,200 | 5,500 | 6,400 | 1 |
| MDMK3030TR33MM | RoHS | 0.33 | $\pm 20\%$ | 0.020 | 0.017 | 6,400 | 8,700 | 5,500 | 6,400 | 1 |
| MDMK3030TR47MM | RoHS | 0.47 | $\pm 20\%$ | 0.027 | 0.023 | 6,300 | 7,500 | 4,700 | 5,500 | 1 |
| MDMK3030T1R0MM | RoHS | 1.0 | $\pm 20\%$ | 0.050 | 0.043 | 4,300 | 5,100 | 3,300 | 3,900 | 1 |
| MDMK3030T1R5MM | RoHS | 1.5 | $\pm 20\%$ | 0.074 | 0.064 | 3,400 | 4,100 | 2,500 | 3,000 | 1 |
| MDMK3030T2R2MM | RoHS | 2.2 | $\pm 20\%$ | 0.112 | 0.097 | 2,800 | 3,600 | 2,100 | 2,400 | 1 |
| MDMK3030T3R3MM | RoHS | 3.3 | $\pm 20\%$ | 0.167 | 0.145 | 2,100 | 2,700 | 1,650 | 1,900 | 1 |
| MDMK3030T4R7MM | RoHS | 4.7 | $\pm 20\%$ | 0.263 | 0.228 | 1,800 | 2,300 | 1,350 | 1,550 | 1 |

● MDJE4040 type [Thickness: 0.95mm max.]

| Parts number | EHS | Nominal inductance [μ H] | Inductance tolerance | DC Resistance [Ω] | | Rated current ※) [mA] | | | | Measuring frequency [MHz] |
|----------------|------|----------------------------------|----------------------|----------------------------|-------|--------------------------|-------|--------------------------------|-------|------------------------------|
| | | | | | | Saturation current: Idc1 | | Temperature rise current: Idc2 | | |
| | | | | | | Max. | Typ. | Max. | Typ. | |
| MDJE4040TR47MM | RoHS | 0.47 | $\pm 20\%$ | 0.040 | 0.035 | 6,000 | 7,900 | 4,000 | 4,500 | 1 |
| MDJE4040T1R0MM | RoHS | 1.0 | $\pm 20\%$ | 0.069 | 0.060 | 4,700 | 5,700 | 3,000 | 3,500 | 1 |
| MDJE4040T1R5MM | RoHS | 1.5 | $\pm 20\%$ | 0.084 | 0.073 | 3,000 | 4,000 | 2,700 | 3,100 | 1 |
| MDJE4040T2R2MM | RoHS | 2.2 | $\pm 20\%$ | 0.115 | 0.100 | 2,400 | 3,100 | 2,400 | 2,700 | 1 |
| MDJE4040T3R3MM | RoHS | 3.3 | $\pm 20\%$ | 0.200 | 0.175 | 2,000 | 2,600 | 1,800 | 2,000 | 1 |
| MDJE4040T4R7MM | RoHS | 4.7 | $\pm 20\%$ | 0.250 | 0.220 | 1,900 | 2,300 | 1,600 | 1,900 | 1 |
| MDJE4040T6R8MM | RoHS | 6.8 | $\pm 20\%$ | 0.370 | 0.320 | 1,500 | 1,800 | 1,300 | 1,500 | 1 |
| MDJE4040T100MM | RoHS | 10 | $\pm 20\%$ | 0.510 | 0.440 | 1,400 | 1,700 | 1,100 | 1,300 | 1 |

● MDMK4040F type [Thickness: 1.2mm max.]

| Parts number | EHS | Nominal inductance [μ H] | Inductance tolerance | DC Resistance [Ω] | | Rated current ※) [mA] | | | | Measuring frequency [kHz] |
|----------------|------|----------------------------------|----------------------|----------------------------|-------|--------------------------|--------|--------------------------------|-------|------------------------------|
| | | | | | | Saturation current: Idc1 | | Temperature rise current: Idc2 | | |
| | | | | | | Max. | Typ. | Max. | Typ. | |
| MDMK4040TR47MF | RoHS | 0.47 | $\pm 20\%$ | 0.029 | 0.025 | 7,500 | 10,000 | 4,600 | 5,400 | 100 |
| MDMK4040T1R0MF | RoHS | 1.0 | $\pm 20\%$ | 0.047 | 0.041 | 5,200 | 7,500 | 3,500 | 4,200 | 100 |
| MDMK4040T1R2MF | RoHS | 1.2 | $\pm 20\%$ | 0.047 | 0.041 | 4,200 | 6,200 | 3,500 | 4,200 | 100 |
| MDMK4040T1R5MF | RoHS | 1.5 | $\pm 20\%$ | 0.065 | 0.056 | 3,700 | 5,400 | 3,300 | 3,600 | 100 |
| MDMK4040T2R2MF | RoHS | 2.2 | $\pm 20\%$ | 0.092 | 0.080 | 3,200 | 4,500 | 2,500 | 2,900 | 100 |

● MDMK4040 type [Thickness: 1.2mm max.]

| Parts number | EHS | Nominal inductance [μ H] | Inductance tolerance | DC Resistance [Ω] | | Rated current ※) [mA] | | | | Measuring frequency [MHz] |
|----------------|------|----------------------------------|----------------------|----------------------------|-------|--------------------------|-------|--------------------------------|-------|------------------------------|
| | | | | | | Saturation current: Idc1 | | Temperature rise current: Idc2 | | |
| | | | | | | Max. | Typ. | Max. | Typ. | |
| MDMK4040TR68MM | RoHS | 0.68 | $\pm 20\%$ | 0.029 | 0.025 | 6,700 | 7,800 | 5,000 | 5,700 | 1 |
| MDMK4040T1R0MM | RoHS | 1.0 | $\pm 20\%$ | 0.036 | 0.031 | 5,000 | 6,200 | 4,500 | 5,100 | 1 |
| MDMK4040T1R5MM | RoHS | 1.5 | $\pm 20\%$ | 0.065 | 0.056 | 4,500 | 5,600 | 3,200 | 3,600 | 1 |
| MDMK4040T2R2MM | RoHS | 2.2 | $\pm 20\%$ | 0.079 | 0.069 | 3,800 | 4,500 | 2,800 | 3,200 | 1 |
| MDMK4040T3R3MM | RoHS | 3.3 | $\pm 20\%$ | 0.130 | 0.113 | 3,200 | 4,000 | 2,200 | 2,500 | 1 |
| MDMK4040T4R7MM | RoHS | 4.7 | $\pm 20\%$ | 0.160 | 0.140 | 2,500 | 3,000 | 1,900 | 2,200 | 1 |
| MDMK4040T6R8MM | RoHS | 6.8 | $\pm 20\%$ | 0.230 | 0.200 | 1,900 | 2,200 | 1,600 | 1,800 | 1 |
| MDMK4040T100MM | RoHS | 10 | $\pm 20\%$ | 0.330 | 0.280 | 1,700 | 2,000 | 1,400 | 1,600 | 1 |

● MDWK4040 type [Thickness: 2.0mm max.]

| Parts number | EHS | Nominal inductance [μ H] | Inductance tolerance | DC Resistance [Ω] | | Rated current ※) [mA] | | | | Measuring frequency [MHz] |
|----------------|------|----------------------------------|----------------------|----------------------------|-------|--------------------------|--------|--------------------------------|-------|------------------------------|
| | | | | | | Saturation current: Idc1 | | Temperature rise current: Idc2 | | |
| | | | | | | Max. | Typ. | Max. | Typ. | |
| MDWK4040TR33NM | RoHS | 0.33 | $\pm 30\%$ | 0.013 | 0.011 | 16,000 | 21,000 | 7,800 | 8,800 | 1 |
| MDWK4040TR47NM | RoHS | 0.47 | $\pm 30\%$ | 0.013 | 0.011 | 10,000 | 15,000 | 7,800 | 8,800 | 1 |
| MDWK4040TR56NM | RoHS | 0.56 | $\pm 30\%$ | 0.016 | 0.014 | 9,000 | 13,000 | 6,500 | 7,500 | 1 |
| MDWK4040TR68MM | RoHS | 0.68 | $\pm 20\%$ | 0.016 | 0.014 | 8,000 | 12,000 | 7,300 | 8,300 | 1 |
| MDWK4040T1R0MM | RoHS | 1.0 | $\pm 20\%$ | 0.027 | 0.023 | 7,000 | 9,400 | 5,100 | 5,800 | 1 |
| MDWK4040T1R5MM | RoHS | 1.5 | $\pm 20\%$ | 0.041 | 0.035 | 7,000 | 9,400 | 4,100 | 4,700 | 1 |
| MDWK4040T2R2MM | RoHS | 2.2 | $\pm 20\%$ | 0.054 | 0.047 | 5,400 | 7,500 | 3,500 | 4,000 | 1 |
| MDWK4040T3R3MM | RoHS | 3.3 | $\pm 20\%$ | 0.075 | 0.066 | 3,700 | 5,200 | 3,000 | 3,300 | 1 |
| MDWK4040T4R7MM | RoHS | 4.7 | $\pm 20\%$ | 0.107 | 0.093 | 3,500 | 5,000 | 2,500 | 2,800 | 1 |
| MDWK4040T6R8MM | RoHS | 6.8 | $\pm 20\%$ | 0.158 | 0.138 | 2,900 | 4,000 | 2,000 | 2,300 | 1 |
| MDWK4040T100MM | RoHS | 10 | $\pm 20\%$ | 0.194 | 0.169 | 2,200 | 3,100 | 1,600 | 1,900 | 1 |
| MDWK4040T220MM | RoHS | 22 | $\pm 20\%$ | 0.460 | 0.400 | 1,500 | 2,100 | 1,200 | 1,400 | 1 |
| MDWK4040T330MM | RoHS | 33 | $\pm 20\%$ | 0.720 | 0.625 | 1,200 | 1,700 | 800 | 1,000 | 1 |

● MDPK5050 type [Thickness: 1.4mm max.]

| Parts number | EHS | Nominal inductance [μ H] | Inductance tolerance | DC Resistance [Ω] | | Rated current ※) [mA] | | | | Measuring frequency [MHz] |
|----------------|------|----------------------------------|----------------------|----------------------------|-------|--------------------------|--------|--------------------------------|-------|------------------------------|
| | | | | | | Saturation current: Idc1 | | Temperature rise current: Idc2 | | |
| | | | | | | Max. | Typ. | Max. | Typ. | |
| MDPK5050T1R0MM | RoHS | 1.0 | $\pm 20\%$ | 0.040 | 0.034 | 8,500 | 10,000 | 4,300 | 4,700 | 1 |
| MDPK5050T2R2MM | RoHS | 2.2 | $\pm 20\%$ | 0.055 | 0.047 | 4,100 | 5,000 | 3,600 | 4,200 | 1 |
| MDPK5050T3R3MM | RoHS | 3.3 | $\pm 20\%$ | 0.086 | 0.073 | 3,800 | 4,500 | 2,900 | 3,400 | 1 |
| MDPK5050T4R7MM | RoHS | 4.7 | $\pm 20\%$ | 0.102 | 0.088 | 3,500 | 4,200 | 2,500 | 3,000 | 1 |
| MDPK5050T6R8MM | RoHS | 6.8 | $\pm 20\%$ | 0.138 | 0.12 | 2,700 | 3,200 | 2,200 | 2,500 | 1 |
| MDPK5050T100MM | RoHS | 10 | $\pm 20\%$ | 0.225 | 0.19 | 2,200 | 2,600 | 1,700 | 2,000 | 1 |

※) The saturation current value (Idc1) is the DC current value having inductance decrease down to 30%. (at 20°C)

※) The temperature rise current value (Idc2) is the DC current value having temperature increase up to 40°C. (at 20°C)

※) The rated current is the DC current value that satisfies both of current value saturation current value and temperature rise current value.

METAL CORE SMD POWER INDUCTORS (MCOIL™ MD SERIES)

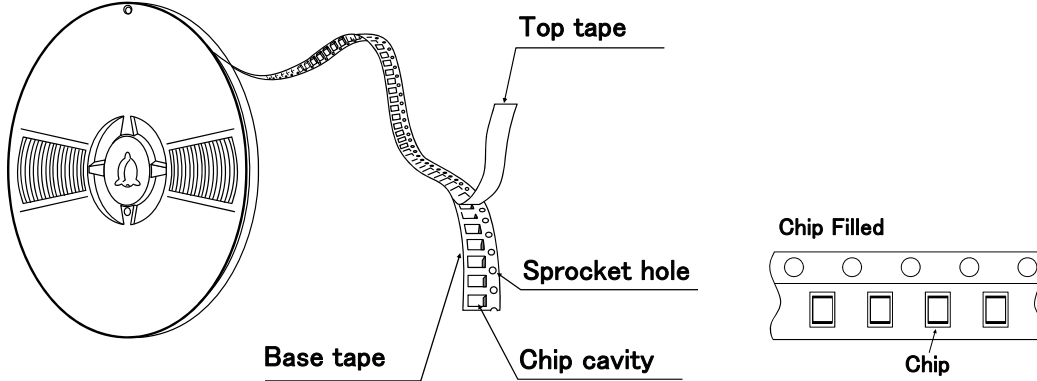
PACKAGING

① Minimum Quantity

| Type | Standard Quantity [pcs] |
|----------|-------------------------|
| | Tape & Reel |
| MDKK1616 | 2500 |
| MDJE2020 | 2500 |
| MDKK2020 | |
| MDMK2020 | |
| MDKK3030 | 2000 |
| MDMK3030 | |
| MDJE4040 | 1000 |
| MDMK4040 | |
| MDWK4040 | 700 |
| MDPK5050 | 1000 |

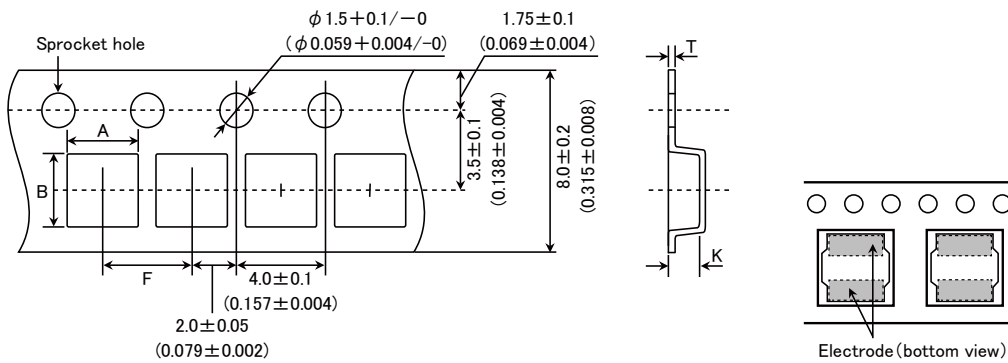
② Tape Material

● Embossed Tape



③ Taping dimensions

● Embossed tape 8mm wide (0.315 inches wide)

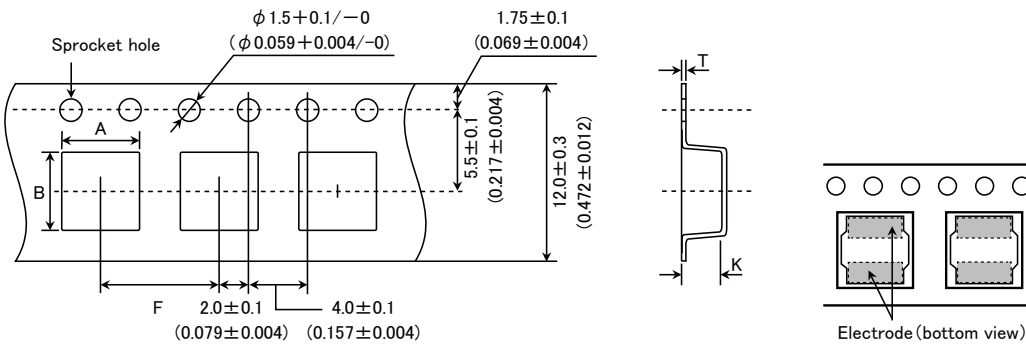


| Type | Chip cavity | | Insertion pitch | Tape thickness | |
|----------|---|---|--|--|--|
| | A | B | | T | K |
| MDKK1616 | 1.79 ± 0.1 (0.071 ± 0.004) | 1.79 ± 0.1 (0.071 ± 0.004) | 4.0 ± 0.1 (0.157 ± 0.004) | 0.25 ± 0.05 (0.010 ± 0.002) | 1.1 ± 0.1 (0.043 ± 0.004) |
| MDJE2020 | 2.2 ± 0.1 (0.102 ± 0.004) | 2.2 ± 0.1 (0.102 ± 0.004) | 4.0 ± 0.1 (0.157 ± 0.004) | 0.25 ± 0.05 (0.009 ± 0.002) | 1.3 ± 0.1 (0.051 ± 0.004) |
| MDKK2020 | | | | | |
| MDMK2020 | | | | | |
| MDKK3030 | 3.2 ± 0.1 (0.126 ± 0.004) | 3.2 ± 0.1 (0.126 ± 0.004) | 4.0 ± 0.1 (0.157 ± 0.004) | 0.3 ± 0.05 (0.012 ± 0.002) | 1.4 ± 0.1 (0.055 ± 0.004) |
| MDMK3030 | | | | | |

Unit: mm (inch)

▶ This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (<http://www.ty-top.com/>).

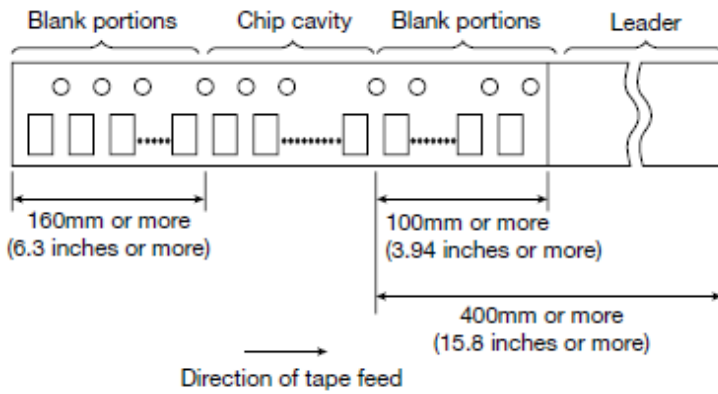
● Embossed tape 12mm wide (0.47 inches wide)



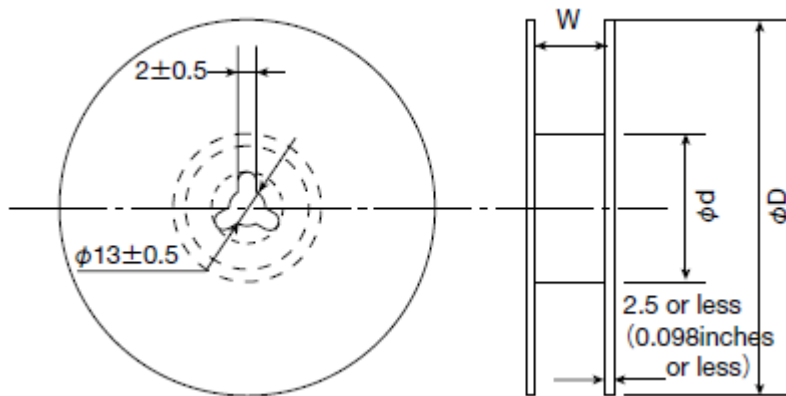
| Type | Chip cavity | | Insertion pitch F | Tape thickness | |
|----------|---|---|--|--|--|
| | A | B | | T | K |
| MDJE4040 | 4.3 ± 0.1 (0.169 ± 0.004) | 4.3 ± 0.1 (0.169 ± 0.004) | 8.0 ± 0.1 (0.315 ± 0.004) | 0.3 ± 0.1 (0.012 ± 0.004) | 1.6 ± 0.1 (0.063 ± 0.004) |
| MDMK4040 | | | | | |
| MDWK4040 | | | | | |
| MDPK5050 | 5.25 ± 0.1 (0.207 ± 0.004) | 5.25 ± 0.1 (0.207 ± 0.004) | 8.0 ± 0.1 (0.315 ± 0.004) | 0.3 ± 0.1 (0.012 ± 0.004) | 1.6 ± 0.1 (0.063 ± 0.004) |

Unit : mm (inch)

④ Leader and Blank portion



⑤ Reel size



| Type | Reel size (Reference values) | | |
|----------|--|-------------------------------------|---|
| | ϕD | ϕd | W |
| MDKK1616 | 180 ± 0.5 (7.087 ± 0.019) | 60 ± 1.0 (2.36 ± 0.04) | 10.0 ± 1.5 (0.394 ± 0.059) |
| MDJE2020 | | | |
| MDKK2020 | | | |
| MDMK2020 | | | |
| MDKK3030 | 180 ± 3.0 (7.087 ± 0.118) | 60 ± 2.0 (2.36 ± 0.08) | 14.0 ± 1.5 (0.551 ± 0.059) |
| MDMK3030 | | | |
| MDJE4040 | | | |
| MDMK4040 | | | |
| MDWK4040 | | | |
| MDPK5050 | | | |

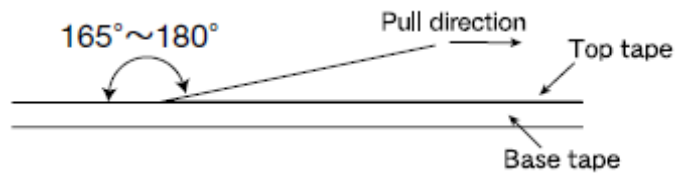
Unit : mm (inch)

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⑥ Top Tape Strength

Top tape strength

| Type | Peel-off strength |
|----------|-------------------|
| MDKK1616 | 0.1N~1.0N |
| MDJE2020 | |
| MDKK2020 | |
| MDMK2020 | |
| MDKK3030 | 0.1N~1.3N |
| MDMK3030 | |
| MDJE4040 | |
| MDMK4040 | |
| MDWK4040 | |
| MDPK5050 | |



METAL CORE SMD POWER INDUCTORS (MCOIL™ MD SERIES)

RELIABILITY DATA

| 1. Operating Temperature Range | | |
|---|--|---------------------------------|
| Specified Value | MD series | -40~+125°C |
| Test Methods and Remarks | Including self-generated heat | |
| 2. Storage Temperature Range | | |
| Specified Value | MD series | -40~+85°C |
| Test Methods and Remarks | -5 to 40°C for the product with taping. | |
| 3. Rated current | | |
| Specified Value | MD series | Within the specified tolerance |
| 4. Inductance | | |
| Specified Value | MD series | Within the specified tolerance |
| Test Methods and Remarks | Measuring equipment : LCR Meter (HP 4285A or equivalent) Measuring condition : Please see item list. | |
| 5. DC Resistance | | |
| Specified Value | MD series | Within the specified tolerance |
| Test Methods and Remarks | Measuring equipment : DC ohmmeter (HIOKI 3227 or equivalent) | |
| 6. Self resonance frequency | | |
| Specified Value | MD series | — |
| 7. Temperature characteristic | | |
| Specified Value | MD series | Inductance change : Within ±10% |
| Test Methods and Remarks | Measurement of inductance shall be taken at temperature range within -40°C~+125°C. With reference to inductance value at +20°C., change rate shall be calculated. | |
| 8. Resistance to flexure of substrate | | |
| Specified Value | MD series | No damage |
| Test Methods and Remarks | The test samples shall be soldered to the test board by the reflow. As illustrated below, apply force in the direction of the arrow indicating until deflection of the test board reaches to 2 mm. Test board size : 100×40×1.0 mm Test board material : Glass epoxy-resin Solder cream thickness : 0.10 mm | |
| | | |
| 9. Insulation resistance : between wires | | |
| Specified Value | MD series | — |
| 10. Insulation resistance : between wire and core | | |
| Specified Value | MD series | — |
| 11. Withstanding voltage : between wire and core | | |
| Specified Value | MD series | — |

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| 12. Adhesion of terminal electrode | | |
|------------------------------------|---|-----------------------------|
| Specified Value | MD series | Shall not come off PC board |
| Test Methods and Remarks | The test samples shall be soldered to the test board by the reflow. Applied force : 10N to X and Y directions. Duration : 5s. Solder cream thickness : 0.10mm. | |

| 13. Resistance to vibration | | | | | | | | | | | | | | | | |
|-----------------------------|--|--|-----------------|---------|--|-----------------|--|--|-----------------|--------------------------------|--|------|---|---------------------------------------|---|---|
| Specified Value | MD series | Inductance change : Within $\pm 10\%$ No significant abnormality in appearance. | | | | | | | | | | | | | | |
| Test Methods and Remarks | The test samples shall be soldered to the test board by the reflow. Then it shall be submitted to below test conditions. <table border="1" style="margin-left: 20px;"> <tr> <td>Frequency Range</td> <td colspan="2">10~55Hz</td> </tr> <tr> <td>Total Amplitude</td> <td colspan="2">1.5mm (May not exceed acceleration 196m/s²)</td> </tr> <tr> <td>Sweeping Method</td> <td colspan="2">10Hz to 55Hz to 10Hz for 1min.</td> </tr> <tr> <td rowspan="3">Time</td> <td>X</td> <td rowspan="3">For 2 hours on each X, Y, and Z axis.</td> </tr> <tr> <td>Y</td> </tr> <tr> <td>Z</td> </tr> </table> Recovery : At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48hrs. | | Frequency Range | 10~55Hz | | Total Amplitude | 1.5mm (May not exceed acceleration 196m/s ²) | | Sweeping Method | 10Hz to 55Hz to 10Hz for 1min. | | Time | X | For 2 hours on each X, Y, and Z axis. | Y | Z |
| Frequency Range | 10~55Hz | | | | | | | | | | | | | | | |
| Total Amplitude | 1.5mm (May not exceed acceleration 196m/s ²) | | | | | | | | | | | | | | | |
| Sweeping Method | 10Hz to 55Hz to 10Hz for 1min. | | | | | | | | | | | | | | | |
| Time | X | For 2 hours on each X, Y, and Z axis. | | | | | | | | | | | | | | |
| | Y | | | | | | | | | | | | | | | |
| | Z | | | | | | | | | | | | | | | |

| 14. Solderability | | | | | | |
|--------------------------|--|---|--------------------|--------------------------|------|------------------|
| Specified Value | MD series | At least 90% of surface of terminal electrode is covered by new solder. | | | | |
| Test Methods and Remarks | The test samples shall be dipped in flux, and then immersed in molten solder as shown in below table. Flux : Methanol solution containing rosin 25%. <table border="1" style="margin-left: 20px;"> <tr> <td>Solder Temperature</td> <td>245\pm5$^{\circ}$C</td> </tr> <tr> <td>Time</td> <td>5\pm1.0 sec.</td> </tr> </table> ※Immersion depth : All sides of mounting terminal shall be immersed. | | Solder Temperature | 245 \pm 5 $^{\circ}$ C | Time | 5 \pm 1.0 sec. |
| Solder Temperature | 245 \pm 5 $^{\circ}$ C | | | | | |
| Time | 5 \pm 1.0 sec. | | | | | |

| 15. Resistance to soldering heat | | |
|----------------------------------|--|--|
| Specified Value | MD series | Inductance change : Within $\pm 10\%$ No significant abnormality in appearance. |
| Test Methods and Remarks | The test sample shall be exposed to reflow oven at 230 \pm 5 $^{\circ}$ C for 40 seconds, with peak temperature at 260 \pm 5 $^{\circ}$ C for 5 seconds, 2 times. Test board material : Glass epoxy-resin Test board thickness : 1.0mm | |

| 16. Thermal shock | | | | | | | | | | | | | | | | | | | | |
|--------------------------|---|--|-----------------------|--|--|------|-----------------------------|----------------|---|-------------|------------|---|------------------|----------|---|-------------|------------|---|------------------|----------|
| Specified Value | MD series | Inductance change : Within $\pm 10\%$ No significant abnormality in appearance. | | | | | | | | | | | | | | | | | | |
| Test Methods and Remarks | The test samples shall be soldered to the test board by the reflow. The test samples shall be placed at specified temperature for specified time by step 1 to step 4 as shown in below table in sequence. The temperature cycle shall be repeated 100 cycles. <table border="1" style="margin-left: 20px;"> <thead> <tr> <th colspan="3">Conditions of 1 cycle</th> </tr> <tr> <th>Step</th> <th>Temperature ($^{\circ}$C)</th> <th>Duration (min)</th> </tr> </thead> <tbody> <tr> <td>1</td> <td>-40\pm3</td> <td>30\pm3</td> </tr> <tr> <td>2</td> <td>Room temperature</td> <td>Within 3</td> </tr> <tr> <td>3</td> <td>+85\pm2</td> <td>30\pm3</td> </tr> <tr> <td>4</td> <td>Room temperature</td> <td>Within 3</td> </tr> </tbody> </table> | | Conditions of 1 cycle | | | Step | Temperature ($^{\circ}$ C) | Duration (min) | 1 | -40 \pm 3 | 30 \pm 3 | 2 | Room temperature | Within 3 | 3 | +85 \pm 2 | 30 \pm 3 | 4 | Room temperature | Within 3 |
| Conditions of 1 cycle | | | | | | | | | | | | | | | | | | | | |
| Step | Temperature ($^{\circ}$ C) | Duration (min) | | | | | | | | | | | | | | | | | | |
| 1 | -40 \pm 3 | 30 \pm 3 | | | | | | | | | | | | | | | | | | |
| 2 | Room temperature | Within 3 | | | | | | | | | | | | | | | | | | |
| 3 | +85 \pm 2 | 30 \pm 3 | | | | | | | | | | | | | | | | | | |
| 4 | Room temperature | Within 3 | | | | | | | | | | | | | | | | | | |

| 17. Damp heat | | | | | | | | |
|--------------------------|---|--|-------------|-------------------------|----------|----------|------|----------------|
| Specified Value | MD series | Inductance change : Within $\pm 10\%$ No significant abnormality in appearance. | | | | | | |
| Test Methods and Remarks | The test samples shall be soldered to the test board by the reflow. The test samples shall be placed in thermostatic oven set at specified temperature and humidity as shown in below table. <table border="1" style="margin-left: 20px;"> <tr> <td>Temperature</td> <td>60\pm2$^{\circ}$C</td> </tr> <tr> <td>Humidity</td> <td>90~95%RH</td> </tr> <tr> <td>Time</td> <td>500+24/-0 hour</td> </tr> </table> | | Temperature | 60 \pm 2 $^{\circ}$ C | Humidity | 90~95%RH | Time | 500+24/-0 hour |
| Temperature | 60 \pm 2 $^{\circ}$ C | | | | | | | |
| Humidity | 90~95%RH | | | | | | | |
| Time | 500+24/-0 hour | | | | | | | |

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| 18. Loading under damp heat | | |
|---|--|--|
| Specified Value | MD series | Inductance change : Within $\pm 10\%$ No significant abnormality in appearance. |
| Test Methods and Remarks | The test samples shall be soldered to the test board by the reflow. The test samples shall be placed in thermostatic oven set at specified temperature and humidity and applied the rated current continuously as shown in below table. | |
| | Temperature | $60 \pm 2^\circ\text{C}$ |
| | Humidity | 90~95%RH |
| | Applied current | Rated current |
| | Time | 500+24/-0 hour |
| 19. Low temperature life test | | |
| Specified Value | MD series | Inductance change : Within $\pm 10\%$ No significant abnormality in appearance. |
| Test Methods and Remarks | The test samples shall be soldered to the test board by the reflow. After that, the test samples shall be placed at test conditions as shown in below table. | |
| | Temperature | $-40 \pm 2^\circ\text{C}$ |
| | Time | 500+24/-0 hour |
| 20. High temperature life test | | |
| Specified Value | MD series | — |
| 21. Loading at high temperature life test | | |
| Specified Value | MD series | Inductance change : Within $\pm 10\%$ No significant abnormality in appearance. |
| Test Methods and Remarks | The test samples shall be soldered to the test board by the reflow. The test samples shall be placed in thermostatic oven set at specified temperature and applied the rated current continuously as shown in below table. | |
| | Temperature | $85 \pm 2^\circ\text{C}$ |
| | Applied current | Rated current |
| | Time | 500+24/-0 hour |
| | | |
| 22. Standard condition | | |
| Specified Value | MD series | Standard test condition : Unless otherwise specified, temperature is $20 \pm 15^\circ\text{C}$ and $65 \pm 20\%$ of relative humidity. When there is any question concerning measurement result: In order to provide correlation data, the test shall be condition of $20 \pm 2^\circ\text{C}$ of temperature, $65 \pm 5\%$ relative humidity. Inductance is in accordance with our measured value. |

METAL CORE SMD POWER INDUCTORS (MCOIL™ MD SERIES)

PRECAUTIONS

| 1. Circuit Design | |
|---|---|
| Precautions | <ul style="list-style-type: none"> ◆ Operating environment <ol style="list-style-type: none"> 1. The products described in this specification are intended for use in general electronic equipment,(office supply equipment, telecommunications systems, measuring equipment, and household equipment). They are not intended for use in mission-critical equipment or systems requiring special quality and high reliability (traffic systems, safety equipment, aerospace systems, nuclear control systems and medical equipment including life-support systems,) where product failure might result in loss of life, injury or damage. For such uses, contact TAIYO YUDEN Sales Department in advance. |
| 2. PCB Design | |
| Precautions | <ul style="list-style-type: none"> ◆ Land pattern design <ol style="list-style-type: none"> 1. Please refer to a recommended land pattern. |
| Technical considerations | <ul style="list-style-type: none"> ◆ Land pattern design <ul style="list-style-type: none"> Surface Mounting <ul style="list-style-type: none"> • Mounting and soldering conditions should be checked beforehand. • Applicable soldering process to this products is reflow soldering only. |
| 3. Considerations for automatic placement | |
| Precautions | <ul style="list-style-type: none"> ◆ Adjustment of mounting machine <ol style="list-style-type: none"> 1. Excessive impact load should not be imposed on the products when mounting onto the PC boards. 2. Mounting and soldering conditions should be checked beforehand. |
| Technical considerations | <ul style="list-style-type: none"> ◆ Adjustment of mounting machine <ol style="list-style-type: none"> 1. When installing products, care should be taken not to apply distortion stress as it may deform the products. |
| 4. Soldering | |
| Precautions | <ul style="list-style-type: none"> ◆ Reflow soldering <ol style="list-style-type: none"> 1. Please contact any of our offices for a reflow soldering, and refer to the recommended condition specified. 2. The product shall be used reflow soldering only. 3. Please do not add any stress to a product until it returns in normal temperature after reflow soldering. ◆ Lead free soldering <ol style="list-style-type: none"> 1. When using products with lead free soldering, we request to use them after confirming adhesion, temperature of resistance to soldering heat, soldering etc sufficiently. ◆ Recommended conditions for using a soldering iron (NR10050 Type) <ul style="list-style-type: none"> • Put the soldering iron on the land-pattern. • Soldering iron's temperature - Below 350°C • Duration - 3 seconds or less • The soldering iron should not directly touch the inductor. |
| Technical considerations | <ul style="list-style-type: none"> ◆ Reflow soldering <ol style="list-style-type: none"> 1. If products are used beyond the range of the recommended conditions, heat stresses may deform the products, and consequently degrade the reliability of the products. <ul style="list-style-type: none"> • NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type, NR10050 Type, NS101/125 Type <p style="margin-left: 20px;">Recommended reflow condition (Pb free solder)</p> |
| 5. Cleaning | |
| Precautions | <ul style="list-style-type: none"> ◆ Cleaning conditions <ol style="list-style-type: none"> 1. Washing by supersonic waves shall be avoided. |
| Technical considerations | <ul style="list-style-type: none"> ◆ Cleaning conditions <ol style="list-style-type: none"> 1. If washed by supersonic waves, the products might be broken. |

▶ This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (<http://www.ty-top.com/>).

| 6. Handling | |
|--------------------------|---|
| Precautions | <ul style="list-style-type: none"> ◆ Handling <ol style="list-style-type: none"> 1. Keep the product away from all magnets and magnetic objects. ◆ Breakaway PC boards (splitting along perforations) <ol style="list-style-type: none"> 1. When splitting the PC board after mounting product, care should be taken not to give any stresses of deflection or twisting to the board. 2. Board separation should not be done manually, but by using the appropriate devices. ◆ Mechanical considerations <ol style="list-style-type: none"> 1. Please do not give the product any excessive mechanical shocks. 2. Please do not add any shock and power to a product in transportation. ◆ Pick-up pressure <ol style="list-style-type: none"> 1. Please do not push to add any pressure to a winding part. Please do not give any shock and push into a ferrite core exposure part. ◆ Packing <ol style="list-style-type: none"> 1. Please avoid accumulation of a packing box as much as possible. ◆ Board mounting <ol style="list-style-type: none"> 1. There shall be no pattern or via between terminals at the bottom of product. 2. Components which are located in peripheral of product shall not make contact with surface (top, side) of product. |
| Technical considerations | <ul style="list-style-type: none"> ◆ Handling <ol style="list-style-type: none"> 1. There is a case that a characteristic varies with magnetic influence. ◆ Breakaway PC boards (splitting along perforations) <ol style="list-style-type: none"> 1. The position of the product on PCBs shall be carefully considered to minimize the stress caused from splitting of the PCBs. ◆ Mechanical considerations <ol style="list-style-type: none"> 1. There is a case to be damaged by a mechanical shock. 2. There is a case to be broken by the handling in transportation. ◆ Pick-up pressure <ol style="list-style-type: none"> 1. Damage and a characteristic can vary with an excessive shock or stress. ◆ Packing <ol style="list-style-type: none"> 1. If packing boxes are accumulated, that could cause a deformation on packing tapes or a damage on the products. ◆ Board mounting <ol style="list-style-type: none"> 1. If there is pattern or via between terminals at the bottom of product, it may cause characteristics change. 2. If components which are located in peripheral of product make contact with surface (top, side) of product, it may cause damage or characteristics change. |

| 7. Storage conditions | |
|--------------------------|---|
| Precautions | <ul style="list-style-type: none"> ◆ Storage <ol style="list-style-type: none"> 1. To maintain the solderability of terminal electrodes and to keep the packing material in good condition, temperature and humidity in the storage area should be controlled. <ul style="list-style-type: none"> ▪ Recommended conditions <ul style="list-style-type: none"> Ambient temperature : $-5\sim 40^{\circ}\text{C}$ Humidity : Below 70% RH ▪ The ambient temperature must be kept below 30°C. Even under ideal storage conditions, solderability of products electrodes may decrease as time passes. <p style="margin-left: 20px;">For this reason, product should be used within 6 months from the time of delivery. In case of storage over 6 months, solderability shall be checked before actual usage.</p> |
| Technical considerations | <ul style="list-style-type: none"> ◆ Storage <ol style="list-style-type: none"> 1. Under a high temperature and humidity environment, problems such as reduced solderability caused by oxidation of terminal electrodes and deterioration of taping/packaging materials may take place. |

METAL CORE WIRE-WOUND CHIP POWER INDUCTORS(MCOIL™ MA SERIES)



REFLOW

■ PARTS NUMBER

* Operating Temp.: -40~+105°C (Including self-generated heat)

| | | | | | | | | | | | | | | |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| M | A | K | K | 2 | 0 | 1 | 6 | T | 1 | R | 0 | M | △ | △ |
| ① | ② | ③ | ④ | ⑤ | ⑥ | ⑦ | ⑧ | | | | | | | |

△=Blank space

①Series name

| Code | Series name |
|------|---|
| MA | Metal Core Wire-wound Chip Power Inductor |

②Dimensions (T)

| Code | Dimensions (T) [mm] |
|------|---------------------|
| KK | 1.0 |
| MK | 1.2 |

③Dimensions (L × W)

| Code | Dimensions (L × W) [mm] |
|------|-------------------------|
| 2016 | 2.0 × 1.6 |
| 2520 | 2.5 × 2.0 |

④Packaging

| Code | Packaging |
|------|-----------|
| T | Taping |

⑤Nominal inductance

| Code (example) | Nominal inductance [μH] |
|----------------|-------------------------|
| R47 | 0.47 |
| 1R0 | 1.0 |
| 4R7 | 4.7 |

※R=Decimal point

⑥Inductance tolerance

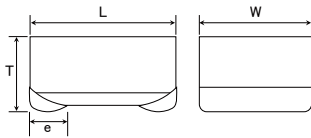
| Code | Inductance tolerance |
|------|----------------------|
| M | ±20% |

⑦Special code

| Code | Special code |
|------|--------------|
| △ | Standard |

⑧Internal code

■ STANDARD EXTERNAL DIMENSIONS / STANDARD QUANTITY

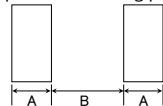


Recommended Land Patterns

Surface Mounting

• Mounting and soldering conditions should be checked beforehand.

• Applicable soldering process to these products is reflow soldering only.



| Type | A | B | C |
|------|-----|-----|-----|
| 2016 | 0.7 | 0.8 | 1.8 |
| 2520 | 0.8 | 1.2 | 2.0 |

Unit: mm

| Type | L | W | T | e | Standard quantity [pcs] Taping |
|----------|--------------------------|--------------------------|------------------------|--------------------------|-----------------------------------|
| MAKK2016 | 2.0±0.1 (0.079±0.004) | 1.6±0.1 (0.063±0.004) | 1.0 max (0.039 max) | 0.5±0.3 (0.020±0.012) | 3000 |
| MAKK2520 | 2.5±0.2 (0.098±0.008) | 2.0±0.2 (0.079±0.008) | 1.0 max (0.039 max) | 0.5±0.3 (0.020±0.012) | 3000 |
| MAMK2520 | 2.5±0.2 (0.098±0.008) | 2.0±0.2 (0.079±0.008) | 1.2 max (0.047 max) | 0.5±0.3 (0.020±0.012) | 3000 |

Unit: mm (inch)

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● MAKK2016 type 【Thickness: 1.0mm max.】

| Parts number | EHS | Nominal inductance [μ H] | Inductance tolerance | Self-resonant frequency [MHz] (min.) | DC Resistance [Ω] (max.) | Rated current ※) [mA] (max.) | | Measuring frequency [MHz] |
|---------------|------|----------------------------------|----------------------|--|--------------------------------------|------------------------------|----------------------------------|------------------------------|
| | | | | | | Saturation current Idc1 | Temperature rise current Idc2 | |
| MAKK2016TR24M | RoHS | 0.24 | $\pm 20\%$ | - | 0.037 | 4,200 | 3,000 | 2 |
| MAKK2016TR33M | RoHS | 0.33 | $\pm 20\%$ | - | 0.040 | 3,600 | 3,200 | 2 |
| MAKK2016TR47M | RoHS | 0.47 | $\pm 20\%$ | - | 0.460 | 3,200 | 2,800 | 2 |
| MAKK2016TR68M | RoHS | 0.68 | $\pm 20\%$ | - | 0.065 | 2,500 | 2,500 | 2 |
| MAKK2016T1R0M | RoHS | 1.0 | $\pm 20\%$ | - | 0.075 | 2,200 | 2,200 | 2 |
| MAKK2016T1R5M | RoHS | 1.5 | $\pm 20\%$ | - | 0.130 | 1,600 | 1,650 | 2 |
| MAKK2016T2R2M | RoHS | 2.2 | $\pm 20\%$ | - | 0.160 | 1,500 | 1,500 | 2 |
| MAKK2016T3R3M | RoHS | 3.3 | $\pm 20\%$ | - | 0.255 | 1,150 | 1,200 | 2 |
| MAKK2016T4R7M | RoHS | 4.7 | $\pm 20\%$ | - | 0.380 | 1,000 | 950 | 2 |

● MAKK2520 type 【Thickness: 1.0mm max.】

| Parts number | EHS | Nominal inductance [μ H] | Inductance tolerance | Self-resonant frequency [MHz] (min.) | DC Resistance [Ω] (max.) | Rated current ※) [mA] (max.) | | Measuring frequency [MHz] |
|---------------|------|----------------------------------|----------------------|--|--------------------------------------|------------------------------|----------------------------------|------------------------------|
| | | | | | | Saturation current Idc1 | Temperature rise current Idc2 | |
| MAKK2520TR33M | RoHS | 0.33 | $\pm 20\%$ | - | 0.038 | 4,700 | 3,500 | 2 |
| MAKK2520TR47M | RoHS | 0.47 | $\pm 20\%$ | - | 0.046 | 3,900 | 3,200 | 2 |
| MAKK2520TR68M | RoHS | 0.68 | $\pm 20\%$ | - | 0.059 | 3,700 | 2,900 | 2 |
| MAKK2520T1R0M | RoHS | 1.0 | $\pm 20\%$ | - | 0.072 | 2,700 | 2,500 | 2 |
| MAKK2520T1R5M | RoHS | 1.5 | $\pm 20\%$ | - | 0.125 | 2,300 | 1,800 | 2 |
| MAKK2520T2R2M | RoHS | 2.2 | $\pm 20\%$ | - | 0.156 | 1,900 | 1,500 | 2 |
| MAKK2520T3R3M | RoHS | 3.3 | $\pm 20\%$ | - | 0.200 | 1,550 | 1,300 | 2 |
| MAKK2520T4R7M | RoHS | 4.7 | $\pm 20\%$ | - | 0.300 | 1,300 | 1,100 | 2 |

● MAMK2520 type 【Thickness: 1.2mm max.】

| Parts number | EHS | Nominal inductance [μ H] | Inductance tolerance | Self-resonant frequency [MHz] (min.) | DC Resistance [Ω] (max.) | Rated current ※) [mA] (max.) | | Measuring frequency [MHz] |
|---------------|------|----------------------------------|----------------------|--|--------------------------------------|------------------------------|----------------------------------|------------------------------|
| | | | | | | Saturation current Idc1 | Temperature rise current Idc2 | |
| MAMK2520TR47M | RoHS | 0.47 | $\pm 20\%$ | - | 0.039 | 4,200 | 3,400 | 2 |
| MAMK2520TR68M | RoHS | 0.68 | $\pm 20\%$ | - | 0.048 | 3,200 | 3,200 | 2 |
| MAMK2520T1R0M | RoHS | 1.0 | $\pm 20\%$ | - | 0.059 | 3,100 | 2,700 | 2 |
| MAMK2520T2R2M | RoHS | 2.2 | $\pm 20\%$ | - | 0.110 | 2,000 | 1,900 | 2 |
| MAMK2520T3R3M | RoHS | 3.3 | $\pm 20\%$ | - | 0.156 | 1,800 | 1,700 | 2 |
| MAMK2520T4R7M | RoHS | 4.7 | $\pm 20\%$ | - | 0.260 | 1,500 | 1,300 | 2 |

※) The saturation current value (Idc1) is the DC current value having inductance decrease down to 30%. (at 20°C)

※) The temperature rise current value (Idc2) is the DC current value having temperature increase by 40°C. (at 20°C)

※) The rated current value is following either Idc1 or Idc2, which is the lower one.

METAL CORE WIRE-WOUND CHIP POWER INDUCTORS(MCOIL™ MA-H SERIES)



REFLOW

PARTS NUMBER

* Operating Temp.: -40~+125°C (Including self-generated heat)

* Operating Temp.: -40~+105°C (Including self-generated heat) ※1Parts Number reference

| | | | | | | | | | | | | | | |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| M | A | K | K | 2 | 0 | 1 | 6 | H | 1 | R | 0 | M | △ | △ |
| ① | ② | ③ | ④ | ⑤ | ⑥ | ⑦ | ⑧ | | | | | | | |

△=Blank space

①Series name

| Code | Series name |
|------|---|
| MA | Metal Core Wire-wound Chip Power Inductor |

②Dimensions (T)

| Code | Dimensions (T) [mm] |
|------|---------------------|
| KK | 1.0 |
| MK | 1.2 |

③Dimensions (L × W)

| Code | Dimensions (L × W) [mm] |
|------|-------------------------|
| 2016 | 2.0 × 1.6 |
| 2520 | 2.5 × 2.0 |

④Packaging

| Code | Packaging or Special specification |
|------|------------------------------------|
| H | Taping (High characteristics) |

⑤Nominal inductance

| Code (example) | Nominal inductance [μH] |
|----------------|-------------------------|
| R47 | 0.47 |
| 1R0 | 1.0 |
| 4R7 | 4.7 |

※R=Decimal point

⑥Inductance tolerance

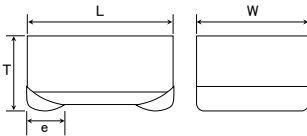
| Code | Inductance tolerance |
|------|----------------------|
| M | ±20% |

⑦Special code

| Code | Special code |
|------|--------------|
| △ | Standard |

⑧Internal code

STANDARD EXTERNAL DIMENSIONS / STANDARD QUANTITY

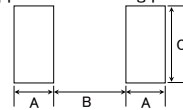


Recommended Land Patterns

Surface Mounting

•Mounting and soldering conditions should be checked beforehand.

•Applicable soldering process to these products is reflow soldering only.



| Type | A | B | C |
|------|-----|-----|-----|
| 2016 | 0.7 | 0.8 | 1.8 |
| 2520 | 0.8 | 1.2 | 2.0 |

Unit: mm

| Type | L | W | T | e | Standard quantity [pcs] Taping |
|-----------|--------------------------|--------------------------|------------------------|--------------------------|-----------------------------------|
| MAKK2016H | 2.0±0.1 (0.079±0.004) | 1.6±0.1 (0.063±0.004) | 1.0 max (0.039 max) | 0.5±0.3 (0.020±0.012) | 3000 |
| MAKK2520H | 2.5±0.2 (0.098±0.008) | 2.0±0.2 (0.079±0.008) | 1.0 max (0.039 max) | 0.5±0.3 (0.020±0.012) | 3000 |
| MAMK2520H | 2.5±0.2 (0.098±0.008) | 2.0±0.2 (0.079±0.008) | 1.2 max (0.047 max) | 0.5±0.3 (0.020±0.012) | 3000 |

Unit: mm (inch)

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● MAKK2016H type [Thickness: 1.0mm max.]

| Parts number | EHS | Nominal inductance [μ H] | Inductance tolerance | Self-resonant frequency [MHz] (min.) | DC Resistance [Ω] (max.) | Rated current ※) [mA] (max.) | | Measuring frequency [MHz] |
|---------------|------|----------------------------------|----------------------|--|--------------------------------------|------------------------------|----------------------------------|------------------------------|
| | | | | | | Saturation current Idc1 | Temperature rise current Idc2 | |
| MAKK2016HR22M | RoHS | 0.22 | $\pm 20\%$ | - | 0.026 | 5,800 | 4,000 | 2 |
| MAKK2016HR24M | RoHS | 0.24 | $\pm 20\%$ | - | 0.026 | 5,800 | 4,000 | 2 |
| MAKK2016HR33M | RoHS | 0.33 | $\pm 20\%$ | - | 0.030 | 4,700 | 3,500 | 2 |
| MAKK2016HR47M | RoHS | 0.47 | $\pm 20\%$ | - | 0.036 | 4,300 | 3,300 | 2 |
| MAKK2016HR68M | RoHS | 0.68 | $\pm 20\%$ | - | 0.050 | 3,200 | 2,700 | 2 |
| MAKK2016H1R0M | RoHS | 1.0 | $\pm 20\%$ | - | 0.070 | 2,700 | 2,300 | 2 |
| MAKK2016H1R5M | RoHS | 1.5 | $\pm 20\%$ | - | 0.105 | 2,100 | 1,800 | 2 |

● MAKK2520H type [Thickness: 1.0mm max.]

| Parts number | EHS | Nominal inductance [μ H] | Inductance tolerance | Self-resonant frequency [MHz] (min.) | DC Resistance [Ω] (max.) | Rated current ※) [mA] (max.) | | Measuring frequency [MHz] |
|------------------|------|----------------------------------|----------------------|--|--------------------------------------|------------------------------|----------------------------------|------------------------------|
| | | | | | | Saturation current Idc1 | Temperature rise current Idc2 | |
| MAKK2520HR22M | RoHS | 0.22 | $\pm 20\%$ | - | 0.021 | 7500 | 4900 | 2 |
| MAKK2520HR33M | RoHS | 0.33 | $\pm 20\%$ | - | 0.026 | 6200 | 4300 | 2 |
| MAKK2520HR47M | RoHS | 0.47 | $\pm 20\%$ | - | 0.029 | 5700 | 4000 | 2 |
| MAKK2520HR68M | RoHS | 0.68 | $\pm 20\%$ | - | 0.043 | 4300 | 3400 | 2 |
| MAKK2520H1R0M | RoHS | 1.0 | $\pm 20\%$ | - | 0.053 | 3800 | 3000 | 2 |
| MAKK2520H1R5M | RoHS | 1.5 | $\pm 20\%$ | - | 0.078 | 3000 | 2400 | 2 |
| MAKK2520H2R2M | RoHS | 2.2 | $\pm 20\%$ | - | 0.120 | 2500 | 1800 | 2 |
| MAKK2520H100M ※1 | RoHS | 10 | $\pm 20\%$ | - | 0.650 | 1100 | 750 | 2 |

● MAMK2520H type [Thickness: 1.2mm max.]

| Parts number | EHS | Nominal inductance [μ H] | Inductance tolerance | Self-resonant frequency [MHz] (min.) | DC Resistance [Ω] (max.) | Rated current ※) [mA] (max.) | | Measuring frequency [MHz] |
|---------------|------|----------------------------------|----------------------|--|--------------------------------------|------------------------------|----------------------------------|------------------------------|
| | | | | | | Saturation current Idc1 | Temperature rise current Idc2 | |
| MAMK2520HR22M | RoHS | 0.22 | $\pm 20\%$ | - | 0.021 | 7500 | 5000 | 2 |
| MAMK2520HR33M | RoHS | 0.33 | $\pm 20\%$ | - | 0.023 | 6600 | 4400 | 2 |
| MAMK2520HR47M | RoHS | 0.47 | $\pm 20\%$ | - | 0.026 | 5800 | 4100 | 2 |
| MAMK2520HR68M | RoHS | 0.68 | $\pm 20\%$ | - | 0.036 | 5100 | 3500 | 2 |
| MAMK2520H1R0M | RoHS | 1.0 | $\pm 20\%$ | - | 0.045 | 4300 | 3100 | 2 |
| MAMK2520H1R5M | RoHS | 1.5 | $\pm 20\%$ | - | 0.065 | 3300 | 2600 | 2 |
| MAMK2520H2R2M | RoHS | 2.2 | $\pm 20\%$ | - | 0.090 | 2800 | 2200 | 2 |

※) The saturation current value (Idc1) is the DC current value having inductance decrease down to 30%. (at 20°C)

※) The temperature rise current value (Idc2) is the DC current value having temperature increase by 40°C. (at 20°C)

※) The rated current value is following either Idc1 or Idc2, which is the lower one.

METAL CORE WIRE-WOUND CHIP POWER INDUCTORS (MCOIL™ MA SERIES / MCOIL™ MA-H SERIES)

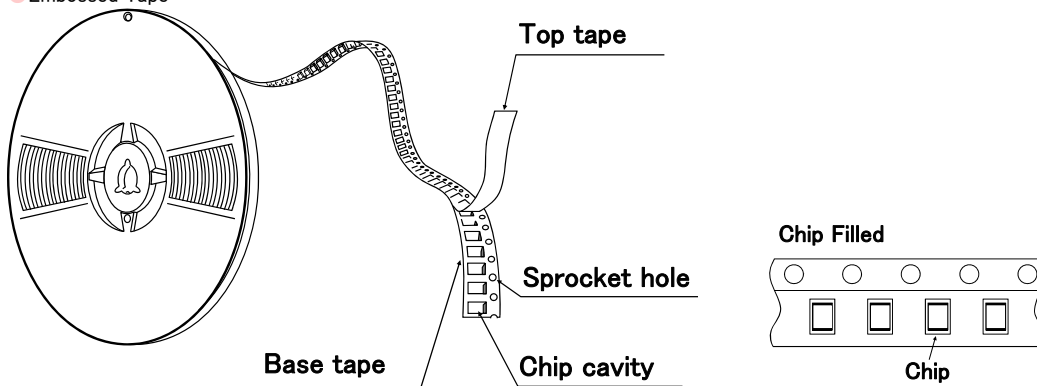
PACKAGING

① Minimum Quantity

| Type | Standard Quantity [pcs] |
|----------|-------------------------|
| | Tape & Reel |
| MAKK2016 | 3000 |
| MAKK2520 | 3000 |
| MAMK2520 | 3000 |

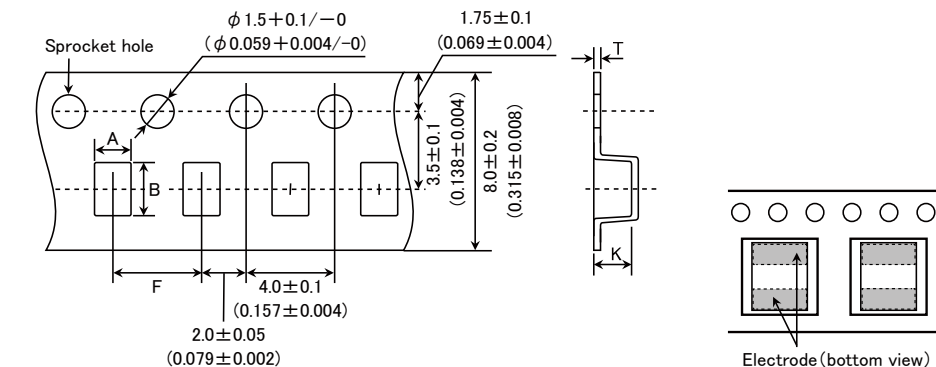
② Tape Material

● Embossed Tape



③ Taping dimensions

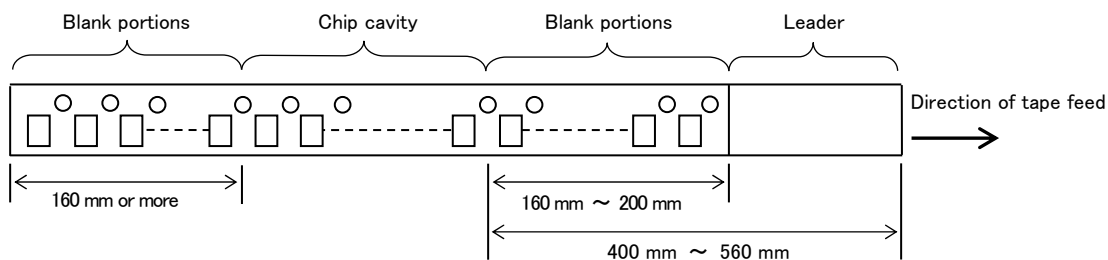
● Embossed tape 8mm wide (0.315 inches wide)



| Type | Chip cavity | | Insertion pitch | Tape thickness | |
|----------|--|--|--|--|-------------------------|
| | A | B | F | T | K |
| MAKK2016 | 1.9 ± 0.1 (0.075 ± 0.004) | 2.3 ± 0.1 (0.091 ± 0.004) | 4.0 ± 0.1 (0.157 ± 0.004) | 0.25 ± 0.05 (0.009 ± 0.002) | 1.2 max (0.047 max) |
| MAKK2520 | 2.3 ± 0.1 (0.091 ± 0.004) | 2.8 ± 0.1 (0.110 ± 0.004) | 4.0 ± 0.1 (0.157 ± 0.004) | 0.3 ± 0.05 (0.012 ± 0.002) | 1.25 max (0.049 max) |
| MAMK2520 | 2.3 ± 0.1 (0.091 ± 0.004) | 2.8 ± 0.1 (0.110 ± 0.004) | 4.0 ± 0.1 (0.157 ± 0.004) | 0.3 ± 0.05 (0.012 ± 0.002) | 1.4 max (0.055 max) |

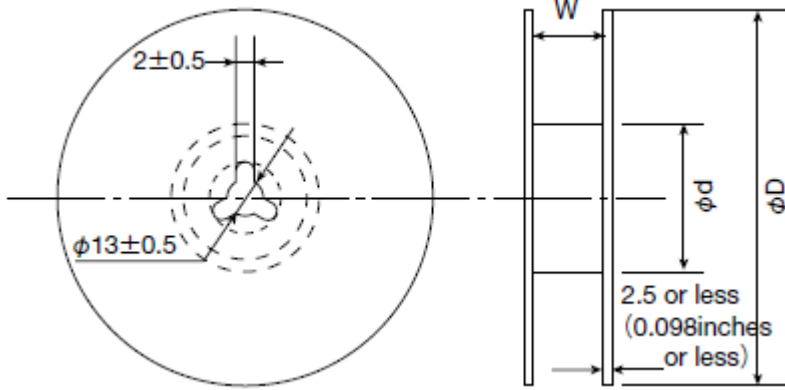
Unit: mm (inch)

④ Leader and Blank portion



▶ This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (<http://www.ty-top.com/>).

⑤ Reel size

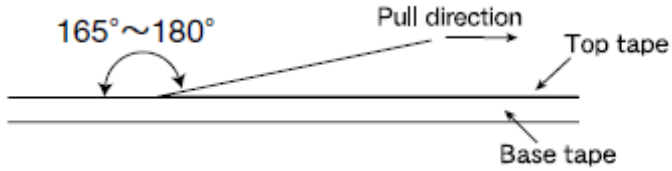


| Type | Reel size (Reference values) | | |
|----------|------------------------------|----------------|---------------|
| | ϕD | ϕd | W |
| MAKK2016 | 180+0/-3 | 60+1/-0 | 10.0±1.5 |
| MAKK2520 | (7.087+0/-0.118) | (2.36+0.039/0) | (0.394±0.059) |
| MAMK2520 | | | |

Unit: mm (inch)

⑥ Top Tape Strength

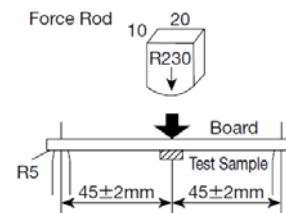
The top The top tape requires a peel-off force of 0.1 to 1.2N in the direction of the arrow as illustrated below.



METAL CORE WIRE-WOUND CHIP POWER INDUCTORS (MCOIL™ MA SERIES / MCOIL™ MA-H SERIES)

RELIABILITY DATA

| 1. Operating Temperature Range | | |
|---------------------------------------|---|---------------------------------|
| Specified Value | MA series | -40~+105°C |
| | MA-H series | -40~+125°C |
| Test Methods and Remarks | Including self-generated heat | |
| 2. Storage Temperature Range | | |
| Specified Value | MA series | -40~+85°C |
| | MA-H series | |
| Test Methods and Remarks | 0 to 40°C for the product with taping. | |
| 3. Rated current | | |
| Specified Value | MA series | Within the specified tolerance |
| | MA-H series | |
| 4. Inductance | | |
| Specified Value | MA series | Within the specified tolerance |
| | MA-H series | |
| Test Methods and Remarks | Measuring equipment : LCR Meter (HP 4285A or equivalent) Measuring frequency : 2MHz, 1V | |
| 5. DC Resistance | | |
| Specified Value | MA series | Within the specified tolerance |
| | MA-H series | |
| Test Methods and Remarks | Measuring equipment : DC ohmmeter (HIOKI 3227 or equivalent) | |
| 6. Self resonance frequency | | |
| Specified Value | MA series | - |
| | MA-H series | |
| 7. Temperature characteristic | | |
| Specified Value | MA series | Inductance change : Within ±15% |
| | MA-H series | |
| Test Methods and Remarks | Measurement of inductance shall be taken at temperature range within -40°C~+85°C. With reference to inductance value at +20°C., change rate shall be calculated. | |
| 8. Resistance to flexure of substrate | | |
| Specified Value | MA series | No damage |
| | MA-H series | |
| Test Methods and Remarks | <p>The test samples shall be soldered to the test board by the reflow. As illustrated below, apply force in the direction of the arrow indicating until deflection of the test board reaches to 2 mm.</p> <p>Test board size : 100 × 40 × 1.0 mm Test board material : Glass epoxy-resin Solder cream thickness : 0.12 mm</p> | |



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| 9. Insulation resistance : between wires | | | | | | | | | | | | | |
|---|---|--|--------------------|---------------|-----------------|--|-----------------|--------------------------------|------|---|---------------------------------------|---|---|
| Specified Value | MA series | — | | | | | | | | | | | |
| | MA-H series | | | | | | | | | | | | |
| 10. Insulation resistance : between wire and core | | | | | | | | | | | | | |
| Specified Value | MA series | DC25V 100kΩ min | | | | | | | | | | | |
| | MA-H series | | | | | | | | | | | | |
| 11. Withstanding voltage : between wire and core | | | | | | | | | | | | | |
| Specified Value | MA series | — | | | | | | | | | | | |
| | MA-H series | | | | | | | | | | | | |
| 12. Adhesion of terminal electrode | | | | | | | | | | | | | |
| Specified Value | MA series | No abnormality. | | | | | | | | | | | |
| | MA-H series | | | | | | | | | | | | |
| Test Methods and Remarks | <p>The test samples shall be soldered to the test board by the reflow.</p> <p>Applied force : 10N to X and Y directions.</p> <p>Duration : 5s.</p> <p>Solder cream thickness : 0.12mm.</p> | | | | | | | | | | | | |
| 13. Resistance to vibration | | | | | | | | | | | | | |
| Specified Value | MA series | Inductance change : Within $\pm 10\%$ No significant abnormality in appearance. | | | | | | | | | | | |
| | MA-H series | | | | | | | | | | | | |
| Test Methods and Remarks | <p>The test samples shall be soldered to the test board by the reflow.</p> <p>Then it shall be submitted to below test conditions.</p> <table border="1"> <tr> <td>Frequency Range</td> <td>10~55Hz</td> </tr> <tr> <td>Total Amplitude</td> <td>1.5mm (May not exceed acceleration 196m/s²)</td> </tr> <tr> <td>Sweeping Method</td> <td>10Hz to 55Hz to 10Hz for 1min.</td> </tr> <tr> <td rowspan="3">Time</td> <td>X</td> <td rowspan="3">For 2 hours on each X, Y, and Z axis.</td> </tr> <tr> <td>Y</td> </tr> <tr> <td>Z</td> </tr> </table> <p>Recovery : At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48hrs.</p> | | Frequency Range | 10~55Hz | Total Amplitude | 1.5mm (May not exceed acceleration 196m/s ²) | Sweeping Method | 10Hz to 55Hz to 10Hz for 1min. | Time | X | For 2 hours on each X, Y, and Z axis. | Y | Z |
| | Frequency Range | 10~55Hz | | | | | | | | | | | |
| Total Amplitude | 1.5mm (May not exceed acceleration 196m/s ²) | | | | | | | | | | | | |
| Sweeping Method | 10Hz to 55Hz to 10Hz for 1min. | | | | | | | | | | | | |
| Time | X | For 2 hours on each X, Y, and Z axis. | | | | | | | | | | | |
| | Y | | | | | | | | | | | | |
| | Z | | | | | | | | | | | | |
| | | | | | | | | | | | | | |
| 14. Solderability | | | | | | | | | | | | | |
| Specified Value | MA series | At least 90% of surface of terminal electrode is covered by new solder. | | | | | | | | | | | |
| | MA-H series | | | | | | | | | | | | |
| Test Methods and Remarks | <p>The test samples shall be dipped in flux, and then immersed in molten solder as shown in below table.</p> <p>Flux : Methanol solution containing rosin 25%.</p> <table border="1"> <tr> <td>Solder Temperature</td> <td>245\pm5°C</td> </tr> <tr> <td>Time</td> <td>5\pm0.5 sec.</td> </tr> </table> <p>※Immersion depth : All sides of mounting terminal shall be immersed.</p> | | Solder Temperature | 245 \pm 5°C | Time | 5 \pm 0.5 sec. | | | | | | | |
| Solder Temperature | 245 \pm 5°C | | | | | | | | | | | | |
| Time | 5 \pm 0.5 sec. | | | | | | | | | | | | |
| 15. Resistance to soldering heat | | | | | | | | | | | | | |
| Specified Value | MA series | Inductance change : Within $\pm 10\%$ No significant abnormality in appearance. | | | | | | | | | | | |
| | MA-H series | | | | | | | | | | | | |
| Test Methods and Remarks | <p>The test sample shall be exposed to reflow oven at 230°C for 40 seconds, with peak temperature at 260+0/−5°C for 5 seconds, 3 times.</p> <p>Test board material : Glass epoxy-resin</p> <p>Test board thickness : 1.0mm</p> <p>Recovery : At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48hrs.</p> | | | | | | | | | | | | |

| 16. Thermal shock | | | |
|---|---|--|----------------|
| Specified Value | MA series | Inductance change : Within $\pm 10\%$ No significant abnormality in appearance. | |
| | MA-H series | | |
| Test Methods and Remarks | The test samples shall be soldered to the test board by the reflow. The test samples shall be placed at specified temperature for specified time by step 1 to step 4 as shown in below table in sequence. The temperature cycle shall be repeated 100 cycles. | | |
| | Conditions of 1 cycle | | |
| | Step | Temperature ($^{\circ}\text{C}$) | Duration (min) |
| | 1 | -40 ± 3 | 30 ± 3 |
| | 2 | Room temperature | Within 3 |
| | 3 | $+85 \pm 2$ | 30 ± 3 |
| 4 | Room temperature | Within 3 | |
| Recovery : At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48hrs. | | | |

| 17. Damp heat | | |
|---|--|--|
| Specified Value | MA series | Inductance change : Within $\pm 10\%$ No significant abnormality in appearance. |
| | MA-H series | |
| Test Methods and Remarks | The test samples shall be soldered to the test board by the reflow. | |
| | The test samples shall be placed in thermostatic oven set at specified temperature and humidity as shown in below table. | |
| | Temperature | $60 \pm 2^{\circ}\text{C}$ |
| | Humidity | $90 \sim 95\% \text{RH}$ |
| | Time | $500 + 24 / - 0$ hour |
| Recovery : At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48hrs. | | |

| 18. Loading under damp heat | | |
|---|---|--|
| Specified Value | MA series | Inductance change : Within $\pm 10\%$ No significant abnormality in appearance. |
| | MA-H series | |
| Test Methods and Remarks | The test samples shall be soldered to the test board by the reflow. | |
| | The test samples shall be placed in thermostatic oven set at specified temperature and humidity and applied the rated current continuously as shown in below table. | |
| | Temperature | $60 \pm 2^{\circ}\text{C}$ |
| | Humidity | $90 \sim 95\% \text{RH}$ |
| | Applied current | Rated current |
| | Time | $500 + 24 / - 0$ hour |
| Recovery : At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48hrs. | | |

| 19. Low temperature life test | | |
|-------------------------------|--|--|
| Specified Value | MA series | Inductance change : Within $\pm 10\%$ No significant abnormality in appearance. |
| | MA-H series | |
| Test Methods and Remarks | The test samples shall be soldered to the test board by the reflow. After that, the test samples shall be placed at test conditions as shown in below table. | |
| | Temperature | $-40 \pm 2^{\circ}\text{C}$ |
| | Time | $500 + 24 / - 0$ hour |
| | Recovery : At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48hrs. | |

| 20. High temperature life test | | |
|--------------------------------|--|--|
| Specified Value | MA series | Inductance change : Within $\pm 10\%$ No significant abnormality in appearance. |
| | MA-H series | |
| Test Methods and Remarks | The test samples shall be soldered to the test board by the reflow. After that, the test samples shall be placed at test conditions as shown in below table. | |
| | Temperature | $85 \pm 2^{\circ}\text{C}$ |
| | Time | $500 + 24 / - 0$ hour |
| | Recovery : At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48hrs. | |

| 21. Loading at high temperature life test | | |
|---|-------------|---|
| Specified Value | MA series | - |
| | MA-H series | |

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22. Standard condition

| | | |
|-----------------|-------------|--|
| Specified Value | MA series | Standard test condition : Unless otherwise specified, temperature is $20 \pm 15^{\circ}\text{C}$ and $65 \pm 20\%$ of relative humidity. When there is any question concerning measurement result: In order to provide correlation data, the test shall be condition of $20 \pm 2^{\circ}\text{C}$ of temperature, $65 \pm 5\%$ relative humidity. Inductance is in accordance with our measured value. |
| | MA-H series | |

METAL CORE WIRE-WOUND CHIP POWER INDUCTORS (MCOIL™ MA SERIES / MCOIL™ MA-H SERIES)

■ PRECAUTIONS

| 1. Circuit Design | |
|---|--|
| Precautions | <p>◆Operating environment</p> <p>1. The products described in this specification are intended for use in general electronic equipment,(office supply equipment, telecommunications systems, measuring equipment, and household equipment). They are not intended for use in mission-critical equipment or systems requiring special quality and high reliability (traffic systems, safety equipment, aerospace systems, nuclear control systems and medical equipment including life-support systems.) where product failure might result in loss of life, injury or damage. For such uses, contact TAIYO YUDEN Sales Department in advance.</p> |
| 2. PCB Design | |
| Precautions | <p>◆Land pattern design</p> <p>1. Please refer to a recommended land pattern.</p> |
| Technical considerations | <p>◆Land pattern design</p> <p>Surface Mounting</p> <ul style="list-style-type: none"> • Mounting and soldering conditions should be checked beforehand. • Applicable soldering process to this products is reflow soldering only. |
| 3. Considerations for automatic placement | |
| Precautions | <p>◆Adjustment of mounting machine</p> <p>1. Excessive impact load should not be imposed on the products when mounting onto the PC boards.</p> <p>2. Mounting and soldering conditions should be checked beforehand.</p> |
| Technical considerations | <p>◆Adjustment of mounting machine</p> <p>1. When installing products, care should be taken not to apply distortion stress as it may deform the products.</p> |
| 4. Soldering | |
| Precautions | <p>◆Reflow soldering</p> <p>1. Please contact any of our offices for a reflow soldering, and refer to the recommended condition specified.</p> <p>2. The product shall be used reflow soldering only.</p> <p>3. Please do not add any stress to a product until it returns in normal temperature after reflow soldering.</p> <p>◆Lead free soldering</p> <p>1. When using products with lead free soldering, we request to use them after confirming adhesion, temperature of resistance to soldering heat, soldering etc sufficiently.</p> |
| Technical considerations | <p>◆Reflow soldering</p> <p>1. If products are used beyond the range of the recommended conditions, heat stresses may deform the products, and consequently degrade the reliability of the products.</p> <p>Recommended reflow condition (Pb free solder)</p> <p>Temperature [°C]</p> <p>Heating Time [sec]</p> <p>150~180</p> <p>90±30sec</p> <p>40sec max</p> <p>230°C min</p> <p>5sec max</p> <p>Peak: 260+0/-5°C</p> |
| 5. Cleaning | |
| Precautions | <p>◆Cleaning conditions</p> <p>1. Washing by supersonic waves shall be avoided.</p> |
| Technical considerations | <p>◆Cleaning conditions</p> <p>1. If washed by supersonic waves, the products might be broken.</p> |

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| 6. Handling | |
|--------------------------|---|
| Precautions | <ul style="list-style-type: none"> ◆Handling <ol style="list-style-type: none"> 1. Keep the product away from all magnets and magnetic objects. ◆Breakaway PC boards (splitting along perforations) <ol style="list-style-type: none"> 1. When splitting the PC board after mounting product, care should be taken not to give any stresses of deflection or twisting to the board. 2. Board separation should not be done manually, but by using the appropriate devices. ◆Mechanical considerations <ol style="list-style-type: none"> 1. Please do not give the product any excessive mechanical shocks. 2. Please do not add any shock and power to a product in transportation. ◆Pick-up pressure <ol style="list-style-type: none"> 1. Please do not push to add any pressure to a winding part. Please do not give any shock and push into a ferrite core exposure part. ◆Packing <ol style="list-style-type: none"> 1. Please avoid accumulation of a packing box as much as possible. |
| Technical considerations | <ul style="list-style-type: none"> ◆Handling <ol style="list-style-type: none"> 1. There is a case that a characteristic varies with magnetic influence. ◆Breakaway PC boards (splitting along perforations) <ol style="list-style-type: none"> 1. The position of the product on PCBs shall be carefully considered to minimize the stress caused from splitting of the PCBs. ◆Mechanical considerations <ol style="list-style-type: none"> 1. There is a case to be damaged by a mechanical shock. 2. There is a case to be broken by the handling in transportation. ◆Pick-up pressure <ol style="list-style-type: none"> 1. Damage and a characteristic can vary with an excessive shock or stress. ◆Packing <ol style="list-style-type: none"> 1. If packing boxes are accumulated, that could cause a deformation on packing tapes or a damage on the products. |
| 7. Storage conditions | |
| Precautions | <ul style="list-style-type: none"> ◆Storage <ol style="list-style-type: none"> 1. To maintain the solderability of terminal electrodes and to keep the packing material in good condition, temperature and humidity in the storage area should be controlled. <ul style="list-style-type: none"> ▪ Recommended conditions <ul style="list-style-type: none"> Ambient temperature : 0~40°C Humidity : Below 70% RH ▪ The ambient temperature must be kept below 30°C. Even under ideal storage conditions, solderability of products electrodes may decrease as time passes. <ul style="list-style-type: none"> For this reason, product should be used within 6 months from the time of delivery. In case of storage over 6 months, solderability shall be checked before actual usage. |
| Technical considerations | <ul style="list-style-type: none"> ◆Storage <ol style="list-style-type: none"> 1. Under a high temperature and humidity environment, problems such as reduced solderability caused by oxidation of terminal electrodes and deterioration of taping/packaging materials may take place. |

METAL WIRE-WOUND CHIP POWER INDUCTORS(MCOIL™ MB SERIES)



REFLOW

PARTS NUMBER

* Operating Temp.: -40~+105°C (Including self-generated heat)

| | | | | | | | | | | | | | |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| M | B | K | K | 1 | 6 | 0 | 8 | T | 1 | R | 0 | M | △ |
| ① | ② | ③ | ④ | ⑤ | ⑥ | ⑦ | | | | | | | |

△=Blank space

① Series name

| Code | Series name |
|------|--------------------------------------|
| MB | Metal Wire-Wound chip power inductor |

② Dimensions (T)

| Code | Dimensions (T) [mm] |
|------|---------------------|
| KK | 1.0 |
| MK | 1.2 |

③ Dimensions (L × W)

| Code | Type (inch) | Dimensions (L × W) [mm] |
|------|-------------|-------------------------|
| 1608 | 1608 (0603) | 1.6 × 0.8 |
| 2012 | 2012 (0805) | 2.0 × 1.25 |
| 2520 | 2520 (1008) | 2.5 × 2.0 |

④ Packaging

| Code | Packaging |
|------|-----------|
| T | Taping |

⑤ Nominal inductance

| Code (example) | Nominal inductance [μH] |
|----------------|-------------------------|
| R24 | 0.24 |
| 1R0 | 1.0 |
| 4R7 | 4.7 |

※R=Decimal point

⑥ Inductance tolerance

| Code | Inductance tolerance |
|------|----------------------|
| M | ±20% |
| N | ±30% |

⑦ Internal code

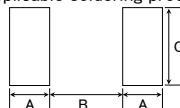
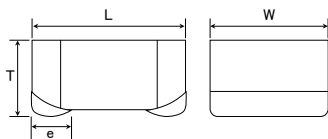
STANDARD EXTERNAL DIMENSIONS / STANDARD QUANTITY

Recommended Land Patterns

Surface Mounting

• Mounting and soldering conditions should be checked beforehand.

• Applicable soldering process to these products is reflow soldering only.



| Type | A | B | C |
|------|------|------|------|
| 1608 | 0.55 | 0.70 | 1.00 |
| 2012 | 0.60 | 1.00 | 1.45 |
| 2520 | 0.60 | 1.50 | 2.00 |

Unit : mm

| Type | L | W | T | e | Standard quantity [pcs] | |
|----------|--------------------------|---------------------------|------------------------|----------------------------|-------------------------|---------------|
| | | | | | Paper tape | Embossed tape |
| MBKK1608 | 1.6±0.2 (0.063±0.008) | 0.8±0.2 (0.031±0.008) | 1.0 max (0.040 max) | 0.45±0.15 (0.016±0.006) | — | 3000 |
| MBKK2012 | 2.0±0.2 (0.079±0.008) | 1.25±0.2 (0.049±0.008) | 1.0 max (0.040 max) | 0.5±0.2 (0.020±0.008) | — | 3000 |
| MBMK2520 | 2.5±0.2 (0.098±0.008) | 2.0±0.2 (0.079±0.008) | 1.2 max (0.047 max) | 0.5±0.2 (0.020±0.008) | — | 3000 |

Unit : mm (inch)

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● MBKK1608(0603) type 【Thickness: 1.0mm max.】

| Parts number | EHS | Nominal inductance [μ H] | Inductance tolerance | Self-resonant frequency [MHz] (min.) | DC Resistance [Ω] (max.) | Rated current ※) [mA] (max.) | | Measuring frequency [MHz] |
|---------------|------|----------------------------------|----------------------|--|--------------------------------------|------------------------------|----------------------------------|------------------------------|
| | | | | | | Saturation current Idc1 | Temperature rise current Idc2 | |
| MBKK1608TR24N | RoHS | 0.24 | $\pm 30\%$ | - | 0.049 | 1,650 | 2,300 | 1.0 |
| MBKK1608TR47N | RoHS | 0.47 | $\pm 30\%$ | - | 0.104 | 1,100 | 1,400 | 1.0 |
| MBKK1608TR68N | RoHS | 0.68 | $\pm 30\%$ | - | 0.120 | 950 | 1,200 | 1.0 |
| MBKK1608T1R0M | RoHS | 1.0 | $\pm 20\%$ | - | 0.150 | 800 | 1,150 | 1.0 |
| MBKK1608T1R5M | RoHS | 1.5 | $\pm 20\%$ | - | 0.200 | 650 | 1,000 | 1.0 |
| MBKK1608T2R2M | RoHS | 2.2 | $\pm 20\%$ | - | 0.345 | 520 | 750 | 1.0 |
| MBKK1608T3R3M | RoHS | 3.3 | $\pm 20\%$ | - | 0.512 | 450 | 600 | 1.0 |
| MBKK1608T4R7M | RoHS | 4.7 | $\pm 20\%$ | - | 0.730 | 370 | 500 | 1.0 |

● MBKK2012(0805) type 【Thickness: 1.0mm max.】

| Parts number | EHS | Nominal inductance [μ H] | Inductance tolerance | Self-resonant frequency [MHz] (min.) | DC Resistance [Ω] (max.) | Rated current ※) [mA] (max.) | | Measuring frequency [MHz] |
|---------------|------|----------------------------------|----------------------|--|--------------------------------------|------------------------------|----------------------------------|------------------------------|
| | | | | | | Saturation current Idc1 | Temperature rise current Idc2 | |
| MBKK2012TR24N | RoHS | 0.24 | $\pm 30\%$ | - | 0.041 | 3,000 | 2,400 | 1.0 |
| MBKK2012TR47N | RoHS | 0.47 | $\pm 30\%$ | - | 0.078 | 2,000 | 1,650 | 1.0 |
| MBKK2012TR68N | RoHS | 0.68 | $\pm 30\%$ | - | 0.090 | 1,800 | 1,500 | 1.0 |
| MBKK2012T1R0M | RoHS | 1.0 | $\pm 20\%$ | - | 0.106 | 1,500 | 1,450 | 1.0 |
| MBKK2012T1R5M | RoHS | 1.5 | $\pm 20\%$ | - | 0.173 | 1,200 | 1,100 | 1.0 |
| MBKK2012T2R2M | RoHS | 2.2 | $\pm 20\%$ | - | 0.290 | 900 | 850 | 1.0 |
| MBKK2012T3R3M | RoHS | 3.3 | $\pm 20\%$ | - | 0.500 | 700 | 650 | 1.0 |
| MBKK2012T4R7M | RoHS | 4.7 | $\pm 20\%$ | - | 0.615 | 600 | 600 | 1.0 |

● MBMK2520(1008) type 【Thickness: 1.2mm max.】

| Parts number | EHS | Nominal inductance [μ H] | Inductance tolerance | Self-resonant frequency [MHz] (min.) | DC Resistance [Ω] (max.) | Rated current ※) [mA] (max.) | | Measuring frequency [MHz] |
|---------------|------|----------------------------------|----------------------|--|--------------------------------------|------------------------------|----------------------------------|------------------------------|
| | | | | | | Saturation current Idc1 | Temperature rise current Idc2 | |
| MBMK2520TR24N | RoHS | 0.24 | $\pm 30\%$ | - | 0.026 | 4,750 | 3,500 | 1.0 |
| MBMK2520TR47N | RoHS | 0.47 | $\pm 30\%$ | - | 0.042 | 3,900 | 2,600 | 1.0 |
| MBMK2520TR68N | RoHS | 0.68 | $\pm 30\%$ | - | 0.058 | 3,150 | 2,150 | 1.0 |
| MBMK2520T1R0M | RoHS | 1.0 | $\pm 20\%$ | - | 0.072 | 2,350 | 1,850 | 1.0 |
| MBMK2520T1R5M | RoHS | 1.5 | $\pm 20\%$ | - | 0.106 | 2,050 | 1,500 | 1.0 |
| MBMK2520T2R2M | RoHS | 2.2 | $\pm 20\%$ | - | 0.159 | 1,800 | 1,250 | 1.0 |
| MBMK2520T3R3M | RoHS | 3.3 | $\pm 20\%$ | - | 0.260 | 1,400 | 970 | 1.0 |
| MBMK2520T4R7M | RoHS | 4.7 | $\pm 20\%$ | - | 0.380 | 1,150 | 800 | 1.0 |

※) The saturation current value (Idc1) is the DC current value having inductance decrease down to 30%. (at 20°C)

※) The temperature rise current value (Idc2) is the DC current value having temperature increase by 40°C. (at 20°C)

※) The rated current value is following either Idc1 or Idc2, which is the lower one.

METAL WIRE-WOUND CHIP POWER INDUCTORS(MCOIL™ MB-H SERIES)



REFLOW

PARTS NUMBER

* Operating Temp.: -40~+125°C (Including self-generated heat)

| | | | | | | | | | | | | | |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| M | B | K | K | 1 | 6 | 0 | 8 | H | 1 | R | 0 | M | △ |
| ① | ② | ③ | ④ | ⑤ | ⑥ | ⑦ | | | | | | | |

△=Blank space

①Series name

| Code | Series name |
|------|--------------------------------------|
| MB | Metal Wire-Wound chip power inductor |

②Dimensions (T)

| Code | Dimensions (T) [mm] |
|------|---------------------|
| KK | 1.0 |
| MK | 1.2 |

③Dimensions (L × W)

| Code | Type (inch) | Dimensions (L × W) [mm] |
|------|-------------|-------------------------|
| 1608 | 1608 (0603) | 1.6 × 0.8 |
| 2520 | 2520 (1008) | 2.5 × 2.0 |

④Packaging

| Code | Packaging |
|------|--------------------------------|
| H | Taping (Special specification) |

⑤Nominal inductance

| Code (example) | Nominal inductance [μH] |
|----------------|-------------------------|
| R24 | 0.24 |
| 1R0 | 1.0 |
| 4R7 | 4.7 |

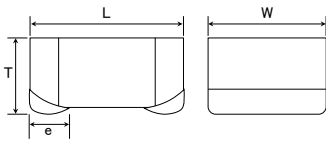
※R=Decimal point

⑥Inductance tolerance

| Code | Inductance tolerance |
|------|----------------------|
| M | ±20% |
| N | ±30% |

⑦Internal code

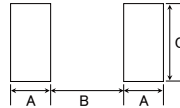
STANDARD EXTERNAL DIMENSIONS / STANDARD QUANTITY



Recommended Land Patterns

Surface Mounting

- Mounting and soldering conditions should be checked beforehand.
- Applicable soldering process to these products is reflow soldering only.



| Type | A | B | C |
|------|------|------|------|
| 1608 | 0.55 | 0.70 | 1.00 |
| 2520 | 0.60 | 1.50 | 2.00 |

Unit: mm

| Type | L | W | T | e | Standard quantity [pcs] | |
|----------|--------------------------|--------------------------|------------------------|----------------------------|-------------------------|---------------|
| | | | | | Paper tape | Embossed tape |
| MBKK1608 | 1.6±0.2 (0.063±0.008) | 0.8±0.2 (0.031±0.008) | 1.0 max (0.040 max) | 0.45±0.15 (0.016±0.006) | — | 3000 |
| MBMK2520 | 2.5±0.2 (0.098±0.008) | 2.0±0.2 (0.079±0.008) | 1.2 max (0.047 max) | 0.5±0.2 (0.020±0.008) | — | 3000 |

Unit: mm (inch)

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● MBKK1608H(0603) type 【Thickness: 1.0mm max.】

| Parts number | EHS | Nominal inductance [μ H] | Inductance tolerance | Self-resonant frequency [MHz] (min.) | DC Resistance [Ω] (max.) | Rated current ※) [mA] (max.) | | Measuring frequency [MHz] |
|---------------|------|----------------------------------|----------------------|--|--------------------------------------|------------------------------|----------------------------------|------------------------------|
| | | | | | | Saturation current Idc1 | Temperature rise current Idc2 | |
| MBKK1608HR24N | RoHS | 0.24 | $\pm 30\%$ | - | 0.049 | 1,650 | 2,300 | 1.0 |
| MBKK1608HR47N | RoHS | 0.47 | $\pm 30\%$ | - | 0.104 | 1,100 | 1,400 | 1.0 |
| MBKK1608HR68N | RoHS | 0.68 | $\pm 30\%$ | - | 0.120 | 950 | 1,200 | 1.0 |
| MBKK1608H1R0M | RoHS | 1.0 | $\pm 20\%$ | - | 0.150 | 800 | 1,150 | 1.0 |
| MBKK1608H1R5M | RoHS | 1.5 | $\pm 20\%$ | - | 0.200 | 650 | 1,000 | 1.0 |
| MBKK1608H2R2M | RoHS | 2.2 | $\pm 20\%$ | - | 0.345 | 520 | 750 | 1.0 |
| MBKK1608H3R3M | RoHS | 3.3 | $\pm 20\%$ | - | 0.512 | 450 | 600 | 1.0 |
| MBKK1608H4R7M | RoHS | 4.7 | $\pm 20\%$ | - | 0.730 | 370 | 500 | 1.0 |

● MBMK2520H(1008) type 【Thickness: 1.2mm max.】

| Parts number | EHS | Nominal inductance [μ H] | Inductance tolerance | Self-resonant frequency [MHz] (min.) | DC Resistance [Ω] (max.) | Rated current ※) [mA] (max.) | | Measuring frequency [MHz] |
|---------------|------|----------------------------------|----------------------|--|--------------------------------------|------------------------------|----------------------------------|------------------------------|
| | | | | | | Saturation current Idc1 | Temperature rise current Idc2 | |
| MBMK2520HR24N | RoHS | 0.24 | $\pm 30\%$ | - | 0.026 | 4,750 | 3,500 | 1.0 |
| MBMK2520HR47N | RoHS | 0.47 | $\pm 30\%$ | - | 0.042 | 3,900 | 2,600 | 1.0 |
| MBMK2520HR68N | RoHS | 0.68 | $\pm 30\%$ | - | 0.058 | 3,150 | 2,150 | 1.0 |
| MBMK2520H1R0M | RoHS | 1.0 | $\pm 20\%$ | - | 0.072 | 2,350 | 1,850 | 1.0 |
| MBMK2520H1R5M | RoHS | 1.5 | $\pm 20\%$ | - | 0.106 | 2,050 | 1,500 | 1.0 |
| MBMK2520H2R2M | RoHS | 2.2 | $\pm 20\%$ | - | 0.159 | 1,800 | 1,250 | 1.0 |
| MBMK2520H3R3M | RoHS | 3.3 | $\pm 20\%$ | - | 0.260 | 1,400 | 970 | 1.0 |
| MBMK2520H4R7M | RoHS | 4.7 | $\pm 20\%$ | - | 0.380 | 1,150 | 800 | 1.0 |

※) The saturation current value (Idc1) is the DC current value having inductance decrease down to 30%. (at 20°C)

※) The temperature rise current value (Idc2) is the DC current value having temperature increase by 40°C. (at 20°C)

※) The rated current value is following either Idc1 or Idc2, which is the lower one.

METAL WIRE-WOUND CHIP POWER INDUCTORS (MCOIL™ MB SERIES/MCOIL™ MB-H SERIES)

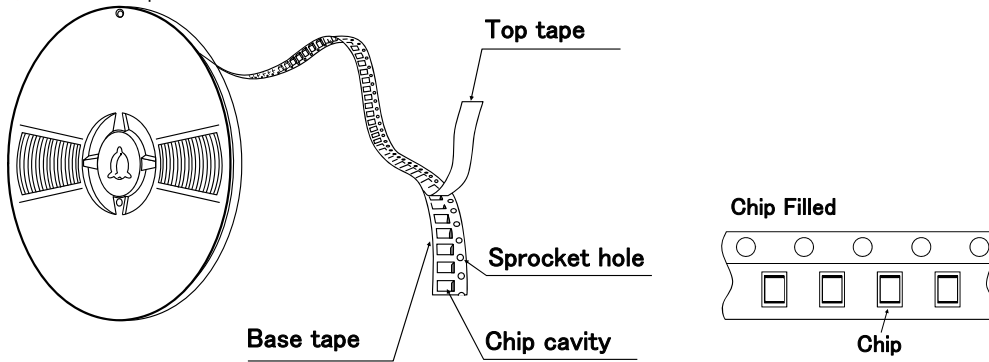
PACKAGING

① Minimum Quantity

| Type | Standard Quantity [pcs] |
|--------------------|-------------------------|
| | Tape & Reel |
| MBKK1608/MBKK1608H | 3000 |
| MBKK2012 | 3000 |
| MBMK2520/MBMK2520H | 3000 |

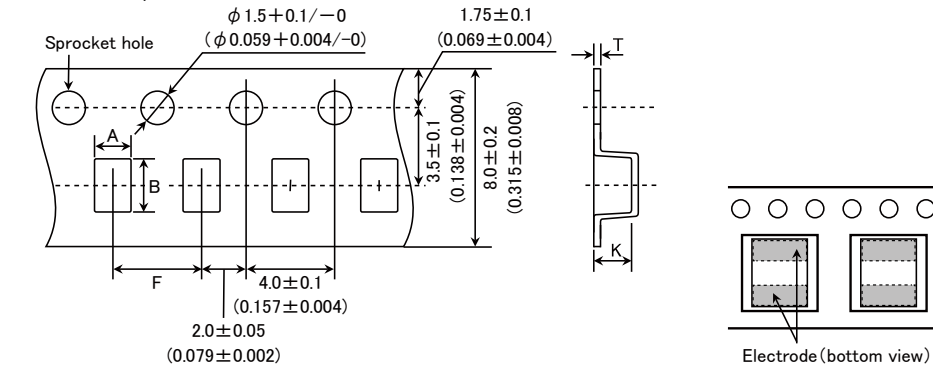
② Tape Material

● Embossed Tape



③ Taping dimensions

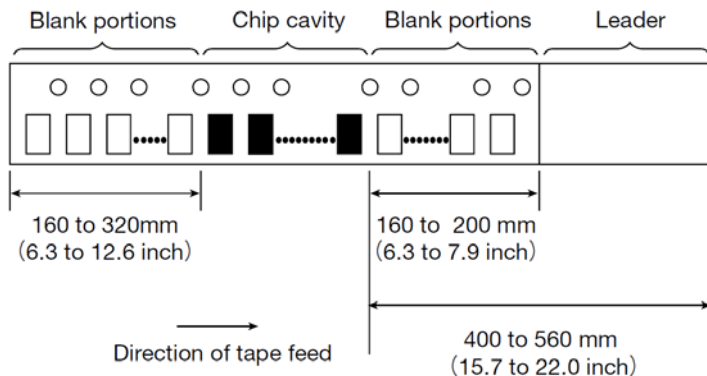
● Embossed tape 8mm wide (0.315 inches wide)



| Type | Chip cavity | | Insertion pitch | Tape thickness | |
|--------------------|-----------------|----------------|--|--|-------------------------|
| | A | B | F | T | K |
| MBKK1608/MBKK1608H | 1.1 (0.043) | 1.9 (0.075) | 4.0 ± 0.1 (0.157 ± 0.004) | 0.25 ± 0.05 (0.010 ± 0.002) | 1.2 max (0.047 max) |
| MBKK2012 | 1.45 (0.057) | 2.2 (0.087) | 4.0 ± 0.1 (0.157 ± 0.004) | 0.25 ± 0.05 (0.010 ± 0.002) | 1.2 max (0.047 max) |
| MBMK2520/MBMK2520H | 2.3 (0.091) | 2.8 (0.110) | 4.0 ± 0.1 (0.157 ± 0.004) | 0.3 ± 0.05 (0.012 ± 0.002) | 1.45 max (0.057 max) |

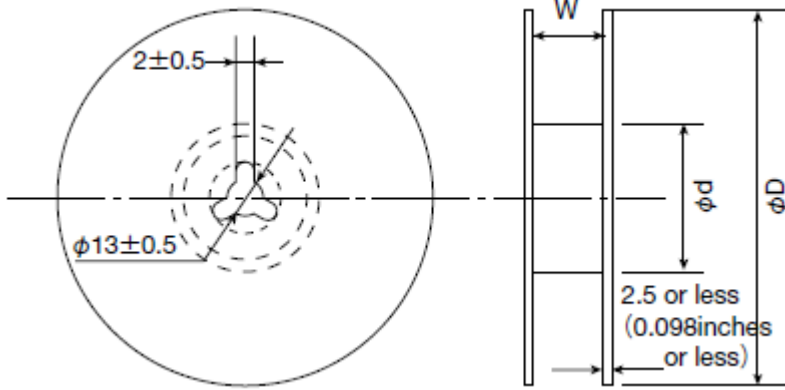
Unit : mm (inch)

④ Leader and Blank portion



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⑤ Reel size

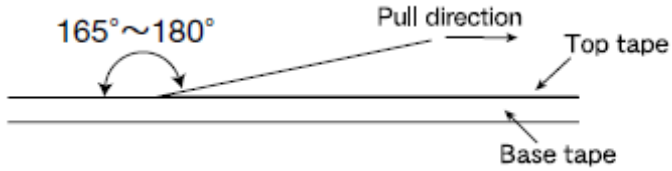


| Type | Reel size (Reference values) | | |
|----------------------|------------------------------|---------------------------|---------------------------|
| | ϕD | ϕd | W |
| MBKK1608 / MBKK1608H | 180+0/-3 (7.087+0/-0.118) | 60+1/-0 (2.36+0.039/0) | 10.0±1.5 (0.394±0.059) |
| MBKK2012 | | | |
| MBMK2520 / MBMK2520H | | | |

Unit: mm (inch)

⑥ Top Tape Strength

The top tape requires a peel-off force of 0.2 to 0.7N in the direction of the arrow as illustrated below.



METAL WIRE-WOUND CHIP POWER INDUCTORS

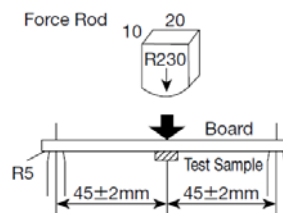
(MCOIL™ MB SERIES / MCOIL™ MB-H SERIES)

RELIABILITY DATA

| 1. Operating Temperature Range | | |
|--------------------------------|--|---------------------------------------|
| Specified Value | MB series | -40~+105°C |
| | MB-H series | -40~+125°C |
| Test Methods and Remarks | Including self-generated heat | |
| 2. Storage Temperature Range | | |
| Specified Value | MB series | -40~+85°C |
| | MB-H series | |
| Test Methods and Remarks | 0 to 40°C for the product with taping. | |
| 3. Rated current | | |
| Specified Value | MB series | Within the specified tolerance |
| | MB-H series | |
| 4. Inductance | | |
| Specified Value | MB series | Within the specified tolerance |
| | MB-H series | |
| Test Methods and Remarks | Measuring equipment : LCR Meter (HP 4285A or equivalent) Measuring frequency : 1MHz, 1V | |
| 5. DC Resistance | | |
| Specified Value | MB series | Within the specified tolerance |
| | MB-H series | |
| Test Methods and Remarks | Measuring equipment : DC ohmmeter (HIOKI 3227 or equivalent) | |
| 6. Self resonance frequency | | |
| Specified Value | MB series | - |
| | MB-H series | |
| 7. Temperature characteristic | | |
| Specified Value | MB series | Inductance change : Within $\pm 15\%$ |
| | MB-H series | |
| Test Methods and Remarks | MB series : Measurement of inductance shall be taken at temperature range within -40°C~+105°C. With reference to inductance value at +20°C., change rate shall be calculated. MB-H series : Measurement of inductance shall be taken at temperature range within -40°C~+125°C. With reference to inductance value at +20°C., change rate shall be calculated. | |

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| 8. Resistance to flexure of substrate | | |
|---------------------------------------|---|-----------|
| Specified Value | MB series | No damage |
| | MB-H series | |
| Test Methods and Remarks | <p>The test samples shall be soldered to the test board by the reflow. As illustrated below, apply force in the direction of the arrow indicating until deflection of the test board reaches to 2 mm.</p> <p>Test board size : 100 × 40 × 1.0 mm (1608:0.8mm) Test board material : Glass epoxy-resin Solder cream thickness : 0.1 mm</p> | |



| 9. Insulation resistance : between wires | | |
|--|-------------|---|
| Specified Value | MB series | — |
| | MB-H series | |

| 10. Insulation resistance : between wire and core | | |
|---|-------------|-----------------|
| Specified Value | MB series | DC25V 100kΩ min |
| | MB-H series | DC50V 100kΩ min |

| 11. Withstanding voltage : between wire and core | | |
|--|-------------|---|
| Specified Value | MB series | — |
| | MB-H series | |

| 12. Adhesion of terminal electrode | | |
|------------------------------------|---|-----------------|
| Specified Value | MB series | No abnormality. |
| | MB-H series | |
| Test Methods and Remarks | <p>The test samples shall be soldered to the test board by the reflow.</p> <p>Applied force : 10N (1608:5N) to X and Y directions. Duration : 5s. Solder cream thickness : 0.1mm.</p> | |

| 13. Resistance to vibration | | | | | | | | | | | | | | | | |
|-----------------------------|--|---|-----------------|---------|--|-----------------|--|--|-----------------|--------------------------------|--|------|---|---------------------------------------|---|---|
| Specified Value | MB series | Inductance change : Within ± 10% | | | | | | | | | | | | | | |
| | MB-H series | No significant abnormality in appearance. | | | | | | | | | | | | | | |
| Test Methods and Remarks | <p>The test samples shall be soldered to the test board by the reflow. Then it shall be submitted to below test conditions.</p> <table border="1"> <tr> <td>Frequency Range</td> <td colspan="2">10~55Hz</td> </tr> <tr> <td>Total Amplitude</td> <td colspan="2">1.5mm (May not exceed acceleration 196m/s²)</td> </tr> <tr> <td>Sweeping Method</td> <td colspan="2">10Hz to 55Hz to 10Hz for 1min.</td> </tr> <tr> <td rowspan="3">Time</td> <td>X</td> <td rowspan="3">For 2 hours on each X, Y, and Z axis.</td> </tr> <tr> <td>Y</td> </tr> <tr> <td>Z</td> </tr> </table> <p>Recovery : At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48hrs.</p> | | Frequency Range | 10~55Hz | | Total Amplitude | 1.5mm (May not exceed acceleration 196m/s ²) | | Sweeping Method | 10Hz to 55Hz to 10Hz for 1min. | | Time | X | For 2 hours on each X, Y, and Z axis. | Y | Z |
| Frequency Range | 10~55Hz | | | | | | | | | | | | | | | |
| Total Amplitude | 1.5mm (May not exceed acceleration 196m/s ²) | | | | | | | | | | | | | | | |
| Sweeping Method | 10Hz to 55Hz to 10Hz for 1min. | | | | | | | | | | | | | | | |
| Time | X | For 2 hours on each X, Y, and Z axis. | | | | | | | | | | | | | | |
| | Y | | | | | | | | | | | | | | | |
| | Z | | | | | | | | | | | | | | | |

| 14. Solderability | | | | | | | | |
|--------------------------|---|---|--------------------|---------|-----------------|--------|------|------------|
| Specified Value | MB series | At least 90% of surface of terminal electrode is covered by new solder. | | | | | | |
| | MB-H series | | | | | | | |
| Test Methods and Remarks | <p>The test samples shall be dipped in flux, and then immersed in molten solder as shown in below table.</p> <p>Flux : Methanol solution containing rosin 25%.</p> <table border="1"> <tr> <td>Solder Temperature</td> <td>245±5°C</td> </tr> <tr> <td>Immersing speed</td> <td>25mm/s</td> </tr> <tr> <td>Time</td> <td>5±0.5 sec.</td> </tr> </table> <p>※Immersion depth : All sides of mounting terminal shall be immersed.</p> | | Solder Temperature | 245±5°C | Immersing speed | 25mm/s | Time | 5±0.5 sec. |
| Solder Temperature | 245±5°C | | | | | | | |
| Immersing speed | 25mm/s | | | | | | | |
| Time | 5±0.5 sec. | | | | | | | |

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| 15. Resistance to soldering heat | | |
|----------------------------------|--|--|
| Specified Value | MB series | Inductance change : Within $\pm 10\%$ No significant abnormality in appearance. |
| | MB-H series | |
| Test Methods and Remarks | The test sample shall be exposed to reflow oven at 230°C for 40 seconds, with peak temperature at 260+0/-5°C for 5 seconds, 3 times. Test board material : Glass epoxy-resin Test board thickness : 1.0mm Recovery : At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48hrs. | |

| 16. Thermal shock | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
|--------------------------|---|--|--|--|------|------------------|----------------|---|-------------|------------|---|------------------|----------|---|-------------|------------|---|------------------|----------|--|-----------------------|--|--|------|------------------|----------------|---|-------------|------------|---|------------------|----------|---|--------------|------------|---|------------------|----------|
| Specified Value | MB series | Inductance change : Within $\pm 10\%$ No significant abnormality in appearance. | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| | MB-H series | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| Test Methods and Remarks | <p>MB series: The test samples shall be soldered to the test board by the reflow. The test samples shall be placed at specified temperature for specified time by step 1 to step 4 as shown in below table in sequence. The temperature cycle shall be repeated 100 cycles.</p> <table border="1"> <thead> <tr> <th colspan="3">Conditions of 1 cycle</th> </tr> <tr> <th>Step</th> <th>Temperature (°C)</th> <th>Duration (min)</th> </tr> </thead> <tbody> <tr> <td>1</td> <td>-40\pm3</td> <td>30\pm3</td> </tr> <tr> <td>2</td> <td>Room temperature</td> <td>Within 3</td> </tr> <tr> <td>3</td> <td>+85\pm2</td> <td>30\pm3</td> </tr> <tr> <td>4</td> <td>Room temperature</td> <td>Within 3</td> </tr> </tbody> </table> <p>Recovery : At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48hrs.</p> | Conditions of 1 cycle | | | Step | Temperature (°C) | Duration (min) | 1 | -40 \pm 3 | 30 \pm 3 | 2 | Room temperature | Within 3 | 3 | +85 \pm 2 | 30 \pm 3 | 4 | Room temperature | Within 3 | <p>MB-H series: The test samples shall be soldered to the test board by the reflow. The test samples shall be placed at specified temperature for specified time by step 1 to step 4 as shown in below table in sequence. The temperature cycle shall be repeated 100 cycles.</p> <table border="1"> <thead> <tr> <th colspan="3">Conditions of 1 cycle</th> </tr> <tr> <th>Step</th> <th>Temperature (°C)</th> <th>Duration (min)</th> </tr> </thead> <tbody> <tr> <td>1</td> <td>-40\pm3</td> <td>30\pm3</td> </tr> <tr> <td>2</td> <td>Room temperature</td> <td>Within 3</td> </tr> <tr> <td>3</td> <td>+125\pm2</td> <td>30\pm3</td> </tr> <tr> <td>4</td> <td>Room temperature</td> <td>Within 3</td> </tr> </tbody> </table> <p>Recovery : At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48hrs.</p> | Conditions of 1 cycle | | | Step | Temperature (°C) | Duration (min) | 1 | -40 \pm 3 | 30 \pm 3 | 2 | Room temperature | Within 3 | 3 | +125 \pm 2 | 30 \pm 3 | 4 | Room temperature | Within 3 |
| | Conditions of 1 cycle | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| Step | Temperature (°C) | Duration (min) | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| 1 | -40 \pm 3 | 30 \pm 3 | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| 2 | Room temperature | Within 3 | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| 3 | +85 \pm 2 | 30 \pm 3 | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| 4 | Room temperature | Within 3 | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| Conditions of 1 cycle | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| Step | Temperature (°C) | Duration (min) | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| 1 | -40 \pm 3 | 30 \pm 3 | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| 2 | Room temperature | Within 3 | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| 3 | +125 \pm 2 | 30 \pm 3 | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| 4 | Room temperature | Within 3 | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |

| 17. Damp heat | | | | | | | | | | | | | | |
|--------------------------|--|--|--------------|----------|----------|------|-----------------|---|-------------|--------------|----------|-------|------|-----------------|
| Specified Value | MB series | Inductance change : Within $\pm 10\%$ No significant abnormality in appearance. | | | | | | | | | | | | |
| | MB-H series | | | | | | | | | | | | | |
| Test Methods and Remarks | <p>MB series: The test samples shall be soldered to the test board by the reflow. The test samples shall be placed in thermostatic oven set at specified temperature and humidity as shown in below table.</p> <table border="1"> <tbody> <tr> <td>Temperature</td> <td>60\pm2°C</td> </tr> <tr> <td>Humidity</td> <td>90~95%RH</td> </tr> <tr> <td>Time</td> <td>1000+24/-0 hour</td> </tr> </tbody> </table> <p>Recovery : At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48hrs.</p> | Temperature | 60 \pm 2°C | Humidity | 90~95%RH | Time | 1000+24/-0 hour | <p>MB-H series: The test samples shall be soldered to the test board by the reflow. The test samples shall be placed in thermostatic oven set at specified temperature and humidity as shown in below table.</p> <table border="1"> <tbody> <tr> <td>Temperature</td> <td>85\pm2°C</td> </tr> <tr> <td>Humidity</td> <td>85%RH</td> </tr> <tr> <td>Time</td> <td>1000+24/-0 hour</td> </tr> </tbody> </table> <p>Recovery : At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48hrs.</p> | Temperature | 85 \pm 2°C | Humidity | 85%RH | Time | 1000+24/-0 hour |
| | Temperature | 60 \pm 2°C | | | | | | | | | | | | |
| Humidity | 90~95%RH | | | | | | | | | | | | | |
| Time | 1000+24/-0 hour | | | | | | | | | | | | | |
| Temperature | 85 \pm 2°C | | | | | | | | | | | | | |
| Humidity | 85%RH | | | | | | | | | | | | | |
| Time | 1000+24/-0 hour | | | | | | | | | | | | | |

| 18. Loading under damp heat | | | | | | | | | | | | | | | | | | |
|-----------------------------|--|--|--------------|----------|----------|-----------------|---------------|------|-----------------|---|-------------|--------------|----------|-------|-----------------|---------------|------|-----------------|
| Specified Value | MB series | Inductance change : Within $\pm 10\%$ No significant abnormality in appearance. | | | | | | | | | | | | | | | | |
| | MB-H series | | | | | | | | | | | | | | | | | |
| Test Methods and Remarks | <p>MB series: The test samples shall be soldered to the test board by the reflow. The test samples shall be placed in thermostatic oven set at specified temperature and humidity and applied the rated current continuously as shown in below table.</p> <table border="1"> <tbody> <tr> <td>Temperature</td> <td>60\pm2°C</td> </tr> <tr> <td>Humidity</td> <td>90~95%RH</td> </tr> <tr> <td>Applied current</td> <td>Rated current</td> </tr> <tr> <td>Time</td> <td>1000+24/-0 hour</td> </tr> </tbody> </table> <p>Recovery : At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48hrs.</p> | Temperature | 60 \pm 2°C | Humidity | 90~95%RH | Applied current | Rated current | Time | 1000+24/-0 hour | <p>MB-H series: The test samples shall be soldered to the test board by the reflow. The test samples shall be placed in thermostatic oven set at specified temperature and humidity and applied the rated current continuously as shown in below table.</p> <table border="1"> <tbody> <tr> <td>Temperature</td> <td>85\pm2°C</td> </tr> <tr> <td>Humidity</td> <td>85%RH</td> </tr> <tr> <td>Applied current</td> <td>Rated current</td> </tr> <tr> <td>Time</td> <td>1000+24/-0 hour</td> </tr> </tbody> </table> <p>Recovery : At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48hrs.</p> | Temperature | 85 \pm 2°C | Humidity | 85%RH | Applied current | Rated current | Time | 1000+24/-0 hour |
| | Temperature | 60 \pm 2°C | | | | | | | | | | | | | | | | |
| Humidity | 90~95%RH | | | | | | | | | | | | | | | | | |
| Applied current | Rated current | | | | | | | | | | | | | | | | | |
| Time | 1000+24/-0 hour | | | | | | | | | | | | | | | | | |
| Temperature | 85 \pm 2°C | | | | | | | | | | | | | | | | | |
| Humidity | 85%RH | | | | | | | | | | | | | | | | | |
| Applied current | Rated current | | | | | | | | | | | | | | | | | |
| Time | 1000+24/-0 hour | | | | | | | | | | | | | | | | | |

| 19. Low temperature life test | | | | | | |
|-------------------------------|---|--|-------------|---------------|------|-----------------|
| Specified Value | MB series | Inductance change : Within $\pm 10\%$ No significant abnormality in appearance. | | | | |
| | MB-H series | | | | | |
| Test Methods and Remarks | <p>The test samples shall be soldered to the test board by the reflow. After that, the test samples shall be placed at test conditions as shown in below table.</p> <table border="1"> <tbody> <tr> <td>Temperature</td> <td>-40\pm2°C</td> </tr> <tr> <td>Time</td> <td>1000+24/-0 hour</td> </tr> </tbody> </table> <p>Recovery : At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48hrs.</p> | | Temperature | -40 \pm 2°C | Time | 1000+24/-0 hour |
| Temperature | -40 \pm 2°C | | | | | |
| Time | 1000+24/-0 hour | | | | | |

| 20. High temperature life test | | |
|---|--|--|
| Specified Value | MB series | Inductance change : Within $\pm 10\%$ No significant abnormality in appearance. |
| | MB-H series | |
| Test Methods and Remarks | The test samples shall be soldered to the test board by the reflow. After that, the test samples shall be placed at test conditions as shown in below table. | |
| | Temperature | $85 \pm 2^\circ\text{C}$ |
| | Time | $1000 \pm 24 / -0$ hour |
| Recovery : At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48hrs. | | |

| 21. Loading at high temperature life test | | |
|---|-------------|---|
| Specified Value | MB series | — |
| | MB-H series | |

| 22. Standard condition | | |
|------------------------|-------------|--|
| Specified Value | MB series | Standard test condition : Unless otherwise specified, temperature is $20 \pm 15^\circ\text{C}$ and $65 \pm 20\%$ of relative humidity. When there is any question concerning measurement result: In order to provide correlation data, the test shall be condition of $20 \pm 2^\circ\text{C}$ of temperature, $65 \pm 5\%$ relative humidity. Inductance is in accordance with our measured value. |
| | MB-H series | |

METAL WIRE-WOUND CHIP POWER INDUCTORS

(MCOIL™ MB SERIES / MCOIL™ MB-H SERIES)

PRECAUTIONS

1. Circuit Design

| | |
|-------------|---|
| Precautions | <ul style="list-style-type: none"> ◆ Operating environment 1. The products described in this specification are intended for use in general electronic equipment, (office supply equipment, telecommunications systems, measuring equipment, and household equipment). They are not intended for use in mission-critical equipment or systems requiring special quality and high reliability (traffic systems, safety equipment, aerospace systems, nuclear control systems and medical equipment including life-support systems,) where product failure might result in loss of life, injury or damage. For such uses, contact TAIYO YUDEN Sales Department in advance. |
|-------------|---|

2. PCB Design

| | |
|--------------------------|---|
| Precautions | <ul style="list-style-type: none"> ◆ Land pattern design 1. Please refer to a recommended land pattern. |
| Technical considerations | <ul style="list-style-type: none"> ◆ Land pattern design Surface Mounting • Mounting and soldering conditions should be checked beforehand. • Applicable soldering process to this products is reflow soldering only. |

3. Considerations for automatic placement

| | |
|--------------------------|--|
| Precautions | <ul style="list-style-type: none"> ◆ Adjustment of mounting machine 1. Excessive impact load should not be imposed on the products when mounting onto the PC boards. 2. Mounting and soldering conditions should be checked beforehand. |
| Technical considerations | <ul style="list-style-type: none"> ◆ Adjustment of mounting machine 1. When installing products, care should be taken not to apply distortion stress as it may deform the products. |

4. Soldering

| | |
|--------------------------|--|
| Precautions | <ul style="list-style-type: none"> ◆ Reflow soldering 1. Please contact any of our offices for a reflow soldering, and refer to the recommended condition specified. 2. The product shall be used reflow soldering only. 3. Please do not add any stress to a product until it returns in normal temperature after reflow soldering. ◆ Lead free soldering 1. When using products with lead free soldering, we request to use them after confirming adhesion, temperature of resistance to soldering heat, soldering etc sufficiently. |
| Technical considerations | <ul style="list-style-type: none"> ◆ Reflow soldering 1. If products are used beyond the range of the recommended conditions, heat stresses may deform the products, and consequently degrade the reliability of the products. <p>Recommended reflow condition (Pb free solder)</p> <p>Temperature [°C]</p> <p>Heating Time [sec]</p> |

5. Cleaning

| | |
|--------------------------|--|
| Precautions | <ul style="list-style-type: none"> ◆ Cleaning conditions 1. Washing by supersonic waves shall be avoided. |
| Technical considerations | <ul style="list-style-type: none"> ◆ Cleaning conditions 1. If washed by supersonic waves, the products might be broken. |

▶ This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (<http://www.ty-top.com/>).

| 6. Handling | |
|--------------------------|--|
| Precautions | <ul style="list-style-type: none"> ◆ Handling <ol style="list-style-type: none"> 1. Keep the product away from all magnets and magnetic objects. ◆ Breakaway PC boards (splitting along perforations) <ol style="list-style-type: none"> 1. When splitting the PC board after mounting product, care should be taken not to give any stresses of deflection or twisting to the board. 2. Board separation should not be done manually, but by using the appropriate devices. ◆ Mechanical considerations <ol style="list-style-type: none"> 1. Please do not give the product any excessive mechanical shocks. 2. Please do not add any shock and power to a product in transportation. ◆ Pick-up pressure <ol style="list-style-type: none"> 1. Please do not push to add any pressure to a winding part. Please do not give any shock and push into a ferrite core exposure part. ◆ Packing <ol style="list-style-type: none"> 1. Please avoid accumulation of a packing box as much as possible. |
| Technical considerations | <ul style="list-style-type: none"> ◆ Handling <ol style="list-style-type: none"> 1. There is a case that a characteristic varies with magnetic influence. ◆ Breakaway PC boards (splitting along perforations) <ol style="list-style-type: none"> 1. The position of the product on PCBs shall be carefully considered to minimize the stress caused from splitting of the PCBs. ◆ Mechanical considerations <ol style="list-style-type: none"> 1. There is a case to be damaged by a mechanical shock. 2. There is a case to be broken by the handling in transportation. ◆ Pick-up pressure <ol style="list-style-type: none"> 1. Damage and a characteristic can vary with an excessive shock or stress. ◆ Packing <ol style="list-style-type: none"> 1. If packing boxes are accumulated, that could cause a deformation on packing tapes or a damage on the products. |
| 7. Storage conditions | |
| Precautions | <ul style="list-style-type: none"> ◆ Storage <ol style="list-style-type: none"> 1. To maintain the solderability of terminal electrodes and to keep the packing material in good condition, temperature and humidity in the storage area should be controlled. <ul style="list-style-type: none"> ▪ Recommended conditions <ul style="list-style-type: none"> Ambient temperature : 0~40°C Humidity : Below 70% RH ▪ The ambient temperature must be kept below 30°C. Even under ideal storage conditions, solderability of products electrodes may decrease as time passes. <ul style="list-style-type: none"> For this reason, product should be used within 6 months from the time of delivery. In case of storage over 6 months, solderability shall be checked before actual usage. |
| Technical considerations | <ul style="list-style-type: none"> ◆ Storage <ol style="list-style-type: none"> 1. Under a high temperature and humidity environment, problems such as reduced solderability caused by oxidation of terminal electrodes and deterioration of taping/packaging materials may take place. |